

## SNx5DP159 6-Gbps AC-Coupled TMDSTM to HDMI™ Level Shifter Retimer

### 1 Features

- AC-coupled TMDSTM or DisplayPort Dual-Mode Physical Layer Input to HDMI2.0b TMDSTM Physical Layer Output Supporting up to 6 Gbps Data Rate, Compatible with HDMI2.0b Electrical Parameters
- Supporting DisplayPort Dual-Mode Standard Version 1.1
- Adaptive Receiver Equalizer and Programmable Fixed Equalizer up to 16.5 dB
- High Speed Lane Control, Pre-emphasis and Transmit Swing, and Slew Rate Control
- I<sup>2</sup>C or Pin Strap Programmable
- Supports Type-2 I2C-over-AUX to DDC Bridge
- Integrated TMDSTM Level Translator and CDR
- Active I<sup>2</sup>C[4] Buffer
- Input Swap on Main Lanes
- Low Power Consumption
- Low Power Consumption
  - –435 mW Active at 6-Gbps and –10 mW at Shutdown State
- Both Extended Commercial and Industrial Temperature Device Options
- 40-pin, 0.4 mm Pitch, 5 mm x 5 mm, WQFN Package, Pin Compatible to the TPD158 Redriver
- 40-pin, 0.5 mm Pitch, 7 mm x 7 mm, VQFN Package

### 2 Applications

- [Notebook, Desktop, All-in-Ones, Tablet, Gaming and Industrial PC](#)
- [Audio/Video Equipment](#)
- [Blu-ray™ DVD](#)
- [Gaming Systems](#)
- [HDMI Adaptor or Dongle](#)
- [Docking Station](#)

### 3 Description

The SNx5DP159 device is a dual mode[1] DisplayPort to transition-minimized differential signal (TMDSTM) retimer supporting digital video interface (DVI) 1.0 and high-definition multimedia interface (HDMI) 1.4b and 2.0b output signals. The SNx5DP159 device supports the dual mode standard version 1.1 type 1 and type 2 through the DDC link or AUX channel. The SNx5DP159 device supports data rate up to 6-Gbps per data lane to support Ultra HD (4K × 2K / 60-Hz) 8-bits per color high-resolution video and HDTV with 16-bit color depth at 1080p (1920 × 1080 / 60-Hz). The SNx5DP159 device can automatically configure itself as a re-driver at data rates <1 Gbps, or as a retimer at more than this data rate. This feature can be turned off through I<sup>2</sup>C[4] programming.

For signal integrity, the SNx5DP159 device implements several features. The SNx5DP159 receiver supports both adaptive and fixed equalization to clean up inter-symbol interference (ISI) jitter or loss from the bandwidth-limited board traces or cables. When working as a retimer, the embedded clock data recovery (CDR) cleans up the input high frequency and random jitter from video source. The transmitter provides several features for passing compliance and reducing system-level design issues like de-emphasis, which compensates for the attenuation when driving long cables or high-loss board traces. The SNx5DP159 device also includes TMDSTM output amplitude adjust using an external resistor on the Vsadj pin, source termination selection, and output slew rate control. Device operation and configuration can be programmed by pin strapping or I<sup>2</sup>C[4].

The SNx5DP159 device implements several methods for power management and active power reduction.

#### Device Information<sup>(1)</sup>

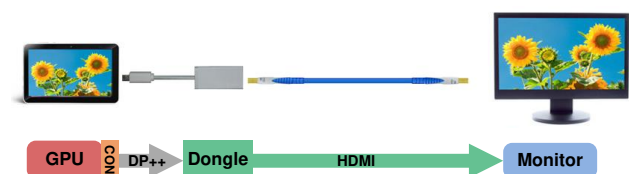
| PART NUMBER | PACKAGE   | BODY SIZE (NOM)   |
|-------------|-----------|-------------------|
| SN65DP159   | VQFN (48) | 7.00 mm × 7.00 mm |
| SN75DP159   | WQFN (40) | 5.00 mm × 5.00 mm |

(1) For all available packages, see the orderable addendum at the end of the data sheet.

#### DP159 Mother Board Application Structure



#### DP159 Dongle Application Structure



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## 4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| Changes from Revision F (May 2018) to Revision G                                                                                                               | Page |
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| • Changed references to HDMI2.0a to HDMI2.0b .....                                                                                                             | 1    |
| • Added links to end equipment pages in <a href="#">Applications</a> section. ....                                                                             | 1    |
| Changes from Revision E (April 2018) to Revision F                                                                                                             | Page |
| • Changed From: "SN75DP159 is characterized from –40°C to 85°C" To "SN65DP159 is characterized from –40°C to 85°C" in the <i>Description (continued)</i> ..... | 5    |
| • Changed From: "SN65DP159 is characterized from 0°C to 85°C" To "SN75DP159 is characterized from 0°C to 85°C" in the <i>Description (continued)</i> .....     | 5    |
| Changes from Revision D (June 2017) to Revision E                                                                                                              | Page |
| • Changed the pinout images appearance in the <i>Pin Configuration and Functions</i> section .....                                                             | 5    |
| Changes from Revision C (July 2016) to Revision D                                                                                                              | Page |
| • Changed the title From: " SNx5DP159 6-Gbps DP++ to HDMI Retimer" To: "SNx5DP159 6-Gbps AC-Coupled TMDS™ to HDMI™ Level Shifter Retimer" .....                | 1    |
| • Changed the <i>Features</i> List .....                                                                                                                       | 1    |
| • Changed the <i>Applications</i> List .....                                                                                                                   | 1    |

|                                                                                                                                               |    |
|-----------------------------------------------------------------------------------------------------------------------------------------------|----|
| • V <sub>SADJ</sub> : Added Note: "Best transmit eye ..", added MIN and MAX values in the <i>Recommended Operating Conditions</i> table ..... | 9  |
| • Changed the description of t <sub>d1</sub> in <a href="#">Table 1</a> .....                                                                 | 27 |
| • Changed read procedures in the <i>I<sup>2</sup>C Control Behavior</i> section .....                                                         | 35 |
| • Added paragraph: "DP159 is designed..." to the <i>Application and Implementation</i> section .....                                          | 41 |
| • Added 2 paragraphs to the <i>Application Information</i> section .....                                                                      | 41 |
| • Added line item "Adding pre-emphasis will improve..." to the <i>Detailed Design Procedure</i> section .....                                 | 47 |

#### Changes from Revision B (April 2016) to Revision C

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| • <a href="#">Recommended Operating Conditions</a> , Changed the CONTROL PINS section .....                    | 9  |
| • Changed the <a href="#">AUX, DDC, and I<sup>2</sup>C Electrical Characteristics</a> table .....              | 13 |
| • Added text to <a href="#">Figure 31</a> Note: "The SCL_SRC and SDA_SRC pins must be pulled to ground." ..... | 43 |

#### Changes from Revision A (July 2015) to Revision B

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| • Added "Low-level input voltage at OE" to V <sub>IL</sub> in the <a href="#">Recommended Operating Conditions</a> table .....                                             | 9  |
| • Added OE to V <sub>IH</sub> "High-level input voltage" in the <a href="#">Recommended Operating Conditions</a> table .....                                               | 9  |
| • Changed <a href="#">Figure 22</a> .....                                                                                                                                  | 26 |
| • Deleted the VDD_ramp and VCC_ramp MIN values in <a href="#">Table 1</a> .....                                                                                            | 27 |
| • Changed text "through the I <sup>2</sup> C interface" To: "through the I <sup>2</sup> C access on the DDC interface" in <a href="#">DDC Functional Description</a> ..... | 32 |
| • Changed the HDMI and DVI value for 1Ah <a href="#">Table 3</a> .....                                                                                                     | 33 |
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#### Changes from Original (July 2015) to Revision A

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| • Updated device status from product preview to production data .....                               | 1  |
| • Updated Typical Power Number .....                                                                | 1  |
| • Removed Standby Power numbers .....                                                               | 1  |
| • Changed From: Preview To: Production data .....                                                   | 1  |
| • Replaced SIG_EN with NC in pinout drawing and <i>Pin Functions</i> table .....                    | 5  |
| • Removed lane swap from description of SWAP/POL = H .....                                          | 8  |
| • Updated swing data .....                                                                          | 9  |
| • Changed DDC link into its pin names between SNK and SRC and updated min value .....               | 9  |
| • Added new line for SCL_SNK, SDA_SNK .....                                                         | 9  |
| • Removed standby power and standby current rows and updated active power and current numbers ..... | 10 |
| • Changed term control to no source termination .....                                               | 12 |
| • Increased I <sub>LEAK</sub> max value from 10 µA to 45 µA .....                                   | 12 |
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| • Added note to <i>DDC Functional Description</i> section describing DDC snoop function .....       | 32 |
| • Removed bit 4 SIG_EN and made reserved .....                                                      | 37 |
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**SN65DP159, SN75DP159**

SLLSEJ2G – JULY 2015 – REVISED MARCH 2020

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|                                                                                 |    |
|---------------------------------------------------------------------------------|----|
| • Updated VID swing .....                                                       | 47 |
| • Changed Title to better match table. Removed Standby and redundant rows ..... | 49 |
| • Updated drawing with pin 17 changed to NC .....                               | 52 |

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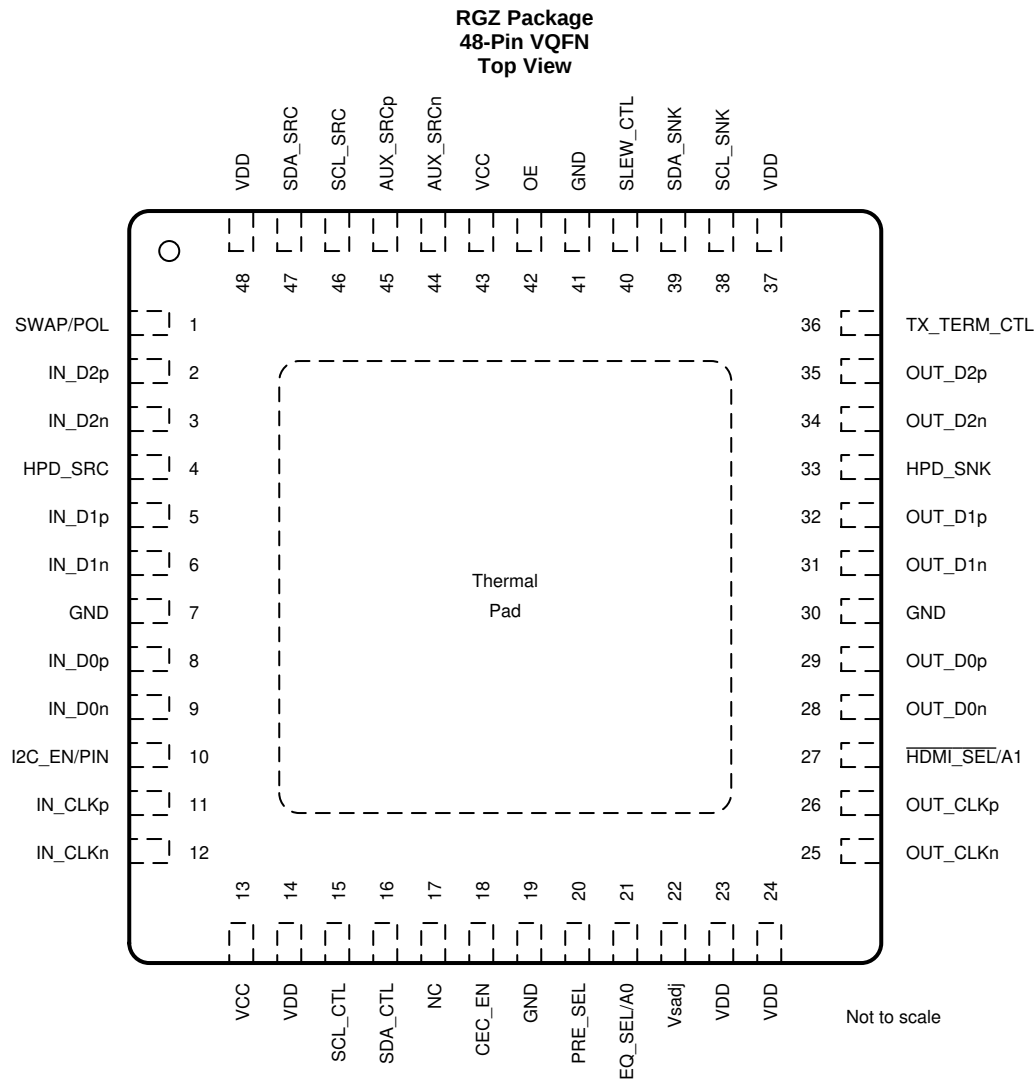
## 5 Description (continued)

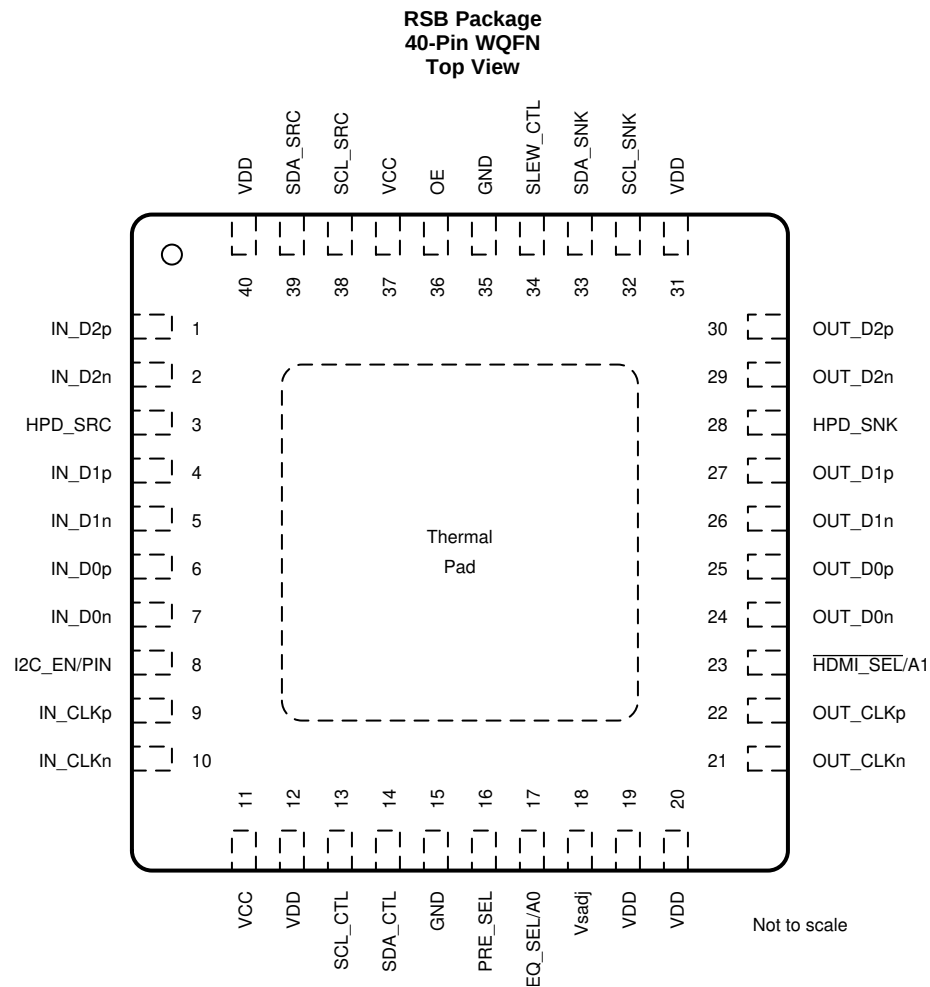
The SNx5DP159 receiver uses several methods to determine whether the application supports HDMI1.4b[2] or HDMI2.0[3] data rates. The SNx5DP159 receiver comes in two packages: a 40-pin RSB supporting space-constrained applications and a 48-pin RGZ version supporting the full feature set for DisplayPort dual-mode standard version 1.1 in applications such as dongles.

The SN65DP159 device is characterized for an industrial operational temperature range from –40°C to 85°C.

The SN75DP159 device is characterized for an extended commercial operational temperature range from 0°C to 85°C.

## 6 Pin Configuration and Functions





### Pin Functions

| PIN <sup>(1)</sup>                |     |     | I/O | DESCRIPTION <sup>(2)</sup>      |
|-----------------------------------|-----|-----|-----|---------------------------------|
| SIGNAL NAME                       | RGZ | RSB |     |                                 |
| MAIN LINK INPUT PINS (FAIL SAFE)  |     |     |     |                                 |
| IN_D2p                            | 2   | 1   | I   | Channel 2 differential input    |
| IN_D2n                            | 3   | 2   |     |                                 |
| IN_D1p                            | 5   | 4   | I   | Channel 1 differential input    |
| IN_D1n                            | 6   | 5   |     |                                 |
| IN_D0p                            | 8   | 6   | I   | Channel 0 differential input    |
| IN_D0n                            | 9   | 7   |     |                                 |
| IN_CLKp                           | 11  | 9   | I   | Clock differential input        |
| IN_CLKn                           | 12  | 10  |     |                                 |
| MAIN LINK OUTPUT PINS (FAIL SAFE) |     |     |     |                                 |
| OUT_D2n                           | 34  | 29  | O   | TMDS data 2 differential output |
| OUT_D2p                           | 35  | 30  |     |                                 |
| OUT_D1n                           | 31  | 26  | O   | TMDS data 1 differential output |
| OUT_D1p                           | 32  | 27  |     |                                 |

(1) Blue pin names are only in the SNx5DP159 RGZ package.

(2) (H) Logic high (pin strapped to VCC through 65-kΩ resistor); (L) logic low (pin strapped to GND through 65-kΩ resistor); (for mid-level, no connect)

### Pin Functions (continued)

| PIN <sup>(1)</sup>         |     |     | I/O                            | DESCRIPTION <sup>(2)</sup>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
|----------------------------|-----|-----|--------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| SIGNAL NAME                | RGZ | RSB |                                |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| OUT_D0n                    | 28  | 24  | O                              | TMDS data 0 differential output                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| OUT_D0p                    | 29  | 25  |                                |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| OUT_CLKn                   | 25  | 21  | O                              | TMDS data clock differential output                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| OUT_CLKp                   | 26  | 22  |                                |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| HOT PLUG DETECT PINS       |     |     |                                |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| HPD_SRC                    | 4   | 3   | O                              | Hot plug detect output                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
| HPD_SNK                    | 33  | 28  | I (Failsafe)                   | Hot plug detect input                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
| AUXILIARY/DDC DATA PINS    |     |     |                                |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| AUX_SRCp                   | 45  | N/A | I/O                            | Source side bidirectional DisplayPort auxiliary for I <sup>2</sup> C-over-AUX (DP159RGZ only)                                                                                                                                                                                                                                                                                                                                                                                                             |
| AUX_SRCn                   | 44  | N/A |                                |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| SDA_SRC                    | 47  | 39  | I/O (Failsafe)                 | Source side TMDS port bidirectional DDC data line                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| SCL_SRC                    | 46  | 38  |                                |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| SDA_SNK                    | 39  | 33  | I/O (Failsafe)                 | Sink side TMDS port bidirectional DDC data lines                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
| SCL_SNK                    | 38  | 32  |                                |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| CONTROL PINS               |     |     |                                |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| OE                         | 42  | 36  | I                              | Operation enable/reset pin<br>OE = L: Power-down mode<br>OE = H: Normal operation<br>Internal weak pullup: Resets device when transitions from H to L                                                                                                                                                                                                                                                                                                                                                     |
| NC <sup>(1)</sup>          | 17  | N/A | I                              | No connect                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
| CEC_EN <sup>(1)</sup>      | 18  | N/A | O                              | CEC control pin for Dongle applications                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
| SLEW_CTL                   | 40  | 34  | I<br>3<br>level <sup>(2)</sup> | Slew rate control when I2C_EN/PIN = Low.<br>SLEW_CTL = H, fastest data rate<br>SLEW_CTL = L, 5 ps slow<br>SLEW_CTL = No Connect, 10 ps slow<br>When I2C_EN/PIN = High Slew rate is controlled through I <sup>2</sup> C[4]                                                                                                                                                                                                                                                                                 |
| PRE_SEL                    | 20  | 16  | I<br>3<br>level <sup>(2)</sup> | De-emphasis pin strap when I2C_EN/PIN = Low.<br>PRE_SEL = L: - 2 dB de-emphasis<br>PRE_SEL = No Connect: 0 dB<br>PRE_SEL = H: Reserved                                                                                                                                                                                                                                                                                                                                                                    |
| EQ_SEL/A0                  | 21  | 17  | I<br>3<br>level <sup>(2)</sup> | Input Receive Equalization pin strap when I2C_EN/PIN = Low<br>EQ_SEL = L: Fixed EQ at 7.5 dB<br>EQ_SEL = No Connect: Adaptive EQ<br>EQ_SEL = H: Fixed at 14 dB<br>When I2C_EN/PIN = High<br>Address bit 1<br>Note: (3 level for pin strap programming but 2 level when I <sup>2</sup> C[4] address)                                                                                                                                                                                                       |
| I2C_EN/PIN                 | 10  | 8   | I                              | I2C_EN/PIN = High; puts device into I <sup>2</sup> C control mode<br>I2C_EN/PIN = Low; puts device into pin strap mode                                                                                                                                                                                                                                                                                                                                                                                    |
| SCL_CTL                    | 15  | 13  | I                              | I <sup>2</sup> C clock signal<br>Note: When I2C_EN/PIN = Low Pin strapping take priority and those functions cannot be changed by I <sup>2</sup> C                                                                                                                                                                                                                                                                                                                                                        |
| SDA_CTL                    | 16  | 14  | I/O                            | I <sup>2</sup> C data signal<br>Note: When I2C_EN/PIN = Low Pin strapping take priority and those functions cannot be changed by I <sup>2</sup> C                                                                                                                                                                                                                                                                                                                                                         |
| Vsadj                      | 22  | 18  | I                              | TMDS-compliant voltage swing control nominal resistor to GND                                                                                                                                                                                                                                                                                                                                                                                                                                              |
| HDMI_SEL/A1                | 27  | 23  | I                              | HDMI_SEL when I2C_EN/PIN = Low<br>HDMI_SEL = High: Device configured for DVI<br>HDMI_SEL = Low: Device configured for HDMI (Adaptor ID block is readable through I <sup>2</sup> C[4] or I <sup>2</sup> C-over-AUX.<br>When I2C_EN/PIN = High<br>Address bit 2<br>Note: Weak internal pull down                                                                                                                                                                                                            |
| TX_TERM_CTL <sup>(1)</sup> | 36  | N/A | I<br>3<br>level <sup>(2)</sup> | Transmit Termination Control when I2C_EN/PIN = Low<br>TX_TERM_CTL = H, No transmit termination<br>TX_TERM_CTL = L, Transmit termination impedance in 75 to about 150 Ω<br>TX_TERM_CTL = No Connect, automatically selects the termination impedance<br>Data rate (DR) > 3.4 Gbps – 75- to 150-Ω differential near end termination<br>2 Gbps < DR < 3.4 Gbps – 150- to 300-Ω differential near end termination<br>DR < 2 Gbps – no termination<br>Note: If left floating will be in automatic select mode. |

## Pin Functions (continued)

| PIN <sup>(1)</sup>            |                       |                       | I/O                            | DESCRIPTION <sup>(2)</sup>                                                                                                                                                                                                           |
|-------------------------------|-----------------------|-----------------------|--------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| SIGNAL NAME                   | RGZ                   | RSB                   |                                |                                                                                                                                                                                                                                      |
| SWAP/POL <sup>(1)</sup>       | 1                     | N/A                   | I<br>3<br>level <sup>(2)</sup> | Input lane SWAP and polarity control pin when I2C_EN/PIN = Low<br>SWAP/POL = H receive lane polarity swap (retimer mode only)<br>SWAP/POL = L receive lanes swap (retimer and redriver mode)<br>SWAP/POL = No Connect normal working |
| <b>SUPPLY AND GROUND PINS</b> |                       |                       |                                |                                                                                                                                                                                                                                      |
| V <sub>CC</sub>               | 13, 43                | 11, 37                | P                              | 3.3-V power supply                                                                                                                                                                                                                   |
| V <sub>DD</sub>               | 14, 23, 24,<br>37, 48 | 12, 19, 20,<br>31, 40 | P                              | 1.1-V power supply                                                                                                                                                                                                                   |
| GND                           | 7, 19, 41,<br>30,     | 15, 35                | G                              | Ground                                                                                                                                                                                                                               |
| Thermal Pad                   |                       |                       |                                | Connected to ground                                                                                                                                                                                                                  |

## 7 Specifications

### 7.1 Absolute Maximum Ratings

 over operating free-air temperature (unless otherwise noted) <sup>(1)(2)</sup>

|                                       |                                                                                                                   | MIN                                     | MAX  | UNIT |
|---------------------------------------|-------------------------------------------------------------------------------------------------------------------|-----------------------------------------|------|------|
| Supply voltage <sup>(3)</sup>         | V <sub>CC</sub>                                                                                                   | −0.3                                    | 4    | V    |
|                                       | V <sub>DD</sub>                                                                                                   | −0.3                                    | 1.4  | V    |
| Voltage                               | Main link input (IN_Dx AC-coupled mode), AUX_SRCp, AUX_SRCn differential voltage                                  |                                         | 1.56 | V    |
|                                       | TMDS outputs (OUT_Dx)                                                                                             | −0.3                                    | 4    | V    |
|                                       | HPD_SRC, Vsadj, SDA_CTL, SCL_CTL, OE, HDMI_SEL/A1, EQ_SEL/A0, I2C_EN/PIN, SLEW_CTL, TX_TERM_CTL, SDA_SRC, SCL_SRC | −0.3                                    | 4    | V    |
|                                       | HPD_SNK, SDA_SNK, SCL_SNK                                                                                         | −0.3                                    | 6    | V    |
| Continuous power dissipation          |                                                                                                                   | See <a href="#">Thermal Information</a> |      |      |
| Storage temperature, T <sub>stg</sub> |                                                                                                                   | −65                                     | 150  | °C   |

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) All voltage values, except differential voltages, are with respect to network ground terminal.
- (3) Tested in accordance with JEDEC Standard 22, Test Method A114-B.

### 7.2 ESD Ratings

|                    |                         | VALUE                                                                                    | UNIT  |
|--------------------|-------------------------|------------------------------------------------------------------------------------------|-------|
| V <sub>(ESD)</sub> | Electrostatic discharge | Human body model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins <sup>(1)</sup>              | ±2000 |
|                    |                         | Charged device model (CDM), per JEDEC specification JESD22-C101, all pins <sup>(2)</sup> | ±500  |

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

## 7.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

|                                |                                                                                                     |              | MIN  | NOM  | MAX  | UNIT |
|--------------------------------|-----------------------------------------------------------------------------------------------------|--------------|------|------|------|------|
| GENERAL PARAMETERS             |                                                                                                     |              |      |      |      |      |
| V <sub>CC</sub>                | Supply voltage                                                                                      |              | 3    | 3.3  | 3.6  | V    |
| V <sub>DD</sub>                |                                                                                                     |              | 1.00 | 1.1  | 1.27 |      |
| T <sub>CASE</sub>              | Case temperature for RSB package                                                                    |              | 93.5 |      |      | °C   |
| T <sub>CASE</sub>              | Case temperature for RGZ package                                                                    |              | 92.7 |      |      | °C   |
| T <sub>A</sub>                 | Operating free-air temperature                                                                      | SN75DP159    | 0    |      | 85   | °C   |
|                                |                                                                                                     | SN65DP159    | −40  |      | 85   |      |
| MAIN LINK DIFFERENTIAL PINS    |                                                                                                     |              |      |      |      |      |
| V <sub>ID_PP</sub>             | Peak-to-peak input differential voltage                                                             |              | 75   |      | 1200 | mv   |
| V <sub>IC</sub>                | Input common mode voltage                                                                           |              | 0    |      | 2    | V    |
| C <sub>AC</sub>                | AC coupling capacitance                                                                             |              | 75   | 100  | 200  | nF   |
| d <sub>R</sub>                 | Data rate                                                                                           |              | 0.25 |      | 5    | Gbps |
| V <sub>SADJ</sub>              | TMDS-compliant swing voltage bias resistor <sup>(1)</sup>                                           |              | 4.5  | 7.06 | 7.5  | kΩ   |
| CONTROL PINS                   |                                                                                                     |              |      |      |      |      |
| V <sub>I-DC</sub>              | DC input voltage                                                                                    | Control pins | −0.3 |      | 3.6  | V    |
| V <sub>IL</sub> <sup>(2)</sup> | Low-level input voltage at OE                                                                       |              | 0.8  |      |      | V    |
|                                | Low-level input voltage at SLEW_CTL, PRE_SEL, EQ_SEL/A0, TX_TERM_CTL, SWAP/POL                      |              | 0.3  |      |      |      |
| V <sub>IM</sub> <sup>(2)</sup> | No connect input voltage at SLEW_CTL, PRE_SEL, EQ_SEL/A0, TX_TERM_CTL, SWAP/POL                     |              | 1    | 1.2  | 1.4  | V    |
| V <sub>IH</sub> <sup>(2)</sup> | High-level input voltage at SLEW_CTL, OE <sup>(3)</sup> , PRE_SEL, EQ_SEL/A0, TX_TERM_CTL, SWAP/POL |              | 2.6  |      |      | V    |
| V <sub>OL</sub>                | Low-level output voltage                                                                            |              | 0.4  |      |      | V    |
| V <sub>OH</sub>                | High-level output voltage                                                                           |              | 2.4  |      |      | V    |
| I <sub>IH</sub>                | High-level input current                                                                            |              | −30  |      | 30   | μA   |
| I <sub>IL</sub>                | Low-level input current                                                                             |              | −10  |      | 10   | μA   |
| I <sub>OS</sub>                | Short circuit output current                                                                        |              | −50  |      | 50   | mA   |
| I <sub>OZ</sub>                | High impedance output current                                                                       |              | 10   |      |      | μA   |
| R <sub>OEPU</sub>              | Pullup resistance on OE pin                                                                         |              | 150  |      | 250  | kΩ   |

- (1) Best transmit eye with minimum intra-pair skew, largest vertical and horizontal eye opening, maintaining HDMI compliant output swing can be achieved with resistors around 6.4k. Using smaller resistors may lead to compliance failures.
- (2) These values are based upon a microcontroller driving the control pins. The pullup/pulldown/floating resistor configuration will set the internal bias to the proper voltage level which will not match the values shown here.
- (3) This value is based upon a microcontroller driving the OE pin. A passive reset circuit using an external capacitor and the internal pullup resistor will set OE pin properly, but may have a different value than shown due to internal biasing.

## 7.4 Thermal Information

| THERMAL METRIC <sup>(1)</sup> |                                                                          | SNx5DP159<br>RGZ (VQFN) | SNx5DP159<br>RSB (WQFN) | UNIT |
|-------------------------------|--------------------------------------------------------------------------|-------------------------|-------------------------|------|
|                               |                                                                          | 48 PINS                 | 40 PINS                 |      |
|                               |                                                                          |                         |                         |      |
| R <sub>θJA</sub>              | Junction-to-ambient thermal resistance                                   | 31.1                    | 37.3                    | °C/W |
| R <sub>θJC(top)</sub>         | Junction-to-case (top) thermal resistance (High-K board <sup>(2)</sup> ) | 18.2                    | 23.1                    | °C/W |
| R <sub>θJB</sub>              | Junction-to-board thermal resistance (High-K board <sup>(2)</sup> )      | 8.1                     | 9.9                     | °C/W |
| Ψ <sub>JT</sub>               | Junction-to-top characterization parameter                               | 0.4                     | 0.3                     | °C/W |
| Ψ <sub>JB</sub>               | Junction-to-board characterization parameter                             | 8.1                     | 3.8                     | °C/W |
| R <sub>θJC(bot)</sub>         | Junction-to-case (bottom) thermal resistance                             | 3.2                     | 3.2                     | °C/W |

- (1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application report.
- (2) Test conditions for Ψ<sub>JB</sub> and Ψ<sub>JT</sub> are clarified in TI document [Semiconductor and IC Package Thermal Metrics](#).

## 7.5 Power Supply Electrical Characteristics

over operating free-air temperature range (unless otherwise noted)

| PARAMETER        |                                               | TEST CONDITIONS                                                                                                                                                                                                                                             | MIN        | TYP <sup>(1)</sup> | MAX <sup>(2)</sup> | UNIT |
|------------------|-----------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------|--------------------|--------------------|------|
| P <sub>DI</sub>  | Device power dissipation (Retimer operation)  | OE = H, V <sub>CC</sub> = 3.3 V/3.6 V, V <sub>DD</sub> = 1.1 V/1.27 V<br>IN <sub>DX</sub> : V <sub>ID_PP</sub> = 1200 mV, 6Gbps TMDS pattern, V <sub>I</sub> = 3.3 V,<br>I2C_EN/PIN = L, PRE_SEL = H, EQ_CTL = H,<br>SDA_CTL/CLK_CTL = 0 V, VSadj = 7.06 kΩ |            | 435                | 600                | mW   |
| P <sub>DI</sub>  | Device power dissipation (Redriver operation) | OE = H, V <sub>CC</sub> = 3.3 V/3.6 V, V <sub>DD</sub> = 1.1 V/1.27 V<br>IN <sub>DX</sub> : V <sub>ID_PP</sub> = 1200 mV, 6Gbps TMDS pattern, V <sub>I</sub> = 3.3 V,<br>I2C_EN/PIN = L, PRE_SEL = H, EQ_CTL = H,<br>SDA_CTL/CLK_CTL = 0 V, VSadj = 7.06 kΩ |            | 215                | 400                | mW   |
| P <sub>SD1</sub> | Device power in power down                    | OE = L, V <sub>CC</sub> = 3.3 V/3.6 V, V <sub>DD</sub> = 1.1 V/1.27 V, VSadj = 7.06 kΩ                                                                                                                                                                      |            | 10                 | 30                 | mW   |
| I <sub>CC1</sub> | VCC supply current (TMDS 6Gbps retimer mode)  | OE = H, V <sub>CC</sub> = 3.3 V/3.6 V, V <sub>DD</sub> = 1.1 V/1.27 V, VSadj = 7.06 kΩ<br>IN <sub>DX</sub> : V <sub>ID_PP</sub> = 1200 mV, 6Gbps TMDS pattern<br>I2C_EN/PIN = L, PRE_SEL = H, EQ_CTL = H,<br>SDA_CTL/CLK_CTL = 0 V, SLEW_CTL = H            |            | 35                 | 50                 | mA   |
| I <sub>DD1</sub> | VDD supply current (TMDS 6Gbps retimer mode)  | OE = H, V <sub>CC</sub> = 3.3 V/3.6 V, V <sub>DD</sub> = 1.1 V/1.27 V, VSadj = 7.06 kΩ<br>IN <sub>DX</sub> : V <sub>ID_PP</sub> = 1200 mV, 6Gbps TMDS pattern<br>I2C_EN/PIN = L, PRE_SEL = H, EQ_CTL = H,<br>SDA_CTL/CLK_CTL = 0 V, SLEW_CTL = H            |            | 295                | 325                | mA   |
| I <sub>CC2</sub> | VCC supply current (TMDS 6Gbps redriver mode) | OE = H, V <sub>CC</sub> = 3.3 V/3.465 V, V <sub>DD</sub> = 1.1 V/1.27 V, VSadj = 7.06 kΩ<br>IN <sub>DX</sub> : V <sub>ID_PP</sub> = 1200 mV, 6Gbps TMDS pattern<br>I2C_EN/PIN = L, PRE_SEL = H, EQ_CTL = H,<br>SDA_CTL/CLK_CTL = 0 V, SLEW_CTL = H          |            | 8                  | 20                 | mA   |
| I <sub>DD2</sub> | VDD supply current (TMDS 6Gbps redriver mode) | OE = H, V <sub>CC</sub> = 3.3 V/3.465 V, V <sub>DD</sub> = 1.1 V/1.27 V, VSadj = 7.06 kΩ<br>IN <sub>DX</sub> : V <sub>ID_PP</sub> = 1200 mV, 6Gbps TMDS pattern<br>I2C_EN/PIN = L, PRE_SEL = H, EQ_CTL = H,<br>SDA_CTL/CLK_CTL = 0 V, SLEW_CTL = H          |            | 170                | 250                | mA   |
| I <sub>SD1</sub> | Power-down current                            | OE = L, V <sub>CC</sub> = 3.3 V/3.465 V, V <sub>DD</sub> = 1.1 V/1.27 V, VSadj = 7.06 kΩ                                                                                                                                                                    | 3.3-V rail | 2                  | 5                  | mA   |
| I <sub>SD1</sub> | Power-down current                            | OE = L, V <sub>CC</sub> = 3.3 V/3.465 V, V <sub>DD</sub> = 1.1 V/1.27 V, VSadj = 7.06 kΩ                                                                                                                                                                    | 1.1-V rail | 3.5                | 10                 |      |

(1) The typical rating is simulated at 3.3-V V<sub>CC</sub> and 1.1-V V<sub>DD</sub> and at 27°C temperature unless otherwise noted

(2) The maximum rating is simulated at 3.6-V V<sub>CC</sub> and 1.27-V V<sub>DD</sub> and at 85°C temperature unless otherwise noted

## 7.6 Differential Input Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER                                                                   | TEST CONDITIONS                                                | MIN  | TYP | MAX  | UNIT             |
|-----------------------------------------------------------------------------|----------------------------------------------------------------|------|-----|------|------------------|
| D <sub>R_RX_DATA</sub> Ddata lanes data rate                                |                                                                | 0.25 |     | 6    | Gbps             |
| D <sub>R_RX_CLK</sub> Clock lanes clock rate                                |                                                                | 25   |     | 340  | MHz              |
| t <sub>RX_DUTY</sub> Input clock duty circle                                |                                                                | 40%  | 50% | 60%  |                  |
| t <sub>CLK_JIT</sub> Input clock jitter tolerance                           |                                                                |      |     | 0.3  | Tbit             |
| t <sub>DATA_JIT</sub> Input data jitter tolerance                           | Test the TTP2, see <a href="#">Figure 10</a>                   |      |     | 150  | ps               |
| T <sub>RX_INTRA</sub> Input intra-pair skew tolerance                       | Test at TTP2 when DR = 1.6-Gbps, see <a href="#">Figure 10</a> | 112  |     |      | ps               |
| T <sub>RX_INTER</sub> Input inter-pair skew tolerance                       |                                                                |      |     | 1.8  | ns               |
| E <sub>QH(D)</sub> Fixed EQ gain for data lane IN <sub>D(0,1,2)n/p</sub>    | EQ_SEL/A0 = H; Fixed EQ gain, test at 6-Gbps                   |      | 15  |      | dB               |
| E <sub>QL(D)</sub> Fixed EQ gain for data lane IN <sub>D(0,1,2)n/p</sub>    | EQ_SEL/A0 = L; Fixed EQ gain, test at 6-Gbps                   |      | 7.5 |      | dB               |
| E <sub>QZ(D)</sub> Adaptive EQ gain for data lane IN <sub>D(0,1,2)n/p</sub> | EQ_SEL/A0 = Z; adaptive EQ                                     | 2    |     | 15   | dB               |
| E <sub>Q(c)</sub> EQ gain for clock lane IN <sub>CLKn/p</sub>               | EQ_SEL/A0 = H,L,NC                                             |      | 3   |      |                  |
| R <sub>INT</sub> Input differential termination impedance                   |                                                                | 80   | 100 | 120  | Ω                |
| V <sub>ITERM</sub> Input termination voltage                                | OE = H                                                         |      | 0.7 |      | V                |
| V <sub>ID_PP</sub> Input differential voltage (peak to peak)                | Tested at TTP2, check <a href="#">Figure 10</a>                | 75   |     | 1200 | mV <sub>PP</sub> |

## 7.7 HDMI and DVI TMD5 Output Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER                                                                                    | TEST CONDITIONS                                                                                                        | MIN                    | TYP | MAX                   | UNIT |
|----------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------|------------------------|-----|-----------------------|------|
| V <sub>OH</sub> Single-ended high level output voltage                                       | Data rate ≤ 1.65-Gbps; PRE_SEL = NC; TX_TERM_CTL = H; SLEW_CTL = H; OE = H; DR = 750-Mbps, VSadj = 7.06-kΩ             | V <sub>CC</sub> – 10   |     | V <sub>CC</sub> + 10  | mV   |
|                                                                                              | 1.65-Gbps < Data rate ≤ 3.4-Gbps; PRE_SEL = NC; TX_TERM_CTL = H; SLEW_CTL = H; OE = H; DR = 2.97-Gbps, VSadj = 7.06-kΩ | V <sub>CC</sub> – 200  |     | V <sub>CC</sub> + 10  |      |
| V <sub>OH</sub> Single-ended high level output voltage                                       | 3.4-Gbps < Data rate < 6 Gbps; PRE_SEL = NC; TX_TERM_CTL = L; SLEW_CTL = H; OE = H; DR = 6-Gbps, VSadj = 7.06-kΩ       | V <sub>CC</sub> – 400  |     | V <sub>CC</sub> + 10  | mV   |
| V <sub>OL</sub> Single-ended low level output voltage                                        | Data rate ≤ 1.65-Gbps; PRE_SEL = NC; TX_TERM_CTL = H; SLEW_CTL = H; OE = H; DR = 750-Mbps, VSadj = 7.06-kΩ             | V <sub>CC</sub> – 600  |     | V <sub>CC</sub> – 400 | mV   |
|                                                                                              | 1.65-Gbps < Data rate ≤ 3.4-Gbps; PRE_SEL = NC; TX_TERM_CTL = H; SLEW_CTL = H; OE = H; DR = 2.97-Gbps, VSadj = 7.06-kΩ | V <sub>CC</sub> – 700  |     | V <sub>CC</sub> – 400 |      |
| V <sub>OL</sub> Single-ended low level output voltage                                        | 3.4-Gbps < Data rate < 6-Gbps; PRE_SEL = NC; TX_TERM_CTL = L; SLEW_CTL = H; OE = H; DR = 6-Gbps                        | V <sub>CC</sub> – 1000 |     | V <sub>CC</sub> – 400 | mV   |
| V <sub>SWING_DA</sub> Single-ended output voltage swing on data lane                         | PRE_SEL = NC; TX_TERM_CTL = H/NC/L; SLEW_CTL = H; OE = H; DR = 270-Mbps/2.97/6Gbps VSadj = 7.06-kΩ                     | 400                    | 500 | 600                   | mV   |
| V <sub>SWING_CLK</sub> Single-ended output voltage swing on clock lane                       | Data rate ≤ 3.4-Gbps; PRE_SEL = NC; TX_TERM_CTL = H; SLEW_CTL = H; OE = H; VSadj = 7.06-kΩ                             | 400                    | 500 | 600                   | mV   |
|                                                                                              | Data rate > 3.4-Gbps; PRE_SEL = NC; TX_TERM_CTL = NC; SLEW_CTL = H; OE = H; VSadj = 7.06-kΩ                            | 200                    | 300 | 400                   |      |
| ΔV <sub>SWING</sub> Change in single-end output voltage swing per 100 Ω ΔVsadj               |                                                                                                                        |                        | 20  |                       | mV   |
| ΔV <sub>OCM(SS)</sub> Change in steady state output common mode voltage between logic levels |                                                                                                                        | –5                     |     | 5                     | mV   |
| V <sub>OD(PP)</sub> Output differential voltage before pre-emphasis                          | VSadj = 7.06-kΩ; PRE_SEL = Z, See <a href="#">Figure 8</a>                                                             | 800                    |     | 1200                  | mV   |
| V <sub>OD(SS)</sub> Steady-state output differential voltage                                 | VSadj = 7.06-kΩ; PRE_SEL = L, See <a href="#">Figure 9</a>                                                             | 600                    |     | 1050                  | mV   |
| I <sub>LEAK</sub> Failsafe condition leakage current                                         | V <sub>CC</sub> = 0-V; V <sub>DD</sub> = 0-V; output pulled to 3.3 V through 50-Ω resistors                            |                        |     | 45                    | μA   |
| I <sub>OS</sub> Short circuit current limit                                                  | Main link output shorted to GND                                                                                        |                        |     | 50                    | mA   |
| R <sub>TERM</sub> Source termination resistance for HDMI 2.0                                 |                                                                                                                        | 75                     |     | 150                   | Ω    |

## 7.8 AUX, DDC, and I<sup>2</sup>C Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER                   |                                                                                                                   | TEST CONDITIONS                                                       | MIN                   | TYP                   | MAX                 | UNIT |
|-----------------------------|-------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------------------|-----------------------|-----------------------|---------------------|------|
| C <sub>IO</sub>             | Input capacitance                                                                                                 | AUX data rate = 1-MHz                                                 |                       | 10                    |                     | pF   |
| C <sub>AC</sub>             | AUX AC coupling capacitance                                                                                       |                                                                       | 75                    |                       | 200                 | nF   |
| D <sub>R(AUX)</sub>         | Data rate of the AUX channel input                                                                                |                                                                       | 0.8                   | 1                     | 1.2                 | Mbps |
| V <sub>I-DC(AUX)</sub>      | DC input voltage on AUX channel, AUX_SRCp/n: 100-kΩ pull up to 3.6 V but differential common mode is 2 V or less. |                                                                       | -0.5                  |                       | 3.6                 | V    |
| V <sub>AUX_DIFF_PP_TX</sub> | Peak-to-peak differential voltage at TX pins                                                                      | V <sub>AUX_DIFF_PP</sub> = 2 ×  V <sub>AUXP</sub> – V <sub>AUXN</sub> | 0.29                  |                       | 1.38                | V    |
| V <sub>AUX_DIFF_PP_RX</sub> | Peak-to-peak differential voltage at RX pins                                                                      | V <sub>AUX_DIFF_PP</sub> = 2 ×  V <sub>AUXP</sub> – V <sub>AUXN</sub> | 0.14                  |                       | 1.36                | V    |
| V <sub>AUX_DC_CM</sub>      | AUX channel DC common mode voltage                                                                                |                                                                       | 0                     |                       | 2                   | V    |
| I <sub>AUX_SHORT</sub>      | AUX channel short circuit current limit                                                                           |                                                                       |                       |                       | 90                  | mA   |
| V <sub>I-DC</sub>           | SCL/SDA_SNK DC input voltage                                                                                      |                                                                       | -0.3                  |                       | 5.6                 | V    |
|                             | SCL/SDA_CTL, SCL/SDA_SRC DC input voltage                                                                         |                                                                       | -0.3                  |                       | 3.6                 | V    |
| V <sub>IL</sub>             | SCL/SDA_SNK, SCL/SDA_SRC Low level input voltage                                                                  |                                                                       |                       | 0.3 × V <sub>CC</sub> |                     | V    |
|                             | SCL/SDA_CTL Low level input voltage                                                                               |                                                                       |                       | 0.3 × V <sub>CC</sub> |                     | V    |
| V <sub>IH</sub>             | SCL/SDA_SNK high level input voltage                                                                              |                                                                       | 3                     |                       |                     | V    |
|                             | SCL/SDA_SRC high level input voltage                                                                              |                                                                       | 0.7 × V <sub>CC</sub> |                       |                     | V    |
|                             | SCL/SDA_CTL high level input voltage                                                                              |                                                                       | 0.7 × V <sub>CC</sub> |                       |                     | V    |
| V <sub>OL</sub>             | SCL/SDA_CTL, SCL/SDA_SRC low-level output voltage                                                                 | I <sub>O</sub> = 3-mA and V <sub>CC</sub> > 2-V                       |                       |                       | 0.4                 | V    |
|                             |                                                                                                                   | I <sub>O</sub> = 3-mA and V <sub>CC</sub> < 2-V                       |                       |                       | 0.2 V <sub>CC</sub> | V    |
| f <sub>SCL</sub>            | SCL clock frequency fast I2C mode for local I2C control                                                           |                                                                       |                       |                       | 400                 | kHz  |
| C <sub>bus</sub>            | Total capacitive load for each bus line (DDC and local I2C pins)                                                  |                                                                       |                       |                       | 400                 | pF   |

## 7.9 HPD Electrical Characteristics

over operating free-air temperature range (unless otherwise noted)

| PARAMETER          |                                    | TEST CONDITIONS                                                                                             | MIN | TYP | MAX | UNIT |
|--------------------|------------------------------------|-------------------------------------------------------------------------------------------------------------|-----|-----|-----|------|
| V <sub>IH</sub>    | High-level input voltage           | HPD_SNK                                                                                                     | 2.1 |     |     | V    |
| V <sub>IL</sub>    | Low-level input voltage            | HPD_SNK                                                                                                     |     |     | 0.8 | V    |
| V <sub>OH</sub>    | High-level output voltage          | I <sub>OH</sub> = -500-μA; HPD_SRC                                                                          | 2.4 |     | 3.6 | V    |
| V <sub>OL</sub>    | Low-level output voltage           | I <sub>OL</sub> = 500-μA; HPD_SRC                                                                           | 0   |     | 0.1 | V    |
| I <sub>LEAK</sub>  | Failsafe condition leakage current | V <sub>CC</sub> = 0-V; V <sub>DD</sub> = 0-V; HPD_SNK = 5-V                                                 |     |     | 40  | μA   |
| I <sub>H_HPD</sub> | High-level input current           | Device powered; V <sub>IH</sub> = 5-V;<br>I <sub>H_HPD</sub> includes R <sub>pdHPD</sub> resistor current   |     |     | 40  | μA   |
| I <sub>L_HPD</sub> | Low-level input current            | Device powered; V <sub>IL</sub> = 0.8-V;<br>I <sub>L_HPD</sub> includes R <sub>pdHPD</sub> resistor current |     |     | 30  | μA   |
| R <sub>pdHPD</sub> | HPD input termination to GND       | V <sub>CC</sub> = 0-V                                                                                       | 150 | 190 | 220 | kΩ   |

## 7.10 HDMI and DVI Main Link Switching Characteristics

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER                |                                                                                                                                            | TEST CONDITIONS                                                                                            | MIN  | TYP | MAX                                                 | UNIT |
|--------------------------|--------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------|------|-----|-----------------------------------------------------|------|
| <b>REDRIVER MODE</b>     |                                                                                                                                            |                                                                                                            |      |     |                                                     |      |
| D <sub>R</sub>           | Data rate (Automatic Mode)                                                                                                                 |                                                                                                            | 250  |     | 1000                                                | Mbps |
| D <sub>R</sub>           | Data rate (full redriver mode)                                                                                                             |                                                                                                            | 250  |     | 6000                                                | Mbps |
| t <sub>PLH</sub>         | Propagation delay time (low to high)                                                                                                       |                                                                                                            | 250  |     | 600                                                 | ps   |
| t <sub>PHL</sub>         | Propagation delay time (high to low)                                                                                                       |                                                                                                            | 250  |     | 800                                                 | ps   |
| t <sub>T1</sub>          | Transition time (rise and fall time); measured at 20% and 80% levels for data lanes. TMDS clock meets t <sub>T3</sub> for all three times. | SLEW_CTL = H; TX_TERM_CTL = L; PRE_SEL = NC; OE = H; DR = 6 Gbps                                           | 45   |     |                                                     | ps   |
| t <sub>T2</sub>          |                                                                                                                                            | SLEW_CTL = L; TX_TERM_CTL = NC; PRE_SEL = NC; OE = H; DR = 6 Gbps                                          | 65   |     |                                                     |      |
| t <sub>T3</sub>          |                                                                                                                                            | SLEW_CTL = NC; TX_TERM_CTL = NC; PRE_SEL = NC; OE = H; DR = 6 Gbps; CLK 150MHz                             | 100  |     |                                                     |      |
| t <sub>SK1(T)</sub>      | Intra-pair output skew                                                                                                                     | SLEW_CTL = NC; TX_TERM_CTL = NC; PRE_SEL = NC; OE = H; DR = 6 Gbps;                                        |      |     | 40                                                  | ps   |
| t <sub>SK2(T)</sub>      | Inter-pair output skew                                                                                                                     | SLEW_CTL = NC; TX_TERM_CTL = NC; PRE_SEL = NC; OE = H; DR = 6 Gbps;                                        |      |     | 100                                                 | ps   |
| t <sub>JITD1(1.4b)</sub> | Total output data jitter                                                                                                                   | DR = 2.97 Gbps, HDMI_SEL/A1 = NC, EQ_SEL/A0 = NC; PRE_SEL = NC; SLEW_CTL = H OE = H. See Figure 10 at TTP3 |      |     | 0.2                                                 | Tbit |
| t <sub>JITD1(2.0)</sub>  | Total output data jitter                                                                                                                   | 3.4Gbps < Rbit ≤ 3.712Gbps SLEW_CTL = H; TX_TERM_CTL = NC; PRE_SEL = NC; OE = H                            |      |     | 0.4                                                 | Tbit |
|                          |                                                                                                                                            | 3.712Gbps < Rbit < 5.94Gbps SLEW_CTL = H; TX_TERM_CTL = NC; PRE_SEL = NC; OE = H                           |      |     | -0.033<br>2Rbit2<br>+0.23<br>12<br>Rbit +<br>0.1998 | Tbit |
|                          |                                                                                                                                            | 5.94Gbps ≤ Rbit ≤ 6.0Gbps SLEW_CTL = H; TX_TERM_CTL = NC; PRE_SEL = NC; OE = H                             |      |     | 0.8                                                 | Tbit |
| t <sub>JITC1(1.4b)</sub> | Total output clock jitter                                                                                                                  | CLK = 297 MHz                                                                                              |      |     | 0.25                                                | Tbit |
| t <sub>JITC1(2.0)</sub>  | Total output clock jitter                                                                                                                  | DR = 6Gbps: CLK = 150 MHz                                                                                  |      |     | 0.3                                                 | Tbit |
| <b>RETIMER MODE</b>      |                                                                                                                                            |                                                                                                            |      |     |                                                     |      |
| d <sub>R</sub>           | Data rate (Full retimer mode)                                                                                                              |                                                                                                            | 0.25 |     | 6                                                   | Gbps |
| d <sub>R</sub>           | Data rate (Automatic mode)                                                                                                                 |                                                                                                            | 1.0  |     | 6                                                   | Gbps |
| d <sub>XVR</sub>         | Automatic redriver to retimer crossover                                                                                                    | Measured with input signal applied from 0 to 200 mVpp                                                      | .75  | 1.0 | 1.25                                                | Gbps |
| f <sub>CROSSOVER</sub>   | Crossover frequency hysteresis                                                                                                             |                                                                                                            |      | 250 |                                                     | MHz  |
| P <sub>LLBW</sub>        | Data retimer PLL bandwidth                                                                                                                 | Default loop bandwidth setting                                                                             |      | .4  | 1                                                   | MHz  |
| t <sub>ACQ</sub>         | Input clock frequency detection and retimer acquisition time                                                                               |                                                                                                            |      | 180 |                                                     | μs   |
| I <sub>JT1</sub>         | Input clock jitter tolerance                                                                                                               | Tested when data rate > 1.0 Gbps                                                                           |      |     | 0.3                                                 | Tbit |
| t <sub>T1</sub>          | Transition time (rise and fall time); measured at 20% and 80% levels for data lanes. TMDS clock meets t <sub>T3</sub> for all three times. | SLEW_CTL = H; TX_TERM_CTL = L; PRE_SEL = NC; OE = H; DR = 6 Gbps                                           | 45   |     |                                                     | ps   |
| t <sub>T2</sub>          |                                                                                                                                            | SLEW_CTL = L; TX_TERM_CTL = NC; PRE_SEL = NC; OE = H; DR = 6 Gbps                                          | 65   |     |                                                     |      |
| t <sub>T3</sub>          |                                                                                                                                            | SLEW_CTL = NC; TX_TERM_CTL = NC; PRE_SEL = NC; OE = H; DR = 6 Gbps; CLK = 150 MHz                          | 100  |     |                                                     |      |
| t <sub>DCD</sub>         | OUT_CLK ± duty cycle                                                                                                                       |                                                                                                            | 40%  | 50% | 60%                                                 |      |

## HDMI and DVI Main Link Switching Characteristics (continued)

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER         |                                                   | TEST CONDITIONS                                                       | MIN | TYP     | MAX     | UNIT |
|-------------------|---------------------------------------------------|-----------------------------------------------------------------------|-----|---------|---------|------|
| $t_{SK\_INTER}$   | Inter-pair output skew                            | Default setting for internal inter-pair skew adjust, HDMI_SEL/A1 = NC |     |         | 0.2     | Tch  |
| $t_{SK\_INTRA}$   |                                                   |                                                                       |     |         | 0.15    | Tbit |
| $t_{JITC1(1.4b)}$ | Total output clock jitter                         | CLK = 297 MHz                                                         |     |         | 0.25    | Tbit |
| $t_{JITC1(2.0)}$  | Total output clock jitter                         | DR = 6Gbps: CLK = 150 MHz                                             |     |         | 0.3     | Tbit |
| $t_{JITD2}$       | Total output data jitter                          | 3.4 Gbps < $R_{bit} \leq 3.712$ Gbps                                  |     |         | 0.4     | Tbit |
|                   |                                                   | 3.712 Gbps < $R_{bit} < 5.94$ Gbps                                    |     |         | See (1) |      |
|                   |                                                   | 5.94 Gbps $\leq R_{bit} \leq 6.0$ Gbps                                |     |         | 0.6     |      |
| $V_{OD\_range}$   | Total TMDS data lanes output differential voltage | 3.4 Gbps < $R_{bit} \leq 3.712$ Gbps                                  |     | 335     |         | mV   |
|                   |                                                   | 3.712 Gbps < $R_{bit} < 5.94$ Gbps                                    |     | See (2) |         |      |
|                   |                                                   | 5.94 Gbps $\leq R_{bit} \leq 6.0$ Gbps                                |     | 150     |         |      |

(1)  $-0.0332R_{bit}^2 + 0.2312 R_{bit} + 0.1998$

(2)  $-19.66 \times (R_{bit}^2) + (106.74 \times R_{bit}) + 209.58$

## 7.11 AUX Switching Characteristics (Only for RGZ Package)

over operating free-air temperature range (unless otherwise noted)

| PARAMETER                 | TEST CONDITIONS                             | MIN | TYP | MAX  | UNIT              |
|---------------------------|---------------------------------------------|-----|-----|------|-------------------|
| UI <sub>MAN</sub>         | Manchester transaction unit interval        | 0.4 |     | 0.6  | μs                |
| t <sub>AUXjitter_TX</sub> | Cycle-to-cycle jitter time at transmit pins |     |     | 0.08 | UI <sub>MAN</sub> |
| t <sub>AUXjitter_RX</sub> | Cycle-to-cycle jitter time receive pins     |     |     | 0.05 | UI <sub>MAN</sub> |

## 7.12 HPD Switching Characteristics

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER            |                                                                         | TEST CONDITIONS                                | MIN | TYP | MAX | UNIT |
|----------------------|-------------------------------------------------------------------------|------------------------------------------------|-----|-----|-----|------|
| t <sub>PD(HPD)</sub> | Propagation delay from HPD_SNK to HPD_SRC; rising edge and falling edge | See Figure 14; not valid during switching time |     | 40  | 120 | ns   |
| t <sub>T(HPD)</sub>  | HPD logical disconnected timeout                                        | See Figure 15                                  |     | 2   |     | ms   |

## 7.13 DDC and I<sup>2</sup>C Switching Characteristics

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER            | TEST CONDITIONS                                  | MIN                                                                                        | TYP | MAX | UNIT |
|----------------------|--------------------------------------------------|--------------------------------------------------------------------------------------------|-----|-----|------|
| t <sub>r</sub>       | Rise time of both SDA and SCL signals            |                                                                                            |     | 300 | ns   |
| t <sub>f</sub>       | Fall time of both SDA and SCL signals            |                                                                                            |     | 300 | ns   |
| t <sub>HIGH</sub>    | Pulse duration, SCL high                         | 0.6                                                                                        |     |     | μs   |
| t <sub>LOW</sub>     | Pulse duration, SCL low                          | 1.3                                                                                        |     |     | μs   |
| t <sub>SU1</sub>     | Setup time, SDA to SCL                           | 100                                                                                        |     |     | ns   |
| t <sub>ST, STA</sub> | Setup time, SCL to start condition               | 0.6                                                                                        |     |     | μs   |
| t <sub>HD, STA</sub> | Hold time, start condition to SCL                | 0.6                                                                                        |     |     | μs   |
| t <sub>ST, STO</sub> | Setup time, SCL to stop condition                | 0.6                                                                                        |     |     | μs   |
| t <sub>(BUF)</sub>   | Bus free time between stop and start condition.  | 1.3                                                                                        |     |     | μs   |
| t <sub>PLH1</sub>    | Propagation delay time, low-to-high-level output | Source-to-sink: 100-kbps pattern;<br>Cb(Sink) = 400-pF <sup>(1)</sup> ;<br>See Figure 18   |     | 360 | ns   |
| t <sub>PHL1</sub>    | Propagation delay time, high-to-low-level output |                                                                                            |     | 230 | ns   |
| t <sub>PLH2</sub>    | Propagation delay time, low-to-high-level output | Sink to Source: 100-kbps pattern;<br>Cb(Source) = 100-pF <sup>(1)</sup> ;<br>See Figure 19 |     | 250 | ns   |
| t <sub>PHL2</sub>    | Propagation delay time, high-to-low-level output |                                                                                            |     | 200 | ns   |

(1) Cb = total capacitance of one bus line in pF.

## 7.14 Typical Characteristics

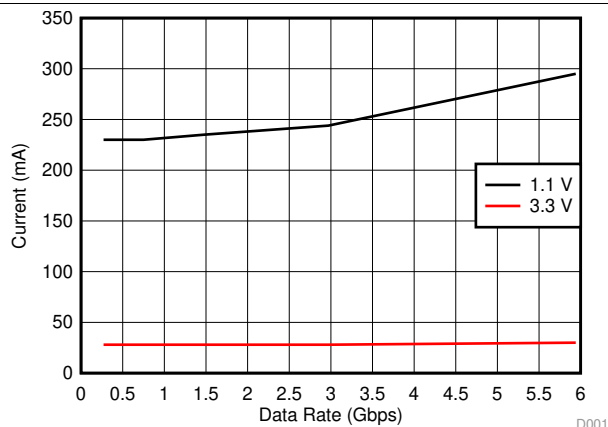


Figure 1. Current vs Data Rate in Retimer Mode

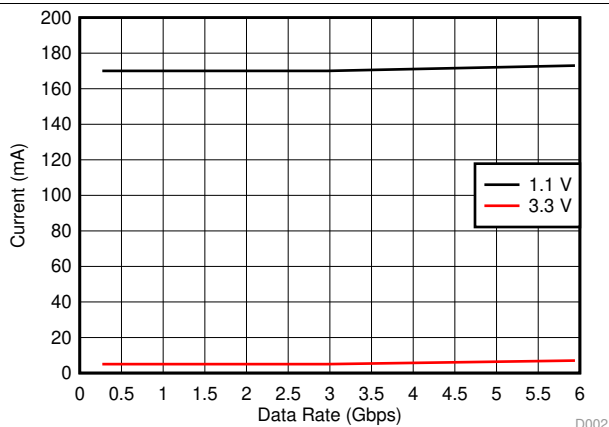


Figure 2. Current vs Data Rate in Redriver Mode

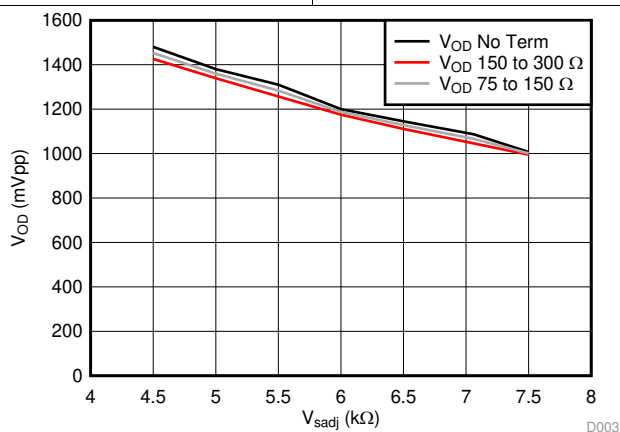


Figure 3.  $V_{OD}$  vs  $V_{sadj}$

## 8 Parameter Measurement Information

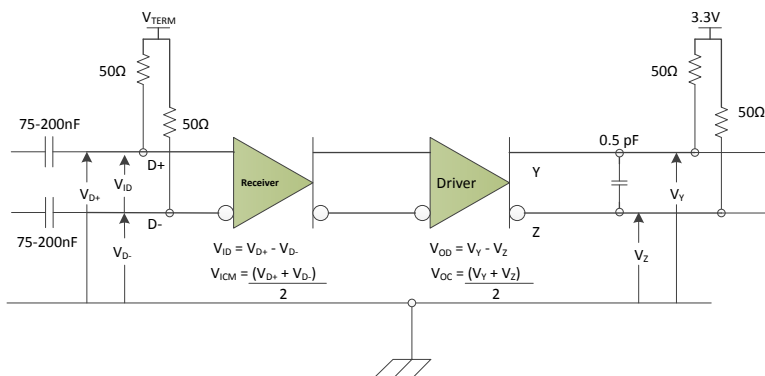
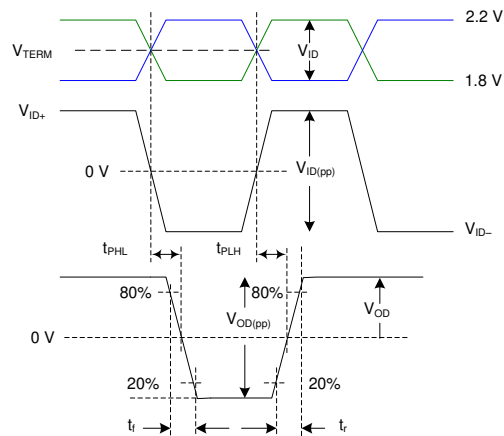
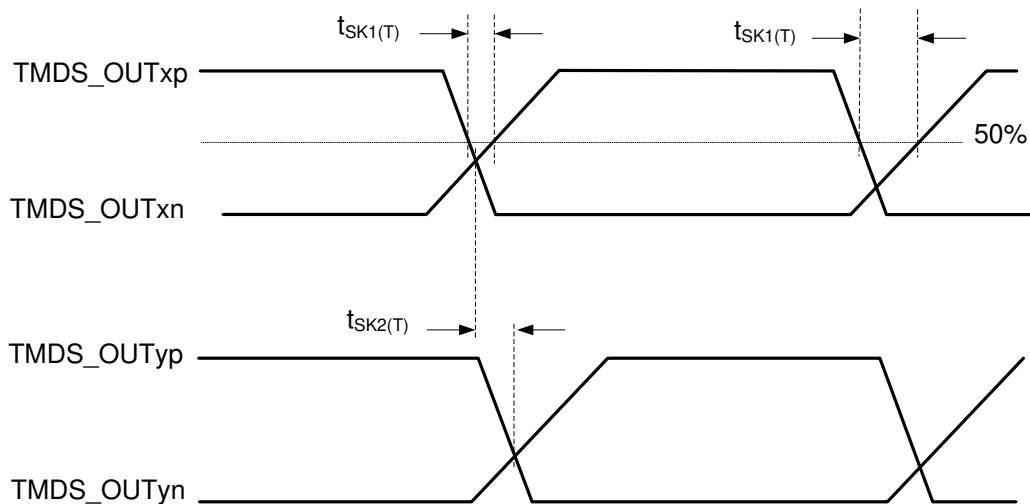


Figure 4. TMD5 Main Link Test Circuit

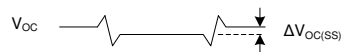
## Parameter Measurement Information (continued)



**Figure 5. Input and Output Timing Measurements**

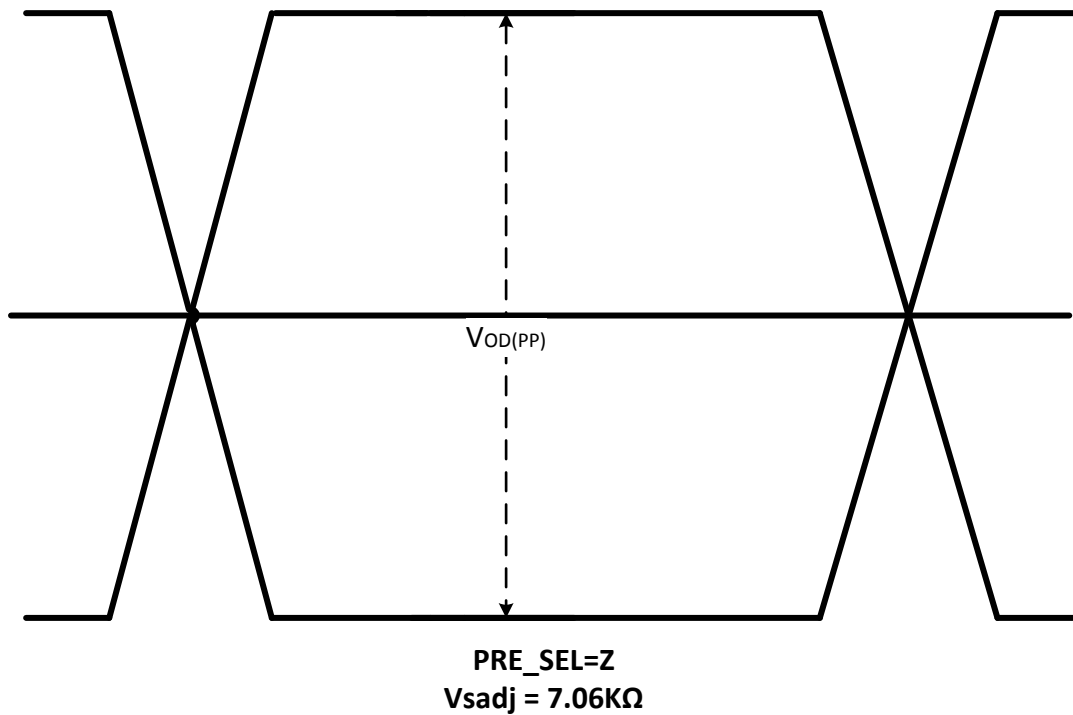


**Figure 6. HDMI and DVI Sink TMDS Output Skew Measurements**

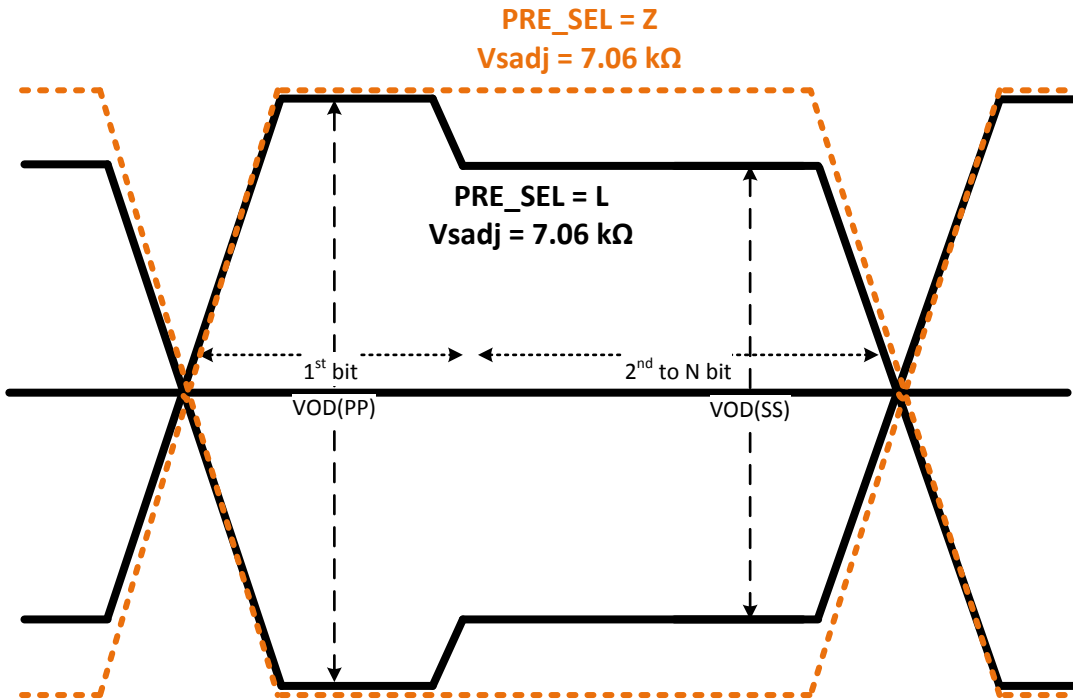


**Figure 7. TMDS Main Link Common Mode Measurements**

**Parameter Measurement Information (continued)**

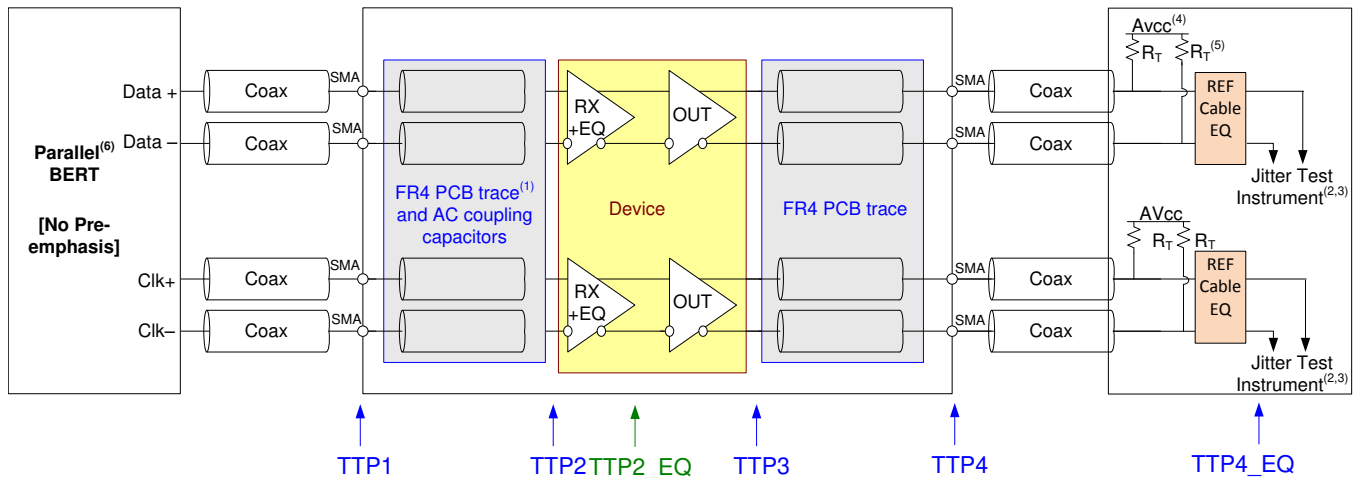


**Figure 8. Output Differential Waveform 0 dB De-Emphasis**



**Figure 9. PRE\_SEL = L for -2-dB De-Emphasis**

## Parameter Measurement Information (continued)



- (1) The FR4 trace between TTP1 and TTP2 is designed to emulate 1-8" of FR4, AC coupling cap, connector and another 1-2" of FR4. Trace width – 4 mils. 100-Ω differential impedance.
- (2) All jitter is measured at a BER of 10<sup>-9</sup>.
- (3) Residual jitter reflects the total jitter measured at TTP4 minus the jitter measured at TTP1.
- (4) AVCC = 3.3-V
- (5) RT = 50-Ω
- (6) The input signal from parallel bit error rate tester (BERT) does not have any pre-emphasis. Refer to [Recommended Operating Conditions](#).

Figure 10. TMDS Output Jitter Measurement

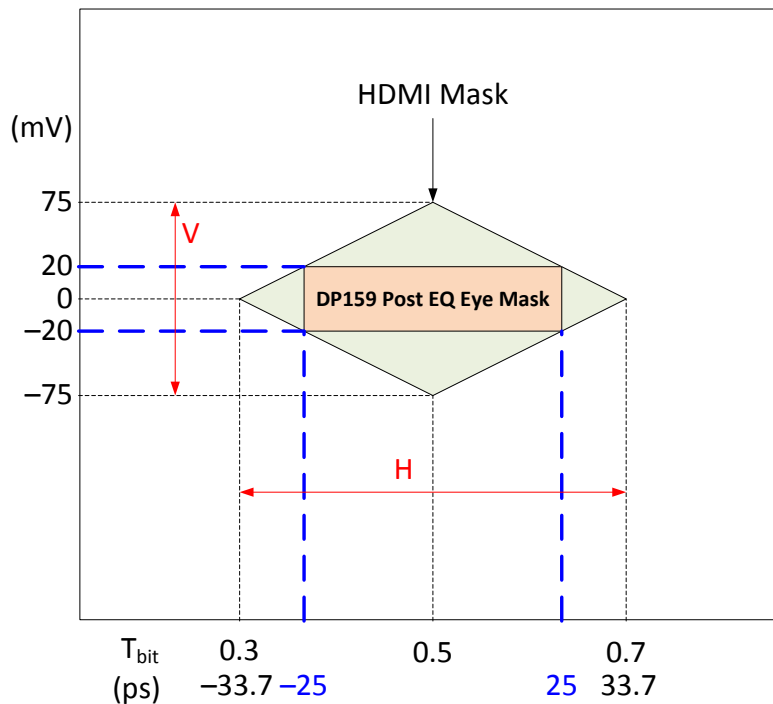
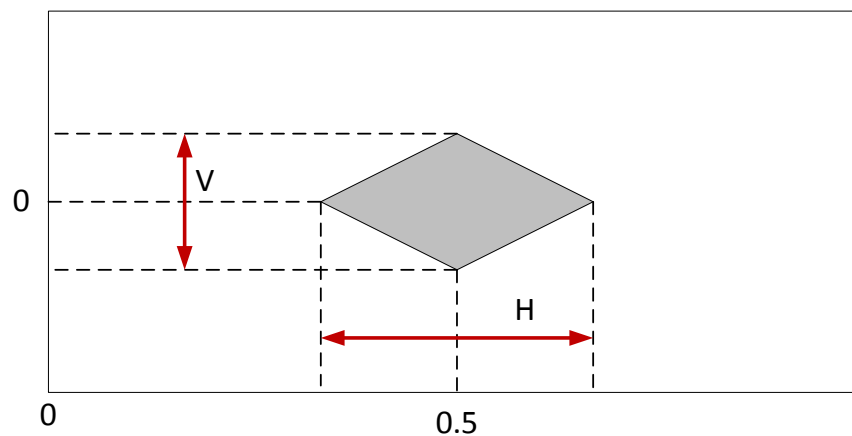


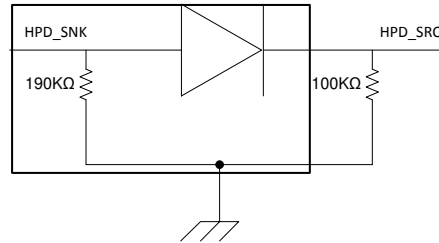
Figure 11. Post EQ Input Eye Mask at TTP2\_EQ

## Parameter Measurement Information (continued)

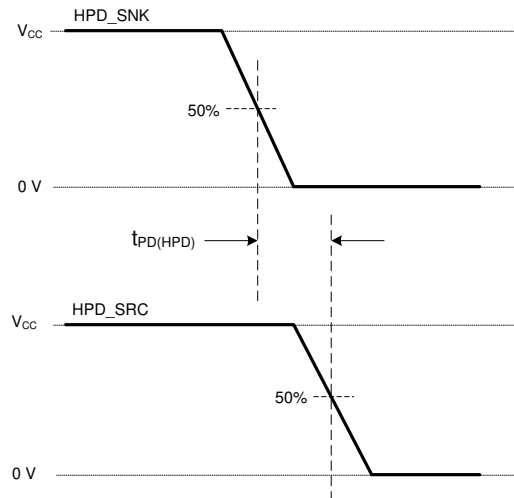


| TMDS DATA RATE (Gbps)   | H (Tbit)                                    | V (mV)                                     |
|-------------------------|---------------------------------------------|--------------------------------------------|
| $3.4 < DR < 3.712$      | 0.6                                         | 335                                        |
| $3.712 < DR < 5.94$     | $-0.0332R_{bit}^2 + 0.2312R_{bit} + 0.1998$ | $-19.66R_{bit}^2 + 106.74R_{bit} + 209.58$ |
| $5.94 \leq DR \leq 6.0$ | 0.4                                         | 150                                        |

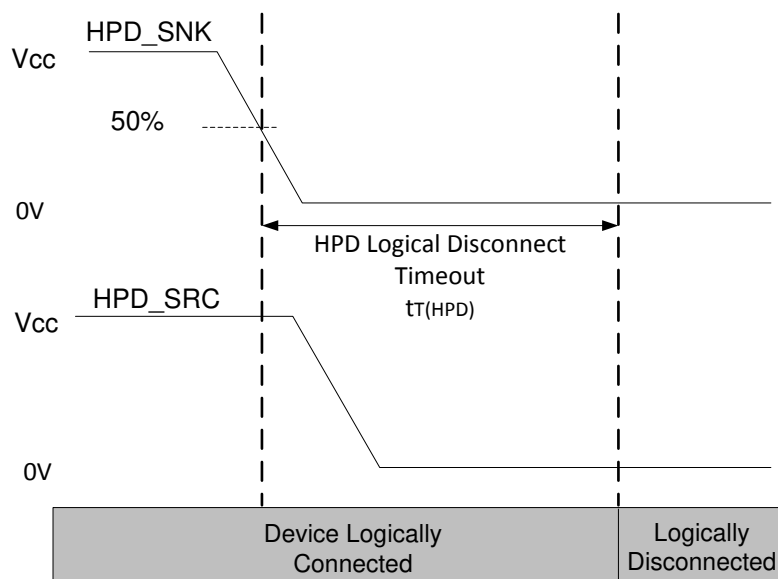
**Figure 12. Output Eye Mask at TTP4\_EQ**



**Figure 13. HPD Test Circuit**



**Figure 14. HPD Timing Diagram Number 1**



**Figure 15. HPD Logic Disconnect Timeout**

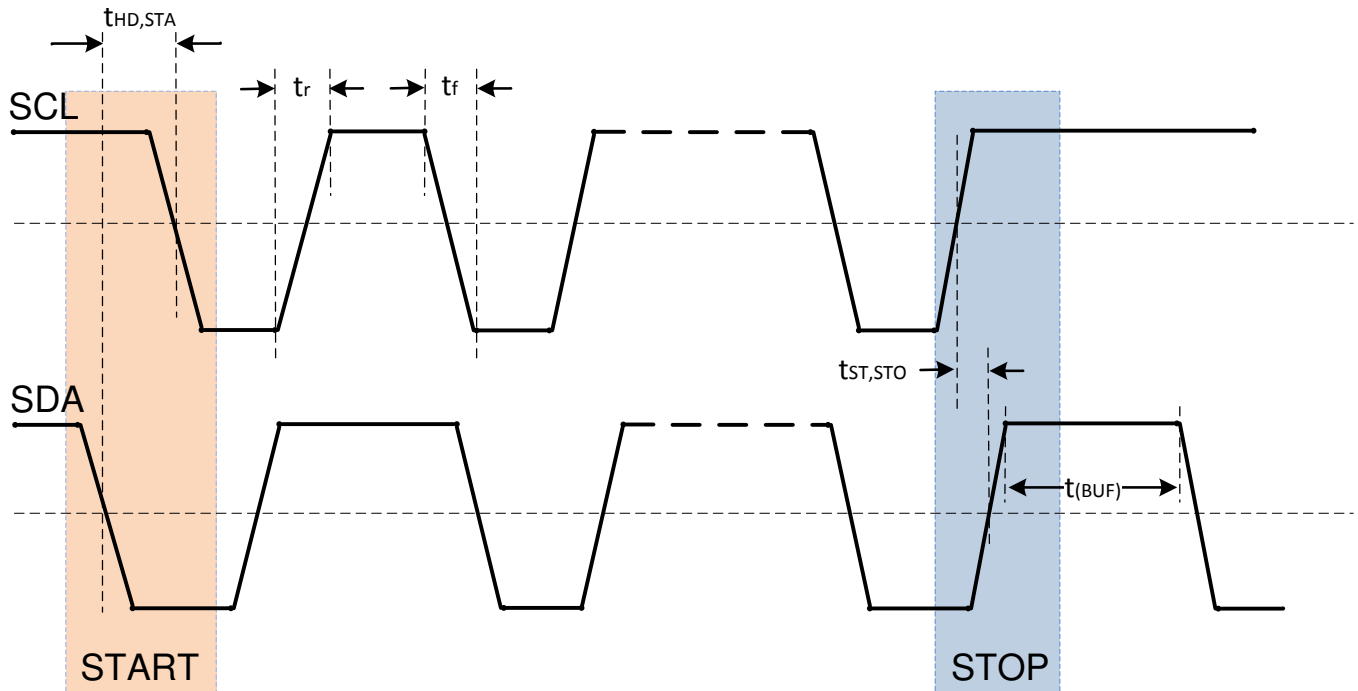


Figure 16. Start and Stop Condition Timing

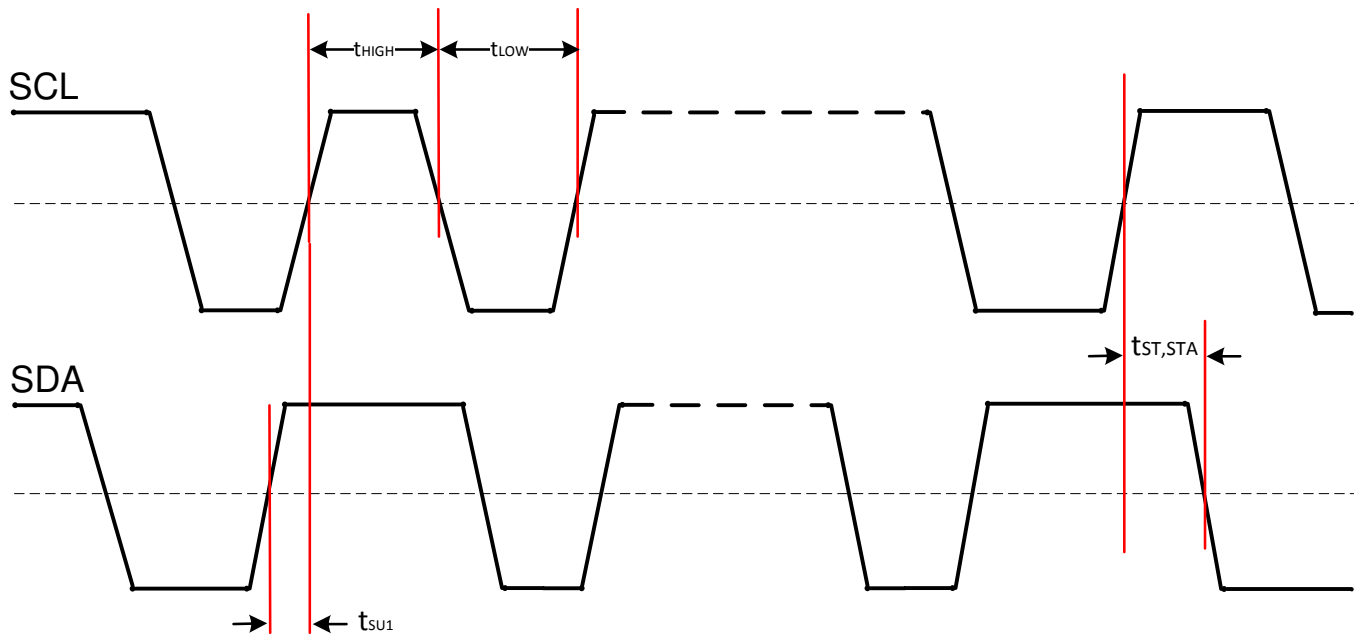
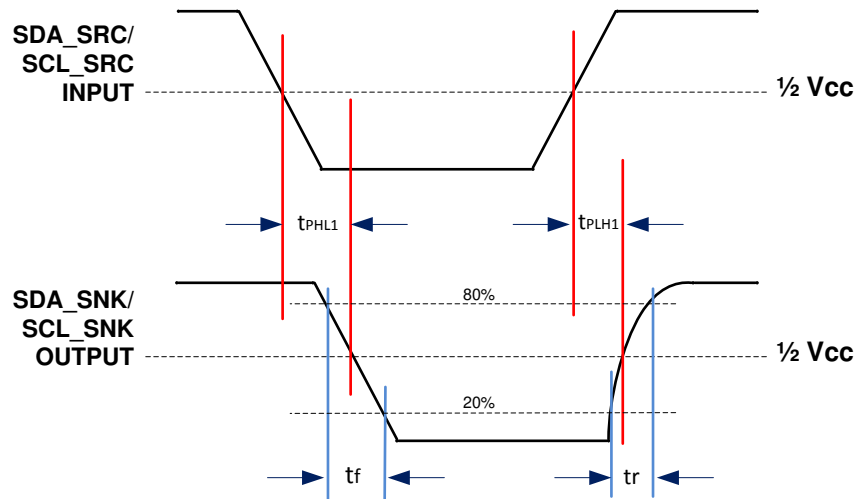
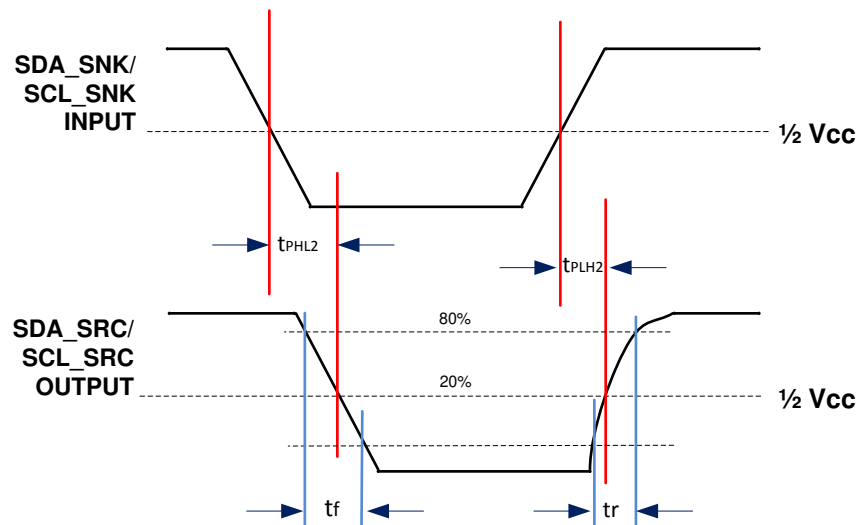


Figure 17. SCL and SDA Timing

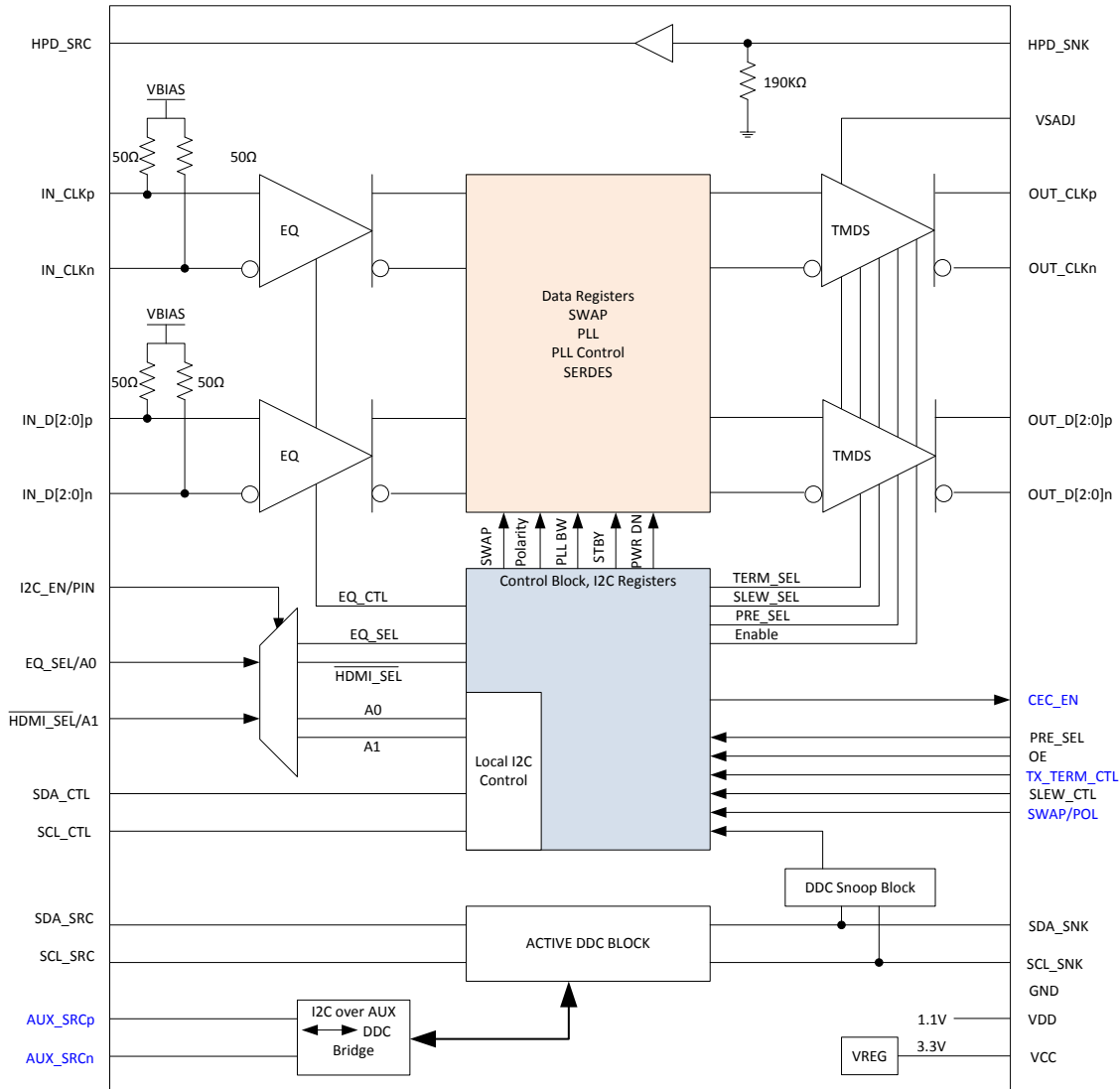

**Figure 18. DDC Propagation Delay – Source to Sink**

**Figure 19. DDC Propagation Delay – Sink to Source**

## 9 Detailed Description

### 9.1 Overview

The SNx5DP159 device is a Dual Mode[1] DisplayPort retiming level shifter that supports data rates up to 6-Gbps for HDMI2.0b. The device takes in AC coupled HDMI/DVI signals and level shifts them to TMDS signals while compensating for loss and jitter through its receiver equalizer and retiming functions. The SNx5DP159 in default configuration should meet most system needs but also provides features that allow the system implementer flexibility in design. Programming can be accomplished through I<sup>2</sup>C[4] or pin strapping.

### 9.2 Functional Block Diagram



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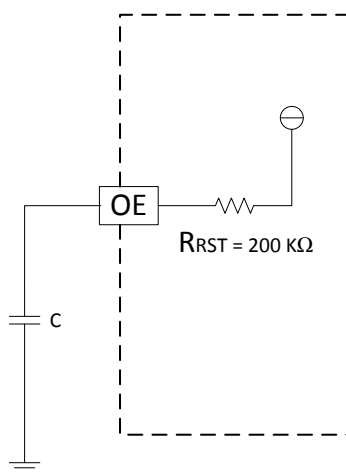
NOTE: **Black** pin names are common to both packages.

**Blue** pin names are only in the SNx5DP159 RGZ package.

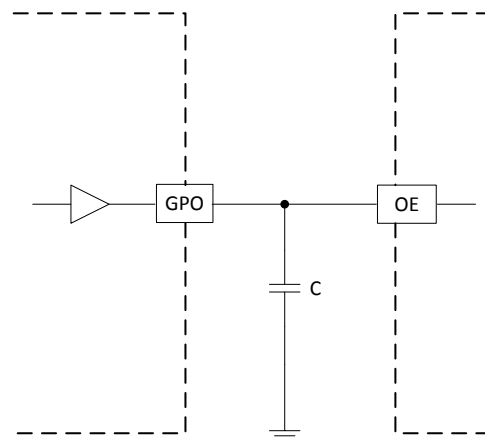
## 9.3 Feature Description

### 9.3.1 Reset Implementation

When OE is de-asserted, control signal inputs are ignored; the Dual Mode<sup>[1]</sup> DisplayPort inputs and outputs are high impedance. It is critical to transition the OE input from a low level to a high level after the  $V_{CC}$  supply has reached the minimum recommended operating voltage. Achieve this transition by a control signal to the OE input, or by an external capacitor connected between OE and GND. To ensure that the SNx5DP159 device is properly reset, the OE pin must be de-asserted for at least 100- $\mu$ s before being asserted. When OE is toggled in this manner the device is reset. This requires the device to be reprogrammed if it was originally programmed through I<sup>2</sup>C for configuration. When implementing the external capacitor, the size of the external capacitor depends on the power-up ramp of the  $V_{CC}$  supply, where a slower ramp-up results in a larger value external capacitor. Refer to the latest reference schematic for SNx5DP159; consider approximately 200-nF capacitor as a reasonable first estimate for the size of the external capacitor. Both OE implementations are shown in [Figure 20](#) and [Figure 21](#).



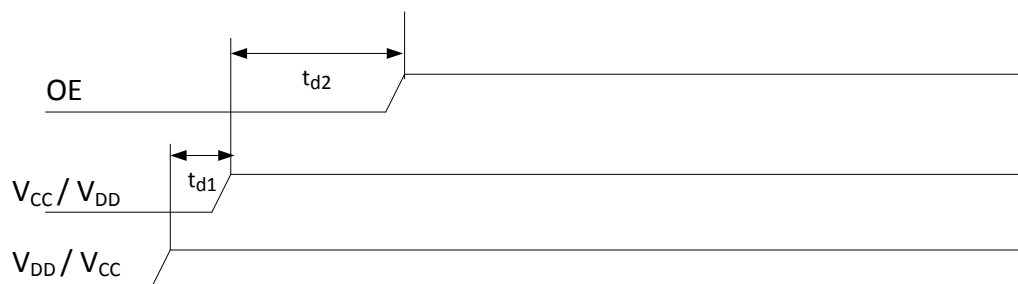
**Figure 20. External Capacitor Controlled OE**



**Figure 21. OE Input from Active Controller**

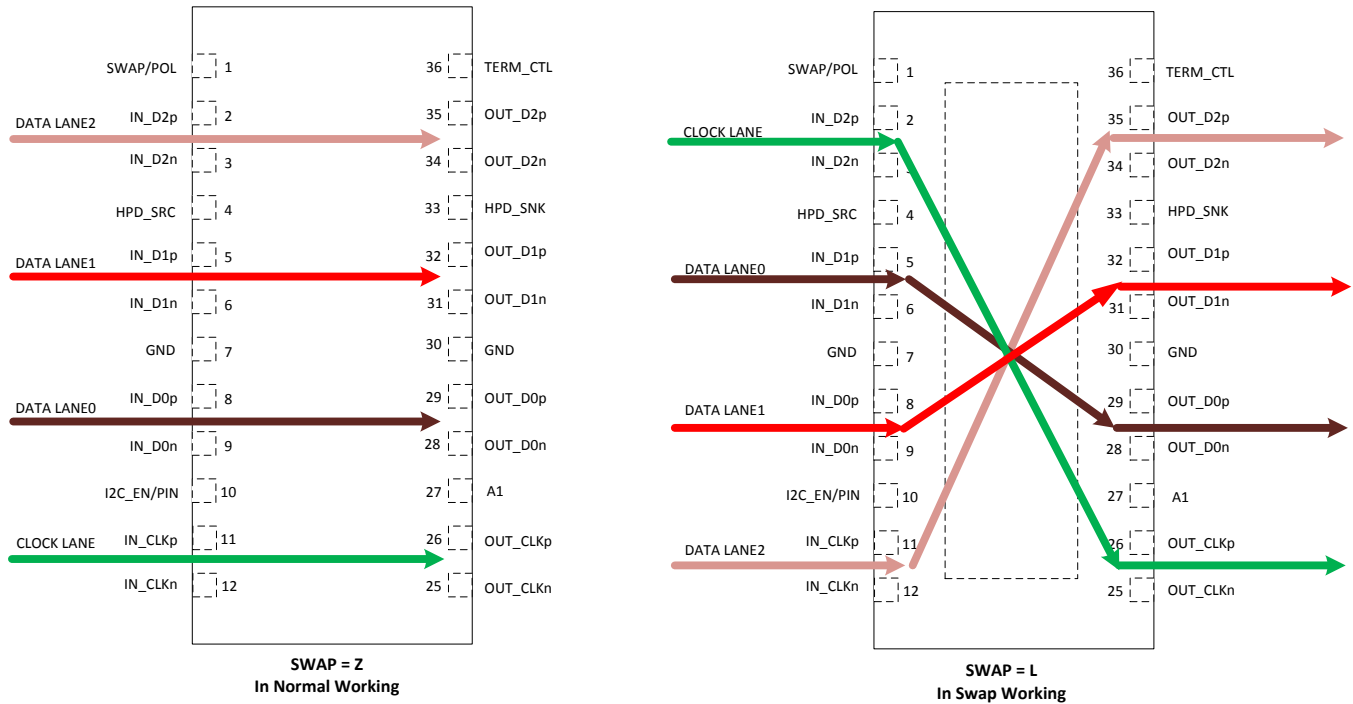
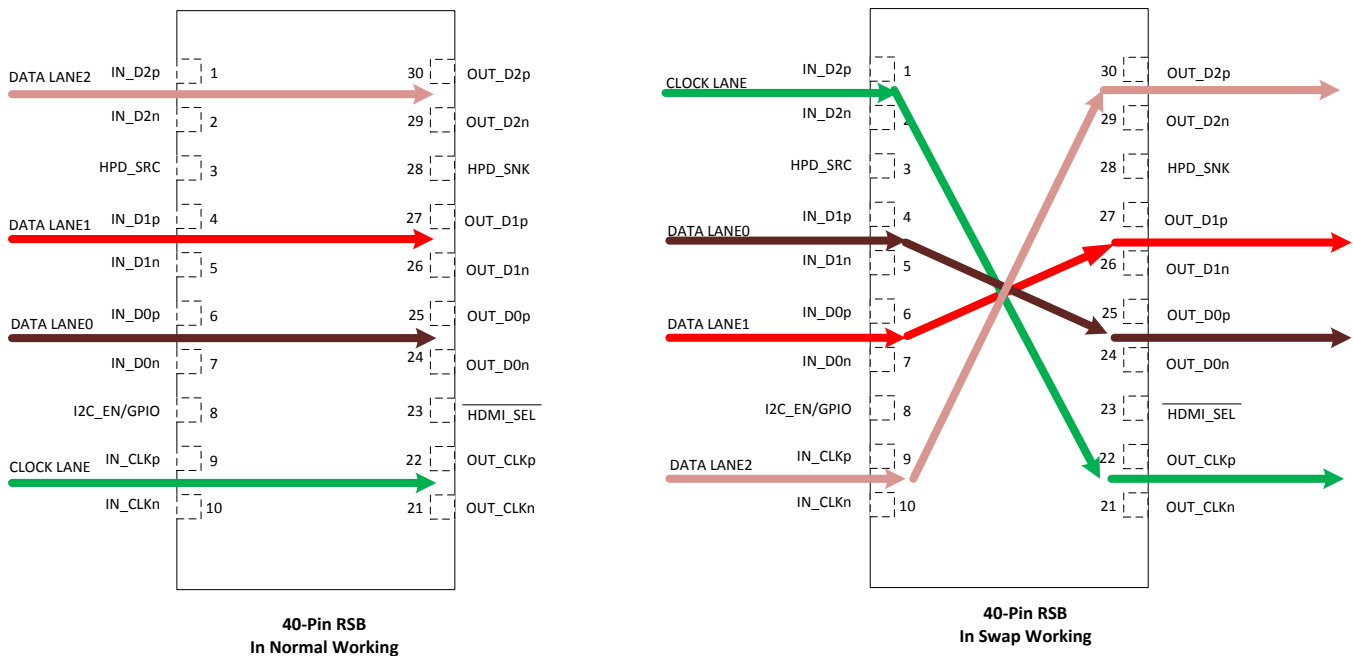
### 9.3.2 Operation Timing

SNx5DP159 starts to operate after the OE signal goes high (see [Figure 22](#), [Figure 23](#), and [Table 1](#)). Keeping OE low until  $V_{DD}$  and  $V_{CC}$  become stable avoids any timing requirements as shown in [Figure 22](#).



**Figure 22. Power-Up Timing for SSNx5DP159**




**Figure 24. SNx5DP159 Swap Function for 48 Pins**

**Figure 25. SNx5DP159 Swap Function for 40 Pins**

The SNx5DP159 can also change the polarity of the input signals. When SWAP/POL is high, the n and p pins on each lane will swap. Use Register 0x9h bit 6 to swap polarity using I<sup>2</sup>C. Polarity swap only works for retimer mode. When the device is in automatic redriver to retimer mode this only works when device is in retimer stage. If set and data rate falls below 1.0-Gbps in this mode the polarity function will be lost.

### 9.3.5 Main Link Inputs

Standard Dual Mode[1] DisplayPort terminations are integrated on all inputs with expected AC coupling capacitors on board prior to input pins. External terminations are not required. Each input data channel contains an adaptive or fixed equalizer to compensate for cable or board losses. The voltage at the input pins must be limited below the absolute maximum ratings. The input pins have incorporated failsafe circuits. The input pins can be polarity changed through the local I2C register or pin strapping.

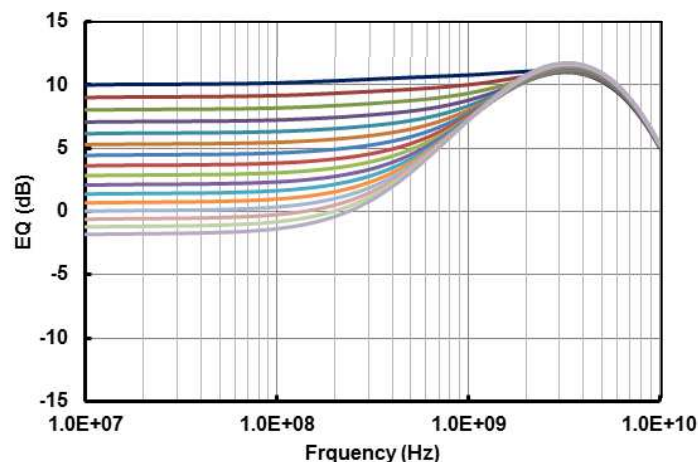
### 9.3.6 Main Link Inputs Debug Tools

There are two methods for debugging a system making sure the inputs to the SNx5DP159 are valid. A TMDS error checker is implemented that will increment an error counter per data lane. This allows the system implementer to determine how the link between the source and SNx5DP159 is performing on all three data lanes. See CSR Bit Field Definitions – RX PATTERN VERIFIER CONTROL/STATUS register in Table 10.

If a high error count is evident, the SNx5DP159 has the ability to provide the general eye quality. A tool is available that uses the I<sup>2</sup>C[4] link to download data that can be plotted for an eye diagram. This is available per data lane.

### 9.3.7 Receiver Equalizer

Equalizers are used to clean up inter-symbol interference (ISI) jitter or loss from the bandwidth-limited board traces or cables. The SNx5DP159 device supports both fixed receiver equalizer (redriver and retimer mode) and adaptive receive equalizer (retimer mode) by setting the EQ\_SEL/A0 pin or through I<sup>2</sup>C using reg0Ah[5]. When the EQ\_SEL/A0 pin is high, the EQ gain is fixed to 14-dB. The EQ gain will be 7.5-dB if the EQ\_SEL/A0 pin is set low. The SNx5DP159 device operates in adaptive equalizer mode when EQ\_SEL/A0 left floating. Using adaptive equalization the gain will be automatically adjusted based on the data rate to compensate for variable trace or cable loss. Using the local I<sup>2</sup>C[4] control, reg0Dh[5:1], the fixed EQ gain can be selected for both data and clock.



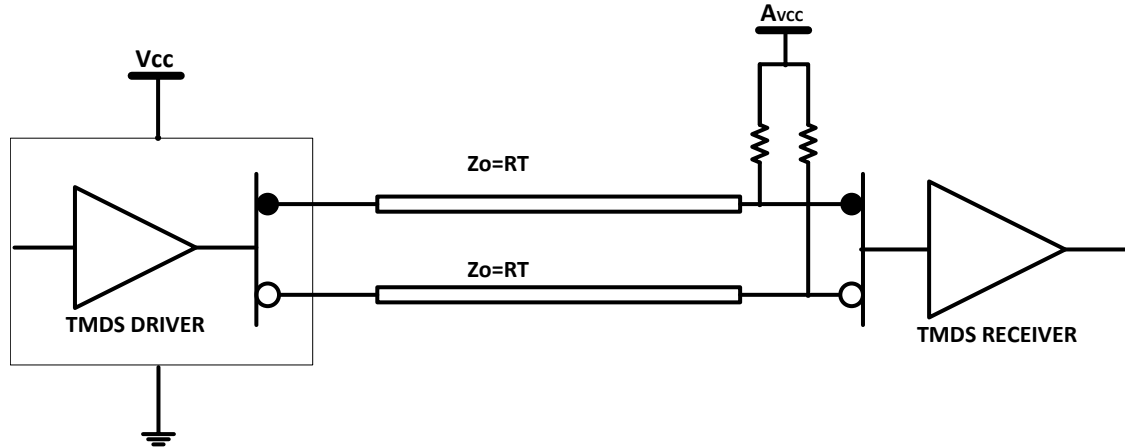
**Figure 26. Adaptive EQ Gain Curve**

### 9.3.8 Termination Impedance Control

HDMI2.0[3] standard requires the transmitter termination impedance should be between 75 to 150-Ω. Older versions of the HDMI standard required no source termination. For HDMI1.4b[2] when data rate over 2 Gbps, the output performance could be better if the termination value between 150 to 300-Ω which was allowed. The SNx5DP159 supports three different source termination impedances for HDMI1.4b[2] and HDMI2.0[3]. Pin 36, TX\_TERM\_CTL, offers a selection option to choose the output termination impedance value. This can be adjusted by I<sup>2</sup>C[4]; reg0Bh[4:3] TX\_TERM\_CTL.

### 9.3.9 TMDS Outputs

An 1% precision resistor, 7.06-k $\Omega$ , is recommended to be connected from Vsadj pin to ground to allow the differential output swing to comply with TMDS signal levels. The differential output driver provides a typical 10-mA current sink capability when no source term is enabled, which provides a typical 500-mV voltage drop across a 50- $\Omega$  termination resistor. As compliance testing is system dependant this resistor value can be adjusted.



**Figure 27. TMDS Driver and Termination Circuit**

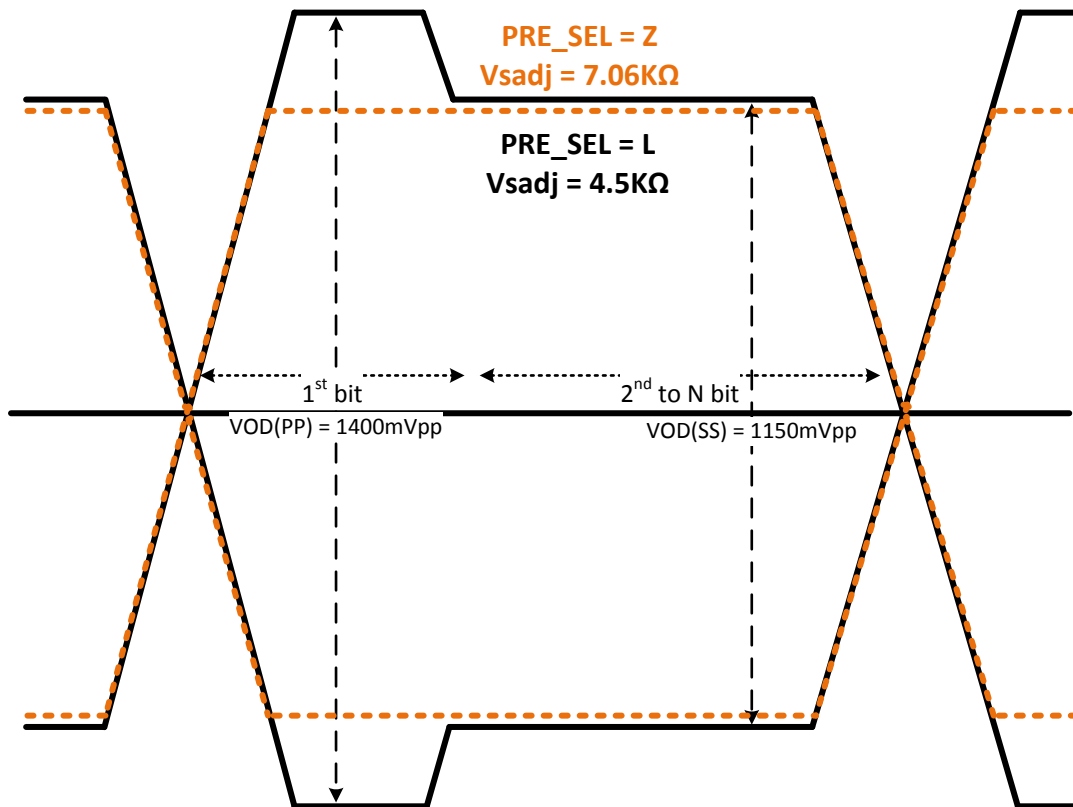
Referring to [Figure 27](#), if both V<sub>CC</sub> (device supply) and AVCC (sink termination supply) are powered, the TMDS output signals are high impedance when OE = low. The normal operating condition is that both supplies are active. A total of 33-mW of power is consumed by the terminations independent of the OE logical selection. When AVCC is powered on, normal operation (OE controls output impedance) is resumed. When the power source of the device is off and the power source to termination is on, the IO(off) (output leakage current) specification ensures the leakage current is limited 45- $\mu$ A or less.

The clock and data lanes V<sub>OD</sub> can be changed through I<sup>2</sup>C[4] (see VSWING\_CLK and VSWING\_DATA in [Table 8](#) for details). [Figure 3](#) shows the different output voltage based on different Vsadj resistor values.

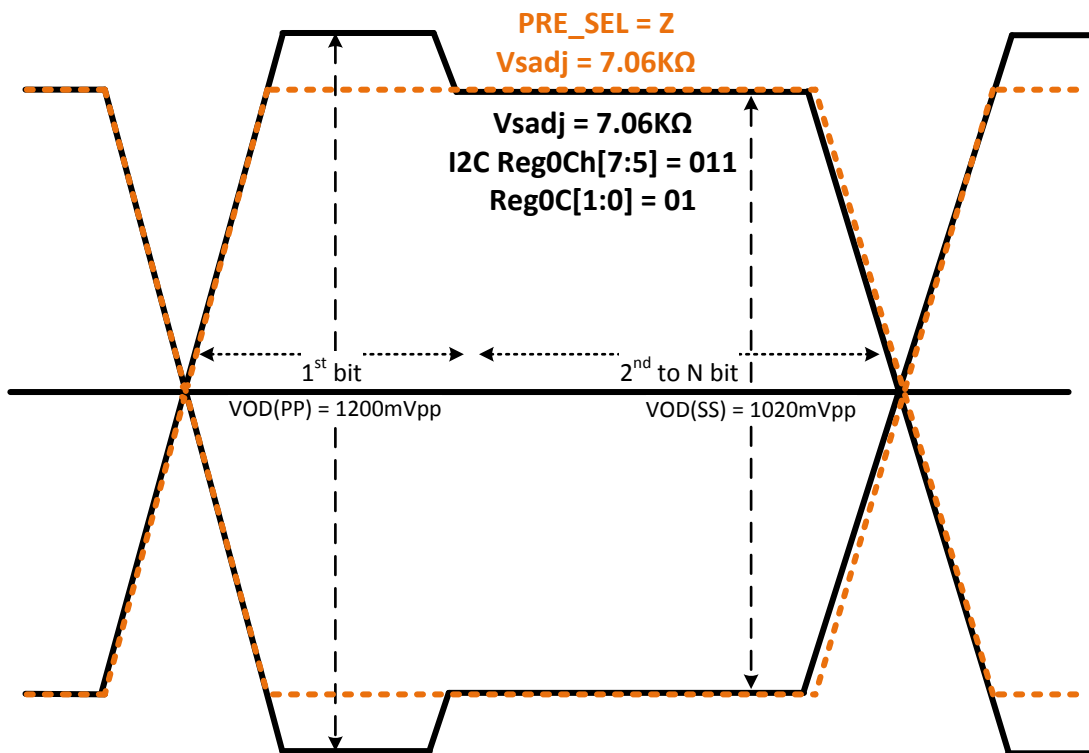
#### 9.3.9.1 Pre-Emphasis/De-Emphasis

The SNx5DP159 provides De-emphasis as a way to compensate for the ISI loss between the TMDS outputs and the receiver it is driving. There are two methods to implement this function. When in pin strapping mode the PRE\_SEL pin controls this. The PRE\_SEL pin provides –2-dB, or 0-dB de-emphasis, which allows output signal pre-conditioning to offset interconnect losses from the SNx5DP159 device outputs to a TMDS receiver. TI recommends setting PRE\_SEL at 0 dB while connecting to a receiver through a short PCB route. When pulled to ground with a 65-k $\Omega$  resistor –2-dB can be realized, see [Figure 9](#). When using I<sup>2</sup>C, Reg0Ch[1:0] is used to make these adjustments.

As there are times true pre-emphasis may be the best solution there are two ways to accomplish this. If pin strapping is being use the best method is to reduce the Vsadj resistor value increasing the V<sub>OD</sub> and then pulling the PRE\_SEL pin to ground using the 65-k $\Omega$  resistor, see [Figure 28](#). If using I<sup>2</sup>C this can be accomplished using two methods. First is similar to pin strapping by adjusting the Vsadj resistor value and then implementing –2-dB de-emphasis. Second method is to set Reg0Ch[7:5] = 011 and the set Reg0Ch[1:0] = 01 which accomplishes the same pre-emphasis setting. See [Figure 29](#).



**Figure 28. Pre-Emphasis Using Pin Strapping Method**



**Figure 29. Pre-Emphasis Using I²C Method**

## 9.4 Device Functional Modes

### 9.4.1 Retimer Mode

Clock and data recovery circuits (CDR) are used to track, sample and retimer the equalized data bit streams. The CDRs are designed with loop bandwidth to minimize the amount of jitter transfer from the video source to the TMDS outputs. Input jitter within the CDR's PLL bandwidth, < 1-MHz, will be transferred to the TMDS outputs. Higher frequency jitter above the CDR loop bandwidth is attenuated, providing a jitter cleaning function to reduce the amount of high frequency jitter from the video source. The retimer is automatically activated at pixel clock above approximately 100-MHz when jitter cleaning is needed for robust operation. The retimer operates at about 1.0 to 6-Gbps DR supporting HDMI2.0[3]. At pixel clock frequency below about 100 MHz, the SNx5DP159 automatically bypasses the internal retimer and operates as a redriver. When the video source changes resolution, the internal retimer starts the acquisition process to determine the input clock frequency and acquire lock to the new data bit streams. During the clock frequency detection period and the retimer acquisition period (that last approximately 7-ms), the TMDS drivers can be kept active (default) or programmed to be disabled to avoid sending invalid clock or data to the downstream receiver.

### 9.4.2 Redriver Mode

The SNx5DP159 also has a redriver mode that can be enabled through I<sup>2</sup>C[4]; at offset address 0Ah bits 1:0 DEV\_FUNC\_MODE. When in this mode, the CDR and PLL are shut off, thus reducing power. Jitter performance is degraded as the device will now only compensate for ISI loss in the link. In redriver mode HDMI2.0[3] compliance is not guaranteed as skew compensation and retiming functions are disabled. Excessive random or phase jitter will not be compensated.

### 9.4.3 DDC Training for HDMI2.0 Data Rate Monitor

As part of discovery, the source reads the sink's E-EDID information to understand the sink's capabilities. Part of this read is HDMI forum vendor specific data block (HF-VSDB) MAX\_TMDS\_Character\_Rate byte to determine the data rate supported. Depending upon the value, the source will write to slave address 0xA8 offset 0x20 bit1, TMDS\_CLOCK\_RATIO\_STATUS. The SNx5DP159 snoops this write to determine the TMDS clock ratio and thus sets its own TMDS\_CLOCK\_RATIO\_STATUS bit accordingly. If a 1 is written, then the TMDS clock is 1/40 of TMDS bit period. If a 0 is written, then the TMDS clock is 1/10 of TMDS bit period. The SNx5DP159 will always default to 1/10 of TMDS bit period unless a 1 is written to address 0xA8 offset 0x20 bit 1. When HPD\_SNK is de-asserted, this bit is reset to default values. If the source does not write this bit the SNx5DP159 will not be configured for TMDS clock 1/40 mode in support of HDMI2.0. As the SNx5DP159 is in link but not recognized as part of the link it is possible that the source could read the sink EDID where this bit is set and does not re-write this bit. If the SNx5DP159 has entered a power down state this bit is cleared and does not reset on a read. To work properly the bit has to be set again with a write by the source.

### 9.4.4 DDC Functional Description

The SNx5DP159 solves sink- or source-level issues by implementing a master/slave control mode for the DDC bus. When the SNx5DP159 detects the start condition on the DDC bus from the SDA\_SRC/SCL\_SRC, it will transfer the data or clock signal to the SDA\_SNK/SCL\_SNK with little propagation delay. When SDA\_SNK detects the feedback from the downstream device, the SNx5DP159 will pull up or pull down the SDA\_SRC bus and deliver the signal to the source.

The DDC link defaults to 100 kbps, but can be set to various values including 400 kbps by setting the correct value to address 22h (see [Table 3](#)) through the I<sup>2</sup>C access on the DDC interface. The DDC lines are 5-V tolerant. The HPD\_SRC goes to high impedance when VCC is under low power conditions, < 1.5-V.

#### NOTE

The SNx5DP159 uses clock stretching for DDC transactions. As there are sources and sinks that do not perform this function correctly a system may not work correctly as DDC transactions are incorrectly transmitted/received. To overcome this a snoop configuration can be implemented where the SDA/SCL from the source is connected directly to the SDA/SCL sink. The SNx5DP159 will need its SDA\_SNK and SCL\_SNK pins connected to this link in order for the SNx5DP159 to configure the TMDS\_CLOCK\_RATIO\_STATUS bit. Care must be taken when this configuration is being implemented as the voltage levels for DDC between the source and sink may be different, 3.3 V vs 5 V.

## 9.5 Register Maps

### 9.5.1 DP-HDMI Adaptor ID Buffer

The SNx5DP159 device includes the DP-HDMI adapter ID buffer for HDMI/DVI adaptor recognition, defined by the VESA DisplayPort Dual-Mode Standard Version 1.1, accessible by standard I<sup>2</sup>C[4] protocols through the DDC interface when the `HDMI_SEL/A1` pin is low. The DP-HDMI adapter buffer and extended DDC register for Type 2 capability is accessed at target addresses 80h (Write) and 81h (Read).

The DP-HDMI adapter buffer contains a read-only phrase DP-HDMI ADAPTOR<EOT> converted to ASCII characters, as shown in Table 3, and supports the WRITE command procedures (accessed at target address 80h) to select the subaddress, as recommended in the VESA DisplayPort Interoperability Guideline Adaptor Checklist Version 1.0 section 2.3.

**Table 3. SNx5DP159 DP-HDMI Adaptor ID Buffer and Extended DDC**

| Address | Description                                                   | Value HDMI | Value DVI | Read or Read/Write |
|---------|---------------------------------------------------------------|------------|-----------|--------------------|
| 00h     | HDMI ID code                                                  | 44h        | 00h       | Read only          |
| 01h     |                                                               | 50h        | 00h       |                    |
| 02h     |                                                               | 2Dh        | 00h       |                    |
| 03h     |                                                               | 48h        | 00h       |                    |
| 04h     |                                                               | 44h        | 00h       |                    |
| 05h     |                                                               | 4Dh        | 00h       |                    |
| 06h     |                                                               | 49h        | 00h       |                    |
| 07h     |                                                               | 20h        | 00h       |                    |
| 08h     |                                                               | 41h        | 00h       |                    |
| 09h     |                                                               | 44h        | 00h       |                    |
| 0Ah     |                                                               | 41h        | 00h       |                    |
| 0Bh     |                                                               | 50h        | 00h       |                    |
| 0Ch     |                                                               | 54h        | 00h       |                    |
| 0Dh     |                                                               | 4Fh        | 00h       |                    |
| 0Eh     |                                                               | 52h        | 00h       |                    |
| 0Fh     |                                                               | 04h        | 00h       |                    |
| 10h     | Video Adaptor Identifier<br>Bit 2:0 ADAPTOR_REVISION          | 0          | 0         | Read only          |
|         | Bit 3 Reserved: but 0 for type 2                              | 0          | 0         |                    |
|         | Bits 7:4 1010 = Dual mode defined by dual mode[1]<br>standard | 1010       | 0         |                    |
| 11h     | IEE_OUI first two hex digits                                  | 08h        | 08h       | Read only          |
| 12h     | IEE_OUI second two hex digits                                 | 00h        | 00h       | Read only          |
| 13h     | IEE_OUI third two hex digits                                  | 28h        | 28h       | Read only          |
| 14h     | Device ID                                                     | 44h        | 44h       | Read only          |
| 15h     |                                                               | 50h        | 50h       |                    |
| 16h     |                                                               | 31h        | 31h       |                    |
| 17h     |                                                               | 35h        | 35h       |                    |
| 18h     |                                                               | 39h        | 39h       |                    |
| 19h     |                                                               | 00h        | 00h       |                    |
| 1Ah     | Hardware revision                                             | 02h        | 02h       | Read only          |
|         | Bits 7:4 major revision                                       | 00h        | 00h       |                    |
|         | Bits 3:0 minor revision                                       | 02h        | 02h       |                    |
| 1Bh     | Firmware or software major revision                           | 00h        | 00h       | Read only          |
| 1Ch     | Firmware or software minor revision                           | 00h        | 00h       | Read only          |

## Register Maps (continued)

**Table 3. SNx5DP159 DP-HDMI Adaptor ID Buffer and Extended DDC (continued)**

| Address | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              | Value HDMI | Value DVI | Read or Read/Write |
|---------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------|-----------|--------------------|
| 1Dh     | Max TMDS clock rate<br>Default value is F0h in HDMI column<br>Note: Value determined by taking clock rate and dividing by 2.5 and converting to HEX. For HDMI2.0 extend as if the clock rate extended instead of its actual method, clock 1/10 DR and not 1/40 DR.                                                                                                                                                                                                                                                                                                                                                                                                                                       | F0h        | 42h       | Read only          |
| 1Eh     | If I2C_DR_CTL = 0 the value is 0Fh → If DDC_AUX_DR_SEL = 0 the value is 0Fh<br>If I2C_DR_CTL = 1 the value is 1Fh → If DDC_AUX_DR_SEL = 1 then value is 1Fh<br>If I2C_DR_CTL = 0 the value is 0Fh<br>If I2C_DR_CTL = 1 the value is 1Fh                                                                                                                                                                                                                                                                                                                                                                                                                                                                  | 0Fh        | 0Fh       | Read only          |
| 1Fh     | Reserved                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 | 00h        | 00h       | Write/Read         |
| 20h     | TMDS_OE<br>Bit 0: 0 = TMDS_ENABLED (default)<br>1 = TMDS_DISABLED<br>Bits 7:1 Reserved                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   | 00h        | 00h       | Write/Read         |
| 21h     | HDMI Pin Control<br>Bit 0 = CEC_EN<br>Enables connection between the HDMI CEC pin connected to the sink and the CONFIG2 pin to the upstream device + 27-kΩ pullup.<br>0 = CEC_DISABLED (default)<br>1 = CEC_ENABLED<br>Bits 7:1 = RESERVED                                                                                                                                                                                                                                                                                                                                                                                                                                                               | 00h        | 00h       | Write/Read         |
| 22h     | Writing a bit pattern to this register that is not defined above may result in an unpredictable I <sup>2</sup> C speed selection, but the adaptor must continue to otherwise work normally. Only applicable when using I <sup>2</sup> C-over-AUX transport<br>01h = 1-Kbps<br>02h = 5-Kbps<br>04h = 10-Kbps<br>08h = 100-kbps<br>10h = 400-Kbps (RSVD in Dual Mode STND)<br>On read, the dual-mode cable adaptor returns a value to indicate the speed currently in use. The default I2C speed prior to software writing to this register is 100-Kbps.<br>Illegal write value shall write register default (08h). This register sets the DDC output DR whether I <sup>2</sup> C-over-AUX or straight DDC | 08h        | 08h       | Write/Read         |
| 23h-FFh | Reserved                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 | 00h        | 00h       | Read               |

### 9.5.2 Local I<sup>2</sup>C Interface Overview

The SCL\_CTL and SDA\_CTL pins are used for I<sup>2</sup>C clock and I<sup>2</sup>C data respectively. The SNx5DP159 I<sup>2</sup>C interface conforms to the 2-wire serial interface defined by the I<sup>2</sup>C Bus Specification, Version 2.1 (January 2000), and supports the fast mode transfer up to 400 kbps.

The device address byte is the first byte received following the start condition from the master device. The 7-bit device address for the SNx5DP159 device decides by the combination of EQ\_SEL/A0 and HDMI\_SEL/A1. [Table 4](#) clarifies the SNx5DP159 device target address.

**Table 4. I<sup>2</sup>C Device Address Description**

| A1/A0 | SNx5DP159 I <sup>2</sup> C Device Address |   |   |   |   |   |   |         | ADD   |
|-------|-------------------------------------------|---|---|---|---|---|---|---------|-------|
|       | 7 (MSB)                                   | 6 | 5 | 4 | 3 | 2 | 1 | 0 (W/R) |       |
| 00    | 1                                         | 0 | 1 | 1 | 1 | 1 | 0 | 0/1     | BC/BD |
| 01    | 1                                         | 0 | 1 | 1 | 1 | 0 | 1 | 0/1     | BA/BB |
| 10    | 1                                         | 0 | 1 | 1 | 1 | 0 | 0 | 0/1     | B8/B9 |
| 11    | 1                                         | 0 | 1 | 1 | 0 | 1 | 1 | 0/1     | B6/B7 |

### 9.5.3 I<sup>2</sup>C Control Behavior

Follow this procedure to write to the SNx5DP159 device I<sup>2</sup>C registers:

1. The master initiates a write operation by generating a start condition (S), followed by the SNx5DP159 device 7-bit address and a zero-value W/R bit to indicate a write cycle.
2. The SNx5DP159 device acknowledges the address cycle by combination of A0 and A1.
3. The master presents the subaddress (I<sup>2</sup>C register within SNx5DP159 device) to be written, consisting of one byte of data, MSB-first.
4. The SNx5DP159 device acknowledges the subaddress cycle.
5. The master presents the first byte of data to be written to the I<sup>2</sup>C register.
6. The SNx5DP159 device acknowledges the byte transfer.
7. The master may continue presenting additional bytes of data to be written, with each byte transfer completing with an acknowledge from the SNx5DP159 .
8. The master terminates the write operation by generating a stop condition (P).

Follow this procedure to read the SNx5DP159 I<sup>2</sup>C registers:

1. The master initiates a write operation by generating a start condition (S), followed by the SNx5DP159 7-bit address and a zero-value W/R bit to indicate a write cycle.
2. The SNx5DP159 device acknowledges the address cycle by combination of A0 and A1.
3. The master presents the subaddress (I<sup>2</sup>C register within SNx5DP159 device) to be read, consisting of one byte of data, MSB-first.
4. The SNx5DP159 device acknowledges the subaddress cycle.
5. The master initiates a read operation by generating a start condition (S), followed by the SNx5DP159 7-bit address and a one-value W/R bit to indicate a read cycle.
6. The SNx5DP159 device acknowledges the address cycle.
7. The SNx5DP159 device transmits the contents of the memory registers MSB-first starting at the written subaddress.
8. The SNx5DP159 device will wait for either an acknowledge (ACK) or a not-acknowledge (NACK) from the master after each byte transfer; the I<sup>2</sup>C master acknowledges reception of each data byte transfer.
9. If an ACK is received, the SNx5DP159 device transmits the next byte of data.
10. The master terminates the read operation by generating a stop condition (P).

#### NOTE

Upon reset, the SNx5DP159 sub-address will always be set to 0x00. When no subaddress is included in a read operation, the SNx5DP159 subaddress increments from previous acknowledged read or write data byte. If it is required to read from a subaddress that is different from the SNx5DP159 internal subaddress, a write operation with only a subaddress specified is needed before performing the read operation.

Refer to [Table 6](#) for the SNx5DP159 device local I<sup>2</sup>C register descriptions. Reads from reserved fields return 0s and writes are ignored.

## 9.5.4 I<sup>2</sup>C Control and Status Registers

Reads from reserved fields return 0, and writes to read-only reserved registers are ignored. Writes to reserved registers, which are marked with 'W', produce unexpected behavior. All addresses not defined by this specification are considered reserved. Reads from these addresses return 0 and writes will be ignored.

### 9.5.4.1 Bit Access Tag Conventions

A table of bit descriptions is typically included for each register description that indicates the bit field name, field description, and the field access tags. The field access tags are described in [Table 5](#).

**Table 5. Field Access Tags**

| ACCESS TAG | NAME      | DESCRIPTION                                                                   |
|------------|-----------|-------------------------------------------------------------------------------|
| R          | Read      | The field is read by software                                                 |
| W          | Write     | The field is written by software                                              |
| S          | Set       | The field is set by a write of one. Writes of 0 to the field have no effect   |
| C          | Clear     | The field is cleared by a write of 1. Writes of 0 to the field have no effect |
| U          | Update    | Hardware may autonomously update this field                                   |
| NA         | No access | Not accessible or not applicable                                              |

### 9.5.4.2 CSR Bit Field Definitions

#### 9.5.4.2.1 ID Registers

**Table 6. ID Registers**

| ADDRESS | BIT | DESCRIPTION                                                                                                                                                                                        | ACCESS |
|---------|-----|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------|
| 00h:07h | 7:0 | DEVICE_ID<br>These fields return a string of ASCII characters "DP159" followed by three space characters.<br>Address 0x00 – 0x07 = {0x44"D", 0x50"P", 0x31"1", 0x35"5", 0x39"9", 0x20, 0x20, 0x20} | R      |
| 08h     | 7:0 | REV_ID. This field identifies the device revision.<br>0000001 – DP159 revision 1                                                                                                                   | R      |

### 9.5.4.2.2 Misc Control

**Table 7. Misc Control**

| ADDRESS | BIT | DEFAULT | DESCRIPTION                                                                                                                                                                                                                                                                                                                                                                                                    | ACCESS |
|---------|-----|---------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------|
| 09h     | 7   | 1'b0    | SWAP_EN: This field enables swapping the input main link lanes<br><b>0 – Disable (default)</b><br>1 – Enable<br>Note: field is loaded from SWAP/POL pin; Writes ignored when I2C_EN/PIN = 0                                                                                                                                                                                                                    | RWU    |
|         | 6   | 1'b0    | LANE_POLARITY: swaps the input data and clock lanes polarity.<br><b>0 – Disabled: No polarity swap</b><br>1 – Swaps the input data and clock lane polarity<br>Note: field is loaded from SWAP/POL pin; Writes ignored when I2C_EN/PIN = 0. This feature is only valid when in retimer mode.                                                                                                                    | RWU    |
|         | 5:4 | 2'b00   | Reserved                                                                                                                                                                                                                                                                                                                                                                                                       | R      |
|         | 3   | 1'b0    | PD_EN<br><b>0 – Normal working (default)</b><br>1 – Forced power-down by I <sup>2</sup> C, lowest power state                                                                                                                                                                                                                                                                                                  | RW     |
|         | 2   | 1'b0    | HPD_AUTO_PWRDWN_DISABLE<br><b>0 – Automatically enters power down mode based on HPD_SNK (default)</b><br>1 – Will not automatically enter power mode based upon HPD_SNK                                                                                                                                                                                                                                        | RW     |
|         | 1:0 | 2'b10   | I2C_DR_CTL. I2C data rate supported for configuring device<br>00 – 5-kbps<br>01 – 10-kbps<br><b>10 – 100-kbps (default)</b><br>11 – 400-kbps (Note: HPD_AUTO_PWRDWN_DISABLE must be set before enabling 400 Kbps mode)                                                                                                                                                                                         | RW     |
| 0Ah     | 7   | 1'b0    | Application Mode Selection<br><b>0 – Source (default) - Set the adaptive EQ mid point to between 6.5-dB and 7.5-dB</b><br>1 – Sink - Sets the adaptive EQ starting point to between 12-dB and 13-dB                                                                                                                                                                                                            | RW     |
|         | 6   | 1'b0    | HPDSNK_GATE_EN: This field sets the functional relationship between HPD_SNK and HPD_SRC.<br><b>0 – HPD_SNK passed through to the HPD_SRC (default)</b><br>1 – HPD_SNK will not pass through to the HPD_SRC.                                                                                                                                                                                                    | RW     |
|         | 5   | 1'b1    | EQ_ADA_EN: this field enables the equalizer working state.<br>0 – Fixed EQ<br><b>1 – Adaptive EQ (default)</b><br>Writes are ignored when I2C_EN/PIN = 0                                                                                                                                                                                                                                                       | RWU    |
|         | 4   | 1'b1    | EQ_EN: this field enables the receiver equalizer.<br>0 – EQ disabled<br><b>1 – EQ enable (default)</b>                                                                                                                                                                                                                                                                                                         | RW     |
|         | 3   | 1'b1    | AUX_BRG_EN: this field enable the AUX bridge working. <b>This is only valid for the 48-pin package.</b><br>0 – AUX bridge disable<br><b>1 – AUX bridge enable (default)</b>                                                                                                                                                                                                                                    | RWU    |
|         | 2   | 1'b0    | APPLY_RTX_CHANGES , Self clearing write-only bit. Writing a 1 to this bit will apply new slew, tx_term, twpst1, eqen, eqadapten, swing, eqftc, eqlev settings to the clock and data lanes. Writes to the respective registers do not take immediate effect. This bit does not need to be written if I <sup>2</sup> C configuration occurs while OE or hpd_sink are low, I <sup>2</sup> C power down is active. | W      |
|         | 1:0 | 2'b01   | DEV_FUNC_MODE: This field selects the device working function mode.<br>00 – Redriver mode across full range 250 Mbps to 6-Gbps<br><b>01 – Automatic redriver to retimer crossover at 1.0 Gbps (default)</b><br>10 - Automatic retimer for HDMI2.0<br>11 - Retimer mode across full range 250 Mbps to 6-Gbps<br>When changing crossover point, need to toggle PD_EN or toggle external HPD_SNK.                 | RW     |

**Mode Selection Definition:** This bit lets the receiver know where the device is located in a system for the purpose of centering the AEQ point. The SNx5DP159 is targeting the source application, so the default value is 0, which will center the EQ at 6.5 to 7.5-dB depending upon TMDS\_CLOCK\_RATIO\_STATUS value, see [Table 9](#). If the SNx5DP159 is in a dock or sink application, the value should be changed to a value of 1, which will center the EQ at 12 to 13-dB depending upon TMDS\_CLOCK\_RATIO\_STATUS value.

**9.5.4.2.3 HDMI Control**
**Table 8. HDMI Control**

| ADDRESS | BIT | DEFAULT | DESCRIPTION                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    | ACCESS |
|---------|-----|---------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------|
| 0Bh     | 7:6 | 2'b00   | SLEW_CTL: Slew rate control. 2'00 is fastest and 2'b11 is slowest<br>Writes ignored when I2C_EN/PIN = 0                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        | RWU    |
|         | 5   | 1'b0    | HDMI_SEL: Contro; Writes ignored when I2C_EN/PIN = 0<br><b>0 – HDMI (default)</b><br>1 – DVI                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   | RWU    |
|         | 4:3 | 2'b00   | TX_TERM_CTL: Controls termination for HDMI TX<br><b>00 – No termination</b><br>01 – 150 to 300-Ω<br>10 – Reserved<br>11 – 75 to 150-Ω<br>Note: Reflects the value of the TX_TERM_CTL pin; Writes ignored when I2C_EN/PIN = 0                                                                                                                                                                                                                                                                                                                                                                   | RWU    |
|         | 2   | 1'b0    | Reserved                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       | R      |
|         | 1   | 1'b0    | TMDS_CLOCK_RATIO_STATUS: This field is updated from snoop of I <sup>2</sup> C write to slave address 0xA8 offset 0x20 bit 1 that occurred on the SDA_SRC/SCL_SRC interface. When bit 1 of address 0xA8 offset 0x20 is written to a 1'b1, then this field will be set to a 1'b1. When bit 1 of address 0xA8 offset 0x20 is written to a 1'b0, then this field will be set to a 1'b0. This field is reset to the default value whenever HPD_SNK is de-asserted for greater than 2 ms.<br><b>0 – TMDS clock is 1/10 of TMDS bit period (default)</b><br>1 – TMDS clock is 1/40 of TMDS bit period | RWU    |
|         | 0   | 1'b0    | DDC_TRAIN_SET: This field indicates the DDC training block function status. If disabled, the device can only work at the HDMI1.4b[2] or DVI mode<br><b>0 – DDC training enable (default)</b><br>1 – DDC training disable<br>Note: To force TMDS_CLOCK_RATIO_STATUS to 1, this register bit must be set to 1 which will force the 1/40 mode for HDMI2.0.                                                                                                                                                                                                                                        | RW     |
| 0Ch     | 7:5 | 3'b000  | VSWING_DATA: Data output swing control<br><b>000 – Vsadj set</b><br>001 – Increase by 7%<br>010 – Increase by 14%<br>011 – Increase by 21%<br>100 – Decrease by 30%<br>101 – Decrease by 21%<br>110 – Decrease by 14%<br>111 – Decrease by 7%                                                                                                                                                                                                                                                                                                                                                  | RW     |
|         | 4:2 | 3'b000  | VSWING_CLK: Clock Output Swing Control<br><b>000 – Vsadj set</b><br>001 – Increase by 7%<br>010 – Increase by 14%<br>011 – Increase by 21%<br>100 – Decrease by 30%<br>101 – Decrease by 21%<br>110 – Decrease by 14%<br>111 – Decrease by 7%<br>Note: Default is set by DR, which means standard based swing values but this allows for the swing to be overridden by selecting one of these values                                                                                                                                                                                           | RW     |
|         | 1:0 | 2'b00   | HDMI_TWPST1: HDMI de-emphasis FIR post-cursor-1 signed tap weight.<br><b>00 – No de-emphasis</b><br>01 – 2-dB de-emphasis<br>10 – Reserved<br>11 – Reserved                                                                                                                                                                                                                                                                                                                                                                                                                                    | RWU    |

#### 9.5.4.2.4 Equalization Control Register

**Table 9. Equalization Control Register**

| ADDRESS | BIT | DEFAULT | DESCRIPTION                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    | ACCESS |
|---------|-----|---------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------|
| 0Dh     | 7:6 | 2'b00   | Reserved                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       | RW     |
|         | 5:3 | 1'b000  | <b>Data Lane EQ – Sets fixed EQ values</b><br><div> <div>HDMI1.4b[2]</div> <div>HDMI2.0[3]</div> <div>000 – 0-dB</div> <div>000 – 0-dB</div> <div>001 – 4.5-dB</div> <div>001 – 3-dB</div> <div>010 – 6.5-dB</div> <div>010 – 5-dB</div> <div>011 – 8.5-dB</div> <div>011 – 7.5-dB</div> <div>100 – 10.5-dB</div> <div>100 – 9.5-dB</div> <div>101 – 12-dB</div> <div>101 – 11-dB</div> <div>110 – 14-dB</div> <div>110 – 13-dB</div> <div>111 – 16.5-dB</div> <div>111 – 14.5-dB</div> </div> | RW     |
|         | 2:1 | 1'b00   | <b>Clock Lane EQ – Sets fixed EQ values</b><br><div> <div>HDMI1.4b[2]</div> <div>HDMI2.0[3]</div> <div>00 – 0-dB</div> <div>00 – 0-dB</div> <div>01 – 1.5-dB</div> <div>01 – 1.5-dB</div> <div>10 – 3-dB</div> <div>10 – 3-dB</div> <div>11 – RSVD</div> <div>11 – 4.5-dB</div> </div>                                                                                                                                                                                                         | RW     |
|         | 0   | 1'b0    | <b>0 – Clock VOD is half the set value when TMDS_CLOCK_RATIO_STATUS states in HDMI2.0 mode</b><br>1 – Disables TMDS_CLOCK_RATIO_STATUS control of the clock VOD so the output swing is full swing                                                                                                                                                                                                                                                                                              | RW     |

#### 9.5.4.2.5 EyeScan Control Register

**Table 10. EyeScan Control Register**

| ADDRESS | BITS | DEFAULT | DESCRIPTION                                                                                                                                                                                                                                                                          | ACCESS |
|---------|------|---------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------|
| 0Eh     | 7:4  | 4'b0000 | PV_SYNC[3:0]. Pattern timing pulse. This field is updated for 8UI once every cycle of the PRBS generator. 1 bit per lane.                                                                                                                                                            | R      |
|         | 3:0  | 4'b0000 | PV_LD[3:0]. Load pattern-verifier controls into RX lanes. When asserted high, the PV_TO, PV_SEL, PV_LEN, PV_CP20, and PV_CP values are enabled into the corresponding RX lane. These values are then latched and held when PV_LD[n] is subsequently de-asserted low. 1 bit per lane. | RWU    |
| 0Fh     | 7:4  | 4'b0000 | PV_FAIL[3:0]. Pattern verification mismatch detected. 1 bit per lane.                                                                                                                                                                                                                | RU     |
|         | 3:0  | 4'b0000 | PV_TIP[3:0]. Pattern search/training in progress. 1 bit per lane.                                                                                                                                                                                                                    | RU     |
| 10h     | 7    | 1'b0    | PV_CP20. Customer pattern length 20 or 16 bits.<br><b>0 – 16 bits</b><br>1 – 20 bits                                                                                                                                                                                                 | RW     |
|         | 6    | 1'b0    | Reserved                                                                                                                                                                                                                                                                             | R      |
|         | 5:3  | 3'b000  | PV_LEN[2:0]. PRBS pattern length<br><b>000 – PRBS7</b><br>001 – PRBS11<br>010 – PRBS23<br>011 – PRBS31<br>100 – PRBS15<br>101 – PRBS15<br>110 – PRBS20<br>111 – PRBS20                                                                                                               | RW     |
|         | 2:0  | 3'b000  | PV_SEL[24:0]. Pattern select control<br><b>000 – Disabled</b><br>001 – PRBS<br>010 – Clock<br>011 – Custom<br>1xx – Timing only mode with sync pulse spacing defined by PV_LEN                                                                                                       | RW     |
| 11h     | 7:0  | 'h00    | PV_CP[7:0]. Custom pattern data.                                                                                                                                                                                                                                                     | RW     |
| 12h     | 7:0  | 'h00    | PV_CP[15:8]. Custom pattern data.                                                                                                                                                                                                                                                    | RW     |

**Table 10. EyeScan Control Register (continued)**

| ADDRESS | BITS | DEFAULT  | DESCRIPTION                                                                                                                                                                                                                                                                                                                    | ACCESS |
|---------|------|----------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------|
| 13h     | 7:4  | 4'b0000  | Reserved                                                                                                                                                                                                                                                                                                                       | R      |
|         | 3:0  | 4'b0000  | PV_CP[19:16]. Custom pattern data. Used when PV_CP20 = 1'b1.                                                                                                                                                                                                                                                                   | RW     |
| 14h     | 7:3  | 5'b00000 | Reserved                                                                                                                                                                                                                                                                                                                       | R      |
|         | 2:0  | 3'b000   | PV_THR[2:0]. Pattern-verifier retain threshold.                                                                                                                                                                                                                                                                                | RW     |
| 15h     | 7    | 1'b0     | DESKEW_CMPLT: Indicates TMDS lane deskew has completed when high                                                                                                                                                                                                                                                               | R      |
|         | 6:5  | 2'b00    | Reserved                                                                                                                                                                                                                                                                                                                       | R      |
|         | 4    | 1'b0     | BERT_CLR. Clear BERT counter (on rising edge).                                                                                                                                                                                                                                                                                 | RSU    |
|         | 3    | 1'b0     | TST_INTQ_CLR. Clear latched interrupt flag.                                                                                                                                                                                                                                                                                    | RSU    |
|         | 2:0  | 3'b000   | TST_SEL[2:0]. Test interrupt source select.                                                                                                                                                                                                                                                                                    | RW     |
| 16h     | 7:4  | 4'b0000  | PV_DP_EN[3:0]. Enabled datapath verified based on DP_TST_SEL, 1 bit per lane.                                                                                                                                                                                                                                                  | RW     |
|         | 3    | 1'b0     | Reserved                                                                                                                                                                                                                                                                                                                       | R      |
|         | 2:0  | 3'b000   | DP_TST_SEL[2:0] Selects pattern reported by BERT_CNT[11:0], TST_INT[0] and TST_INTQ[0]. PV_DP_EN is non-zero<br><b>000 – TMDS disparity or data errors</b><br>001 – FIFO errors<br>010 – FIFO overflow errors<br>011 – FIFO underflow errors<br>100 – TMDS deskew status<br>101 – Reserved<br>110 – Reserved<br>111 – Reserved | RW     |
| 17h     | 7:4  | 4'b0000  | TST_INTQ[3:0]. Latched interrupt flag. 1 bit per lane                                                                                                                                                                                                                                                                          | RU     |
|         | 3:0  | 4'b0000  | TST_INT[3:0]. Test interrupt flag. 1 bit per lane.                                                                                                                                                                                                                                                                             | RU     |
| 18h     | 7:0  | 'h00     | BERT_CNT[7:0]. BERT error count. Lane 0                                                                                                                                                                                                                                                                                        | RU     |
| 19h     | 7:4  | 4'b0000  | Reserved                                                                                                                                                                                                                                                                                                                       | R      |
|         | 3:0  | 4'b0000  | BERT_CNT[11:8]. BERT error count. Lane 0                                                                                                                                                                                                                                                                                       | RU     |
| 1Ah     | 7:0  | 'h00     | BERT_CNT[19:12]. BERT error count. Lane 1                                                                                                                                                                                                                                                                                      | RU     |
| 1Bh     | 7:4  | 4'b0000  | Reserved                                                                                                                                                                                                                                                                                                                       | R      |
|         | 3:0  | 4'b0000  | BERT_CNT[23:20]. BERT error count. Lane 1                                                                                                                                                                                                                                                                                      | RU     |
| 1Ch     | 7:0  | 'h00     | BERT_CNT[31:24]. BERT error count. Lane 2                                                                                                                                                                                                                                                                                      | RU     |
| 1Dh     | 7:4  | 4'b0000  | Reserved                                                                                                                                                                                                                                                                                                                       | R      |
|         | 3:0  | 4'b0000  | BERT_CNT[35:32]. BERT error count. Lane 2                                                                                                                                                                                                                                                                                      | RU     |
| 1Eh     | 7:0  | 'h00     | BERT_CNT[19:12]. BERT error count. Lane 3                                                                                                                                                                                                                                                                                      | RU     |
| 1Fh     | 7:4  | 4'b0000  | Reserved                                                                                                                                                                                                                                                                                                                       | R      |
|         | 3:0  | 'h00     | BERT_CNT[23:20]. BERT error count. Lane 3                                                                                                                                                                                                                                                                                      | RU     |
| 20h     | 7:4  | 4'b0000  | Reserved                                                                                                                                                                                                                                                                                                                       | R      |
|         | 3    | 1'b1     | AUX_TX_SR Slew Rate Control for AUX Output                                                                                                                                                                                                                                                                                     | RW     |
|         | 2:0  | 3'b010   | AUX_SWING; Swing Control for AUX Output<br>000 – 270 mV<br>001 – 355 mV<br><b>010 – 450 mV</b><br>011 – 535 mV<br>100 – 625 mV<br>101 – 710 mV<br>110 – 800 mV<br>111 – Not allowed                                                                                                                                            | RW     |

## 10 Application and Implementation

### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

DP159 is designed to accept AC coupled HDMI input signals. The device provides signal conditioning and level shifting functions to drive a compliant HDMI source connector. DP159 can be used as an DP1.2 retimer, follow application note [SLLA358](#) for required additional configuration. In many major PC or gaming platforms APU/GPU can provide AC coupled HDMI 2.0 signals, DP159 is suitable for such platforms.

### 10.1 Application Information

The DP159 was defined to work in mainly in source applications such as gaming systems, Blu-Ray DVD player, desktop, notebook or VR. The following sections provide design consideration for various types of applications.

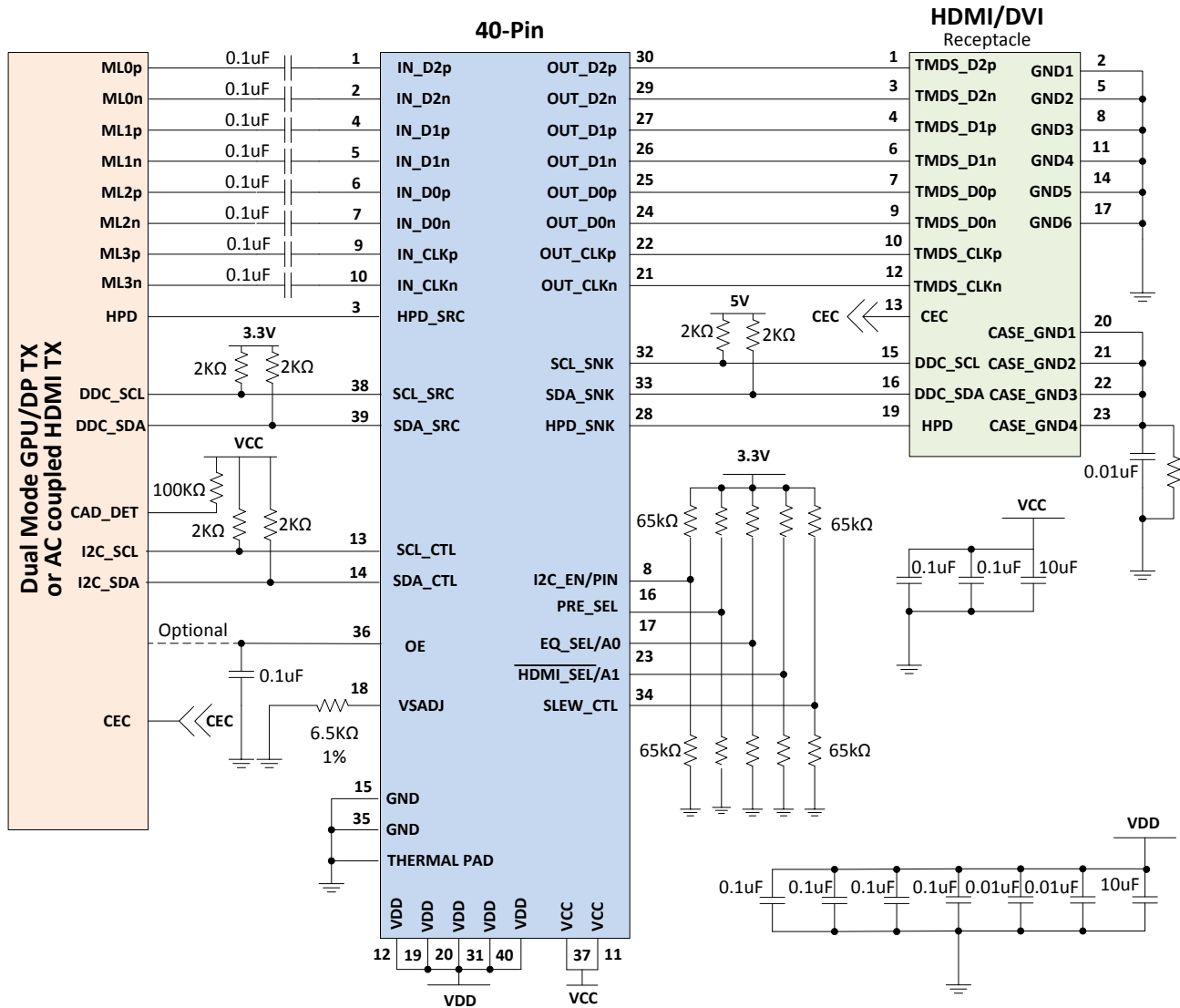
#### 10.1.1 Use Case of SNx5DP159

SNx5DP159 can be used on the motherboard and dongle applications. The following use case diagrams show the connection of AUX and DDC between source side and sink side. The control pin pull up and pull down resistors are shown from reference. If a high is needed only use the pull up. If a low is needed only use the pull down. If mid level is to be selected do not use either resistors and leave the pin floating/No connect. The 6.5-K $\Omega$  Vsadj resistor value shown is explained further in the compliance section, for the RSB package.

The DP159 was defined to work in mainly in source applications such as gaming systems, Blu-Ray DVD player, Desktop, Notebook or VR. The following sections provide design consideration for various types of applications.

[Figure 30](#) shows the original connection of SNx5DP159 on motherboard through the DDC channel. The DDC DR default is 100-kHz and is capable to adjust to 400-kHz.

## Application Information (continued)

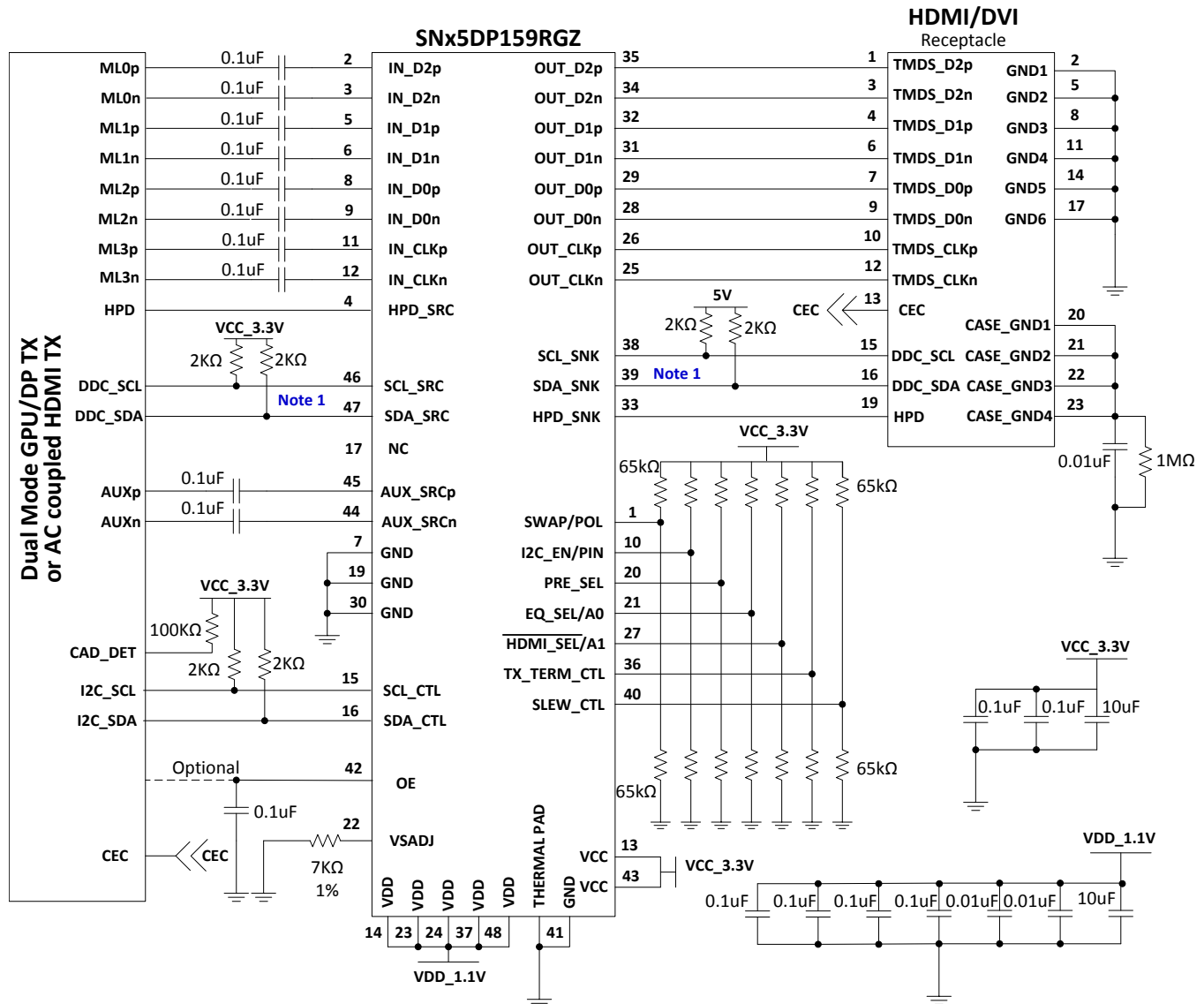


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Figure 30. Implementation for Motherboard 1

## Application Information (continued)

Figure 31 shows the connection for both DDC and AUX GPU connections with the SNx5DP159RGZ. Only one can be implemented at a time. Only the RGZ package supports the I<sup>2</sup>C-over-AUX implementation. The control pin pull up and pull down resistors are shown for reference. If a high is needed only use the pull up. If a low is needed only use the pull down. If mid level is to be selected do not use either resistors and leave the pin floating/No connect.



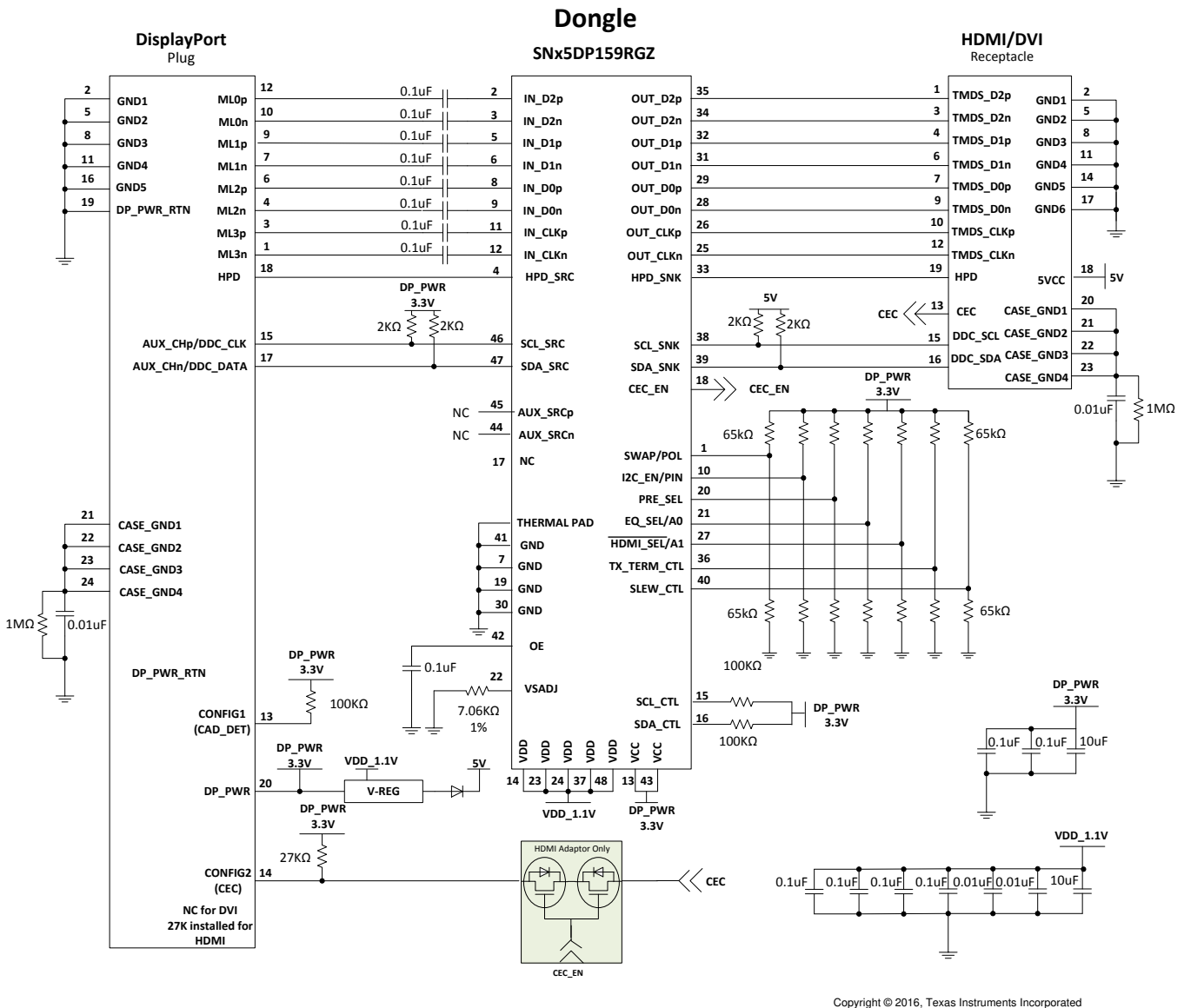
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Note 1: For applications where the GPU or Sink does not support clock stretching the DDC lines from the GPU/DP TX should bypass the SCL\_SRC and SDA\_SRC but still connect to the SCL\_SNK and SDA\_SNK pins on the DP159. The SCL\_SRC and SDA\_SRC pins must be pulled to ground. Note that if the GPU/DP TX cannot support the 5V DDC lines from the connector, a level shifter is needed to step down the 5V signals to the voltage level the GPU/DP TX can support.

Figure 31. Implementation for Motherboard 2

## Application Information (continued)

Figure 32 shows the SNx5DP159 in the dongle application. It uses the unified structure on DisplayPort connector. SNx5DP159 has to identify if the signal comes from DDC or from AUX in I<sup>2</sup>C-over-AUX format. Due to the AUX channel needed, use only the RGZ package for this application.



**Figure 32. SNx5DP159 in Dongle Application**

### 10.1.2 DDC Pullup Resistors

#### NOTE

This section is for information only and subject to change depending upon system implementation.

## Application Information (continued)

The pullup resistor value is determined by two requirements:

- A. The maximum sink current of the I<sup>2</sup>C buffer:

The maximum sink current is 3-mA or slightly higher for an I<sup>2</sup>C driver supporting standard-mode I<sup>2</sup>C[4] operation.

$$R_{up(min)} = \frac{V_{CC}}{I_{sink}} \quad (1)$$

- B. The maximum transition time on the bus:

The maximum transition time, T, of an I<sup>2</sup>C bus is set by an RC time constant, where R is the pullup resistor value, and C is the total load capacitance. The parameter, k, can be calculated from Equation 3 by solving for t, the times at which certain voltage thresholds are reached. Different input threshold combinations introduce different values of t. Table 11 summarizes the possible values of k under different threshold combinations.

$$T = k \times RC \quad (2)$$

$$V(t) = V_{CC} \times \left( 1 - e^{\frac{-t}{RC}} \right) \quad (3)$$

**Table 11. Value k Upon Different Input Threshold Voltages**

| V <sub>th</sub> -IV <sub>th+</sub> | 0.7 V <sub>CC</sub> | 0.65 V <sub>CC</sub> | 0.6 V <sub>CC</sub> | 0.55 V <sub>CC</sub> | 0.5 V <sub>CC</sub> | 0.45 V <sub>CC</sub> | 0.4 V <sub>CC</sub> | 0.35 V <sub>CC</sub> | 0.3 V <sub>CC</sub> |
|------------------------------------|---------------------|----------------------|---------------------|----------------------|---------------------|----------------------|---------------------|----------------------|---------------------|
| 0.1 V <sub>CC</sub>                | 1.0986              | 0.9445               | 0.8109              | 0.6931               | 0.5878              | 0.4925               | 0.4055              | 0.3254               | 0.2513              |
| 0.15 V <sub>CC</sub>               | 1.0415              | 0.8873               | 0.7538              | 0.6360               | 0.5306              | 0.4353               | 0.3483              | 0.2683               | 0.1942              |
| 0.2 V <sub>CC</sub>                | 0.9808              | 0.8267               | 0.6931              | 0.5754               | 0.4700              | 0.3747               | 0.2877              | 0.2076               | 0.1335              |
| 0.25 V <sub>CC</sub>               | 0.9163              | 0.7621               | 0.6286              | 0.5108               | 0.4055              | 0.3102               | 0.2231              | 0.1431               | 0.0690              |
| 0.3 V <sub>CC</sub>                | 0.8473              | 0.6931               | 0.5596              | 0.4418               | 0.3365              | 0.2412               | 0.1542              | 0.0741               |                     |

From Equation 1,  $R_{up(min)} = 5.5\text{-V} / 3\text{-mA} = 1.83\text{-k}\Omega$  to operate the bus under a 5-V pullup voltage and provide less than 3-mA when the I<sup>2</sup>C device is driving the bus to a low state. If a higher sink current, for example 4 mA, is allowed,  $R_{up(min)}$  can be as low as 1.375-k $\Omega$ .

If DDC is working at a standard mode of 100-Kbps, the maximum transition time, T, is fixed, 1  $\mu$ s, and using the k values from Table 11, the recommended maximum total resistance of the pullup resistors on an I<sup>2</sup>C bus can be calculated for different system setups. If DDC is working in a fast mode of 400-kbps, the transition time should be set at 300 ns, according to I<sup>2</sup>C[4] specification.

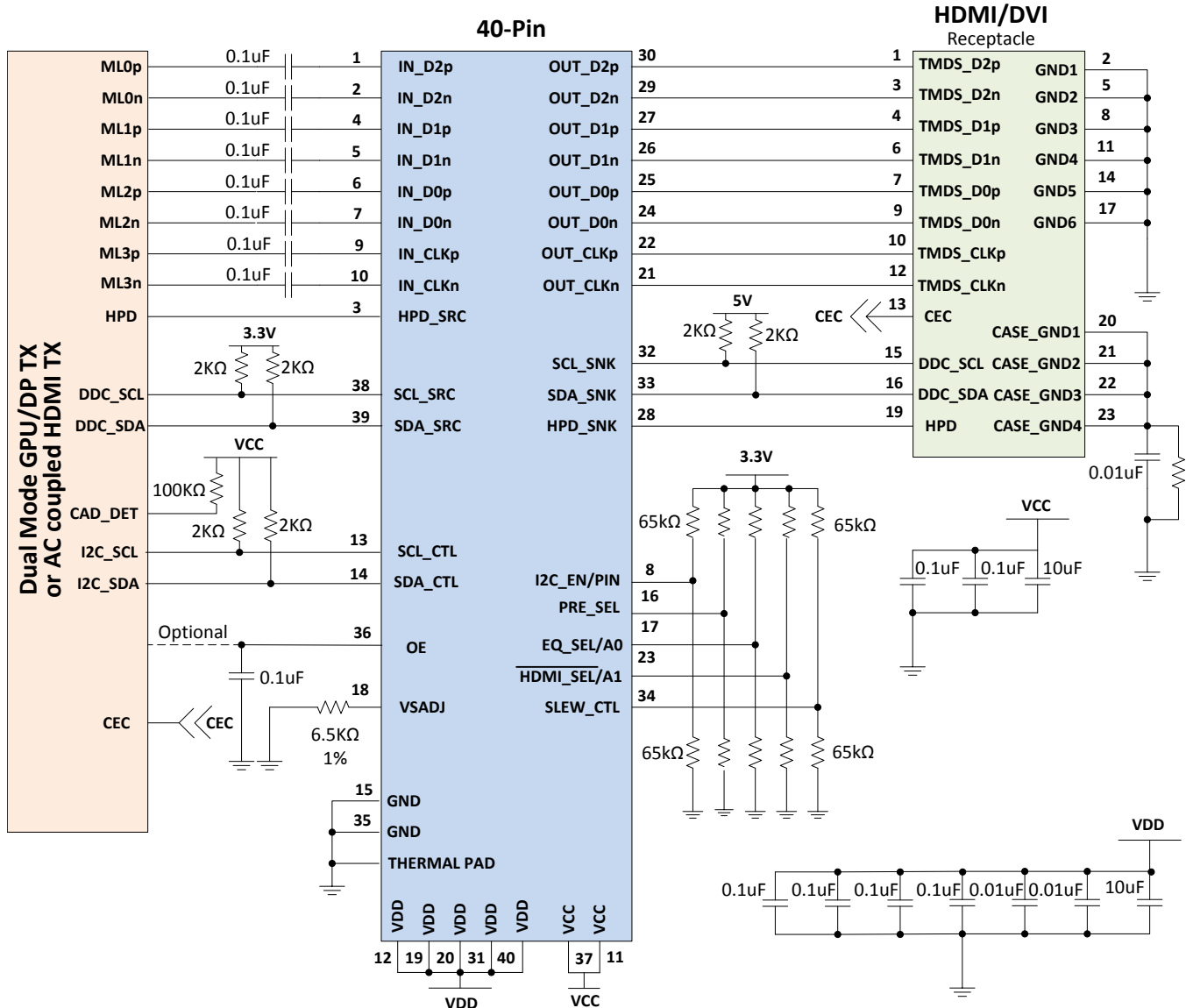
To support the maximum load capacitance specified in the HDMI specification,  $C_{cable(max)} = 700\text{-pF}$ ,  $C_{source} = 50\text{-pF}$ ,  $C_i = 50\text{-pF}$ , and  $R_{(max)}$  can be calculated as shown in Table 12.

**Table 12. Pullup Resistor Upon Different Threshold Voltages and 800-pF Loads**

| V <sub>th</sub> -IV <sub>th+</sub> | 0.7 V <sub>CC</sub> | 0.65 V <sub>CC</sub> | 0.6 V <sub>CC</sub> | 0.55 V <sub>CC</sub> | 0.5 V <sub>CC</sub> | 0.45 V <sub>CC</sub> | 0.4 V <sub>CC</sub> | 0.35 V <sub>CC</sub> | 0.3 V <sub>CC</sub> | UNIT       |
|------------------------------------|---------------------|----------------------|---------------------|----------------------|---------------------|----------------------|---------------------|----------------------|---------------------|------------|
| 0.1 V <sub>CC</sub>                | 1.14                | 1.32                 | 1.54                | 1.8                  | 2.13                | 2.54                 | 3.08                | 3.84                 | 4.97                | k $\Omega$ |
| 0.15 V <sub>CC</sub>               | 1.2                 | 1.41                 | 1.66                | 1.97                 | 2.36                | 2.87                 | 3.59                | 4.66                 | 6.44                | k $\Omega$ |
| 0.2 V <sub>CC</sub>                | 1.27                | 1.51                 | 1.8                 | 2.17                 | 2.66                | 3.34                 | 4.35                | 6.02                 | 9.36                | k $\Omega$ |
| 0.25 V <sub>CC</sub>               | 1.36                | 1.64                 | 1.99                | 2.45                 | 3.08                | 4.03                 | 5.6                 | 8.74                 | 18.12               | k $\Omega$ |
| 0.3 V <sub>CC</sub>                | 1.48                | 1.8                  | 2.23                | 2.83                 | 3.72                | 5.18                 | 8.11                | 16.87                | —                   | k $\Omega$ |

To accommodate the 3-mA drive current specification, a narrower threshold voltage range is required to support a maximum 800-pF load capacitance for a standard-mode I<sup>2</sup>C bus.

## 10.2 Typical Application



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**Figure 33. Implementation for Motherboard 1 Schematic**

### 10.2.1 Design Requirements

The SNx5DP159 can be designed into many types of applications. All applications have certain requirements for the system to work properly. Two voltage rails are required to support the lowest possible power consumption. The OE pin must have a 0.1-μF capacitor to ground. This pin can be driven by a processor but the pin needs to change states after voltage rails have stabilized. Configure the device by using I<sup>2</sup>C. Pin strapping is provided as I<sup>2</sup>C is not available in all cases. Because sources may have different naming conventions, confirm the link between the source and the SNx5DP159 is correctly mapped. A swap function is provided for the input pins in case signaling is reversed between the source and the device. For the control pins the values provided below are when they are being controlled by a micro-controller. If this is not the case then using the 65-kΩ for a pull up for high, pulled down for low, and left floating for mid level.

**Table 13. Design Parameters**

| DESIGN PARAMETER                  | VALUE                                |
|-----------------------------------|--------------------------------------|
| V <sub>CC</sub>                   | 3.3 V                                |
| V <sub>DD</sub>                   | 1.1 V                                |
| Main link input voltage           | V <sub>ID</sub> = 75 mVpp to 1.2 Vpp |
| Control pin Low                   | 65-kΩ pulled to GND                  |
| Control pin Mid                   | No Connect                           |
| Control pin High                  | 65-kΩ pulled to 3.3-V                |
| Vsadj resistor                    | 7.06-kΩ                              |
| Main link AC decoupling capacitor | 75 to 200 nF, recommend 100 nF       |

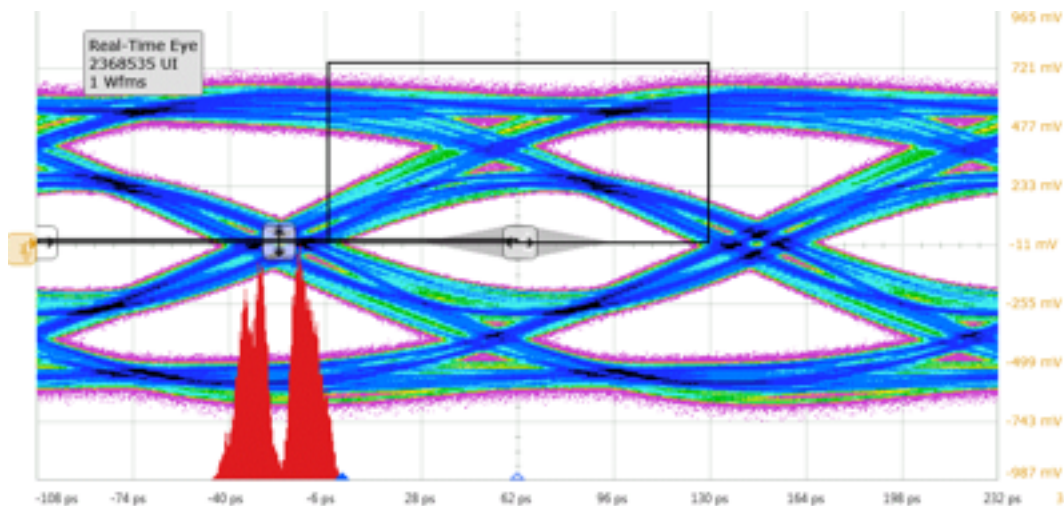
### 10.2.2 Detailed Design Procedure

The SNx5DP159 is a signal conditioner that provides AC coupling to DC coupling level shifting, to support Dual Mode DisplayPort-capable GPUs or GPUs with AC-coupled drive capability to support HDMI or DVI connectors and compliance. Signal conditioning is accomplished using receive equalization, retiming, and output driver configurability. The transmitter drives 2 to 3 inches of board trace and connector.

Designing in the SNx5DP159 requires the following:

- Determine the loss profile between the GPU and the HDMI/DVI connector.
- Based upon the loss profile and signal swing, determine the optimal location for the SNx5DP159, to pass electrical compliance.
- Use the typical application drawings in [Use Case of SNx5DP159](#) for information on using the AC coupling capacitors and control pin resistors.
- The DP159 has a receiver adaptive equalizer by default but can also be configured for fixed value equalization using the EQ\_SEL control pin.
- Set the VOD, pre-emphasis, termination, and edge rate levels to support compliance by using the appropriate Vsadj resistor value and by setting the PRE\_SEL, SLEW\_CTL, and TX\_TERM\_CTL control pins.
- Adding pre-emphasis will improve performance on bandwidth limited channels and make steeper transitions. V<sub>OD</sub> can be increased to compensate for DC losses and have a sheerer slope. SLEW\_CTL handle transition inclination. Making the transition sharper will improve skew performance.
- The thermal pad must be connected to ground.
- See the schematics in [Application Information](#) on recommended decouple capacitors from VCC pins to ground.

### 10.2.3 Application Curve



**Figure 34. 5.94 Gbps Compliance Eye Mask**

## 10.3 System Example

### 10.3.1 Compliance Testing

Compliance testing is very system design specific. Properly designing the system and configuring the DP159 can help pass transmitter compliance for the system. The following information is the starting point to help prepare for compliance test. As each system is different there are many features in the DP159 to help tune the circuit. These include  $V_{OD}$  adjust by changing the  $V_{sadj}$  resistor value or using I<sup>2</sup>C. Other knobs to turn are pre/de-emphasis and slew rate control. Passing both HDMI2.0 and HDMI1.4b compliance is easier to accomplish when using I<sup>2</sup>C as this provides more fine tuning capability.

#### For the SNx5DP159RGZ:

##### Pin Strapping

HDMI2.0 & HDMI1.4b

$V_{sadj}$  Resistor = 7.06-k $\Omega$

PRE\_SEL = NC for 0-dB

TX\_TERM\_CTL = NC for Auto Select

SLEW\_CTL = NC

##### I<sup>2</sup>C Control

HDMI2.0 & HDMI1.4b

$V_{sadj}$  Resistor = 7.06 k $\Omega$

PRE\_SEL = Reg0Ch[1:0] = 00 (labeled HDMI\_TWPST)

TX\_TERM\_CTL =

- Reg0Bh[4:3] = 00 → No term; HDMI1.4b < 2Gbps (This may be best value for all HDMI1.4b)
- Reg0Bh[4:3] = 01 → 150 to 300  $\Omega$ ; HDMI1.4b > 2Gbps
- Reg0Bh[4:3] = 11 → 75 to 150  $\Omega$ ; HDMI2.0

SLEW\_CTL = Reg0Bh[7:6] = 10

#### For the SNx5DP159RSB:

##### Pin Strapping

HDMI2.0 and HDMI1.4b

$V_{sadj}$  Resistor = 6.5 k $\Omega$

PRE\_SEL = L for –2 dB

TX\_TERM\_CTL = NC for Auto Select

SLEW\_CTL = NC

##### I<sup>2</sup>C

HDMI2.0

$V_{sadj}$  Resistor = 6.5 k $\Omega$

PRE\_SEL = Reg0Ch[1:0] = 01 (labeled HDMI\_TWPST)

TX\_TERM\_CTL = Reg0Bh[4:3] = 11

SLEW\_CTL = Reg0Bh[7:6] = 10

##### HDMI1.4b

$V_{sadj}$  Resistor = 6.5 k $\Omega$

VSWING\_DATA & VSWING\_CLK to -7% = Reg0Ch[7:2] = 111111

PRE\_SEL = Reg0Ch[1:0] = 00: (Labeled HDMI\_TWPST)

TX\_TERM\_CTL: Reg0Bh[4:3]

- <2 Gbps = 00 for no termination (This may be best value for all HDMI1.4b)
- >2 Gbps and < 3.4 Gbps = 01 for 150 to 300  $\Omega$

SLEW\_CTL = Reg0Bh[7:6] = 10

## 11 Power Supply Recommendations

### 11.1 Power Management

To minimize the power consumption of customer application, SNx5DP159 uses dual power supply.  $V_{CC}$  is 3.3-V with 10% range to support the I/O voltage. The  $V_{DD}$  is 1.00-V to 1.27-V range to supply the internal digital control circuit.  $v$  operates in two different working states. See Table 14 for conditions for each mode. When OE is deasserted and then reasserted the device will rest to its default configurations. If different configurations were programmed using I<sup>2</sup>C then the device will have to be reprogrammed.

- Power-down mode:
  - OE = Low puts the device into its lowest power state by shutting down all function blocks
    - When OE is re-asserted the transitions from L → H will create a reset and if the device is programmed through I<sup>2</sup>C it will have to be reprogrammed.
    - OE = High, HPD\_SNK = Low
    - Writing a 1 to register 09h[3]
- Normal operation: Working in redriver or retimer
- When HPD asserts, the device CDR and output will enable based on the signal detector circuit result
- HPD\_SRC = HPD\_SNK in all conditions. The HPD channel operational when  $V_{CC}$  over 3-V.

#### NOTE

When the SNx5DP159 is put into a power down state using the OE pin the I<sup>2</sup>C registers are cleared. The TMDS\_CLOCK\_RATIO\_STATUS bit will be cleared in all power down states. If cleared and HDMI2.0 resolutions are to be supported, the SNx5DP159 expects the source to write a 1 to this bit location. If this does not happen the PLL will not be set properly and no video may be evident.

**Table 14. Control Logic and Mode of Operation**

| INPUTS <sup>(1)</sup> |    | STATUS            |         |           |                    |                   |          |                           | MODE                                            |
|-----------------------|----|-------------------|---------|-----------|--------------------|-------------------|----------|---------------------------|-------------------------------------------------|
| HPD_SNK               | OE | Mode of Operation | HPD_SRC | IN_Dx     | SDA_CTL<br>SCL_CTL | OUT_Dx<br>OUT_CLK | DDC      | AUX_SRC±<br>(48 PIN ONLY) |                                                 |
| H                     | L  | X                 | H       | High-Z    | Disabled           | High-Z            | Disabled | Disable                   | Power-down mode                                 |
| L                     | H  | X                 | L       | High-Z    | Active             | High-Z            | Disabled | Disable                   | Power-down mode                                 |
| H                     | H  | X                 | H       | High-Z    | Active             | High-Z            | Disabled | Disable                   | Power-down mode when a one is written to 09h[3] |
| H                     | H  | Redriver          | H       | RX active | Active             | TX active         | Active   | Active                    | Normal operation                                |
| H                     | H  | Retimer           | H       | RX active | Active             | TX active         | Active   | Active                    | Normal operation                                |

(1) L = LOW, H = HIGH

TMDS output termination control impacts the operating power.

**Table 15. Control Logic and Mode of Operation**

| INPUTS <sup>(1)</sup> |    | STATUS            |         |           |                    |                   |          |  | MODE                                            |
|-----------------------|----|-------------------|---------|-----------|--------------------|-------------------|----------|--|-------------------------------------------------|
| HPD_SNK               | OE | Mode of Operation | HPD_SRC | IN_Dx     | SDA_CTL<br>SCL_CTL | OUT_Dx<br>OUT_CLK | DDC      |  |                                                 |
| H                     | L  | X                 | H       | High-Z    | Disabled           | High-Z            | Disabled |  | Power-down mode                                 |
| L                     | H  | X                 | L       | High-Z    | Active             | High-Z            | Disabled |  | Power-down mode                                 |
| H                     | H  | X                 | H       | High-Z    | Active             | High-Z            | Disabled |  | Power-down mode when a one is written to 09h[3] |
| H                     | H  | Redriver          | H       | RX active | Active             | TX active         | Active   |  | Normal operation                                |
| H                     | H  | Retimer           | H       | RX active | Active             | TX active         | Active   |  | Normal operation                                |

(1) L = LOW, H = HIGH

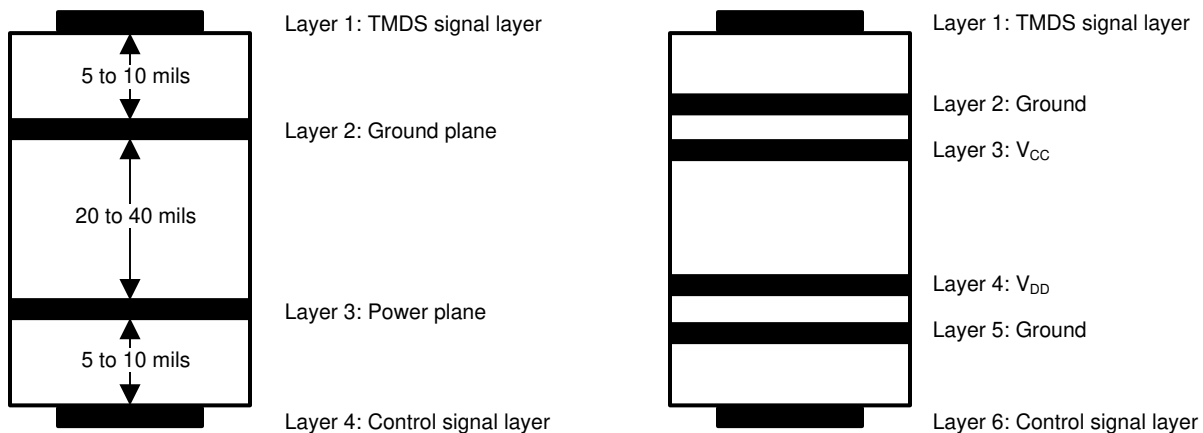
TMDS output termination control impacts the operating power.

## 12 Layout

### 12.1 Layout Guidelines

TI recommends to use at a minimum a four layer stack up to accomplish a low-EMI PCB design. TI recommends six layers because the SNx5DP159 is a two voltage rail device.

- Routing the high-speed input DisplayPort traces and TMDS output traces on the top layer avoids the use of vias (and their discontinuities) and allows for clean interconnects from the HDMI connectors to the repeater inputs and from the repeater output to the subsequent receiver circuit. It is important to match the electrical length of these high speed traces to minimize both inter-pair and intra-pair skew.
- Placing a solid ground plane next to the high-speed signal layer establishes controlled impedance for transmission line interconnects and provides an excellent low-inductance path for the return current flow.
- Placing the power plane next to the ground plane creates additional high-frequency bypass capacitance.
- Routing the slower speed control signals on the bottom layer allows for greater flexibility as these signal links usually have margin to tolerate discontinuities such as vias.
- If an additional supply voltage plane or signal layer is needed, add a second power / ground plane system to the stack to keep it symmetrical. This makes the stack mechanically stable and prevents it from warping. Also the power and ground plane of each power system can be placed closer together, thus increasing the high-frequency bypass capacitance significantly.
- The control pin pullup and pulldown resistors are shown in application section for reference. If a high is needed only use the pull up. If a low is needed only use the pull down. If mid level is to be selected do not use either resistors and leave the pin floating/No connect.



**Figure 35. Recommended 4- or 6-Layer Stack for a Receiver PCB Design**



## Layout Examples (continued)

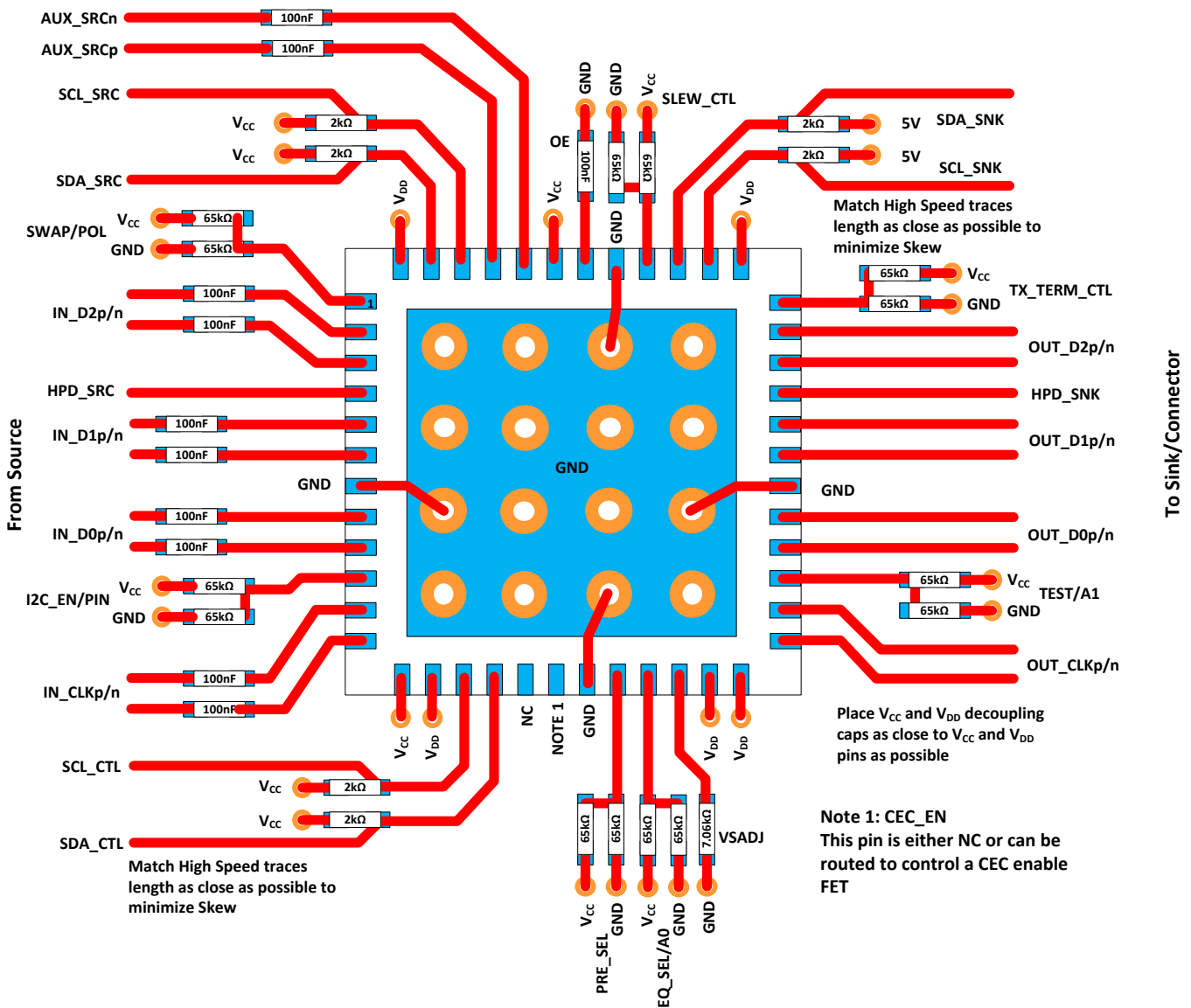


Figure 37. Layout Example for the DP159RGZ

## 12.3 Thermal Considerations

On a high-K board: TI recommends to solder the PowerPAD™ onto the thermal land. A thermal land is the area of solder-tinned-copper underneath the PowerPAD package. On a high-K board, the SNx5DP159 device can operate over the full temperature range by soldering the PowerPAD onto the thermal land without vias.

On a low-K board: For the device to operate across the temperature range on a low-K board, a 1-oz Cu trace connecting the GND pins to the thermal land must be used. A simulation shows  $R_{\theta JA} = 100.84^{\circ}\text{C/W}$  allowing 545-mW power dissipation at 70°C ambient temperature.

A general PCB design guide for PowerPAD packages is provided in *PowerPAD Thermally Enhanced Package*, [SLMA002](#).

## 13 Device and Documentation Support

### 13.1 Related Links

The table below lists quick access links. Categories include technical documents, support and community resources, tools and software, and quick access to sample or buy.

**Table 16. Related Links**

| PARTS     | PRODUCT FOLDER             | SAMPLE & BUY               | TECHNICAL DOCUMENTS        | TOOLS & SOFTWARE           | SUPPORT & COMMUNITY        |
|-----------|----------------------------|----------------------------|----------------------------|----------------------------|----------------------------|
| SN65DP159 | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| SN75DP159 | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |

### 13.2 Documentation Support

#### 13.2.1 Related Documentation

The documents identified in this section are referenced within this data sheet. Most references within the data sheet use the text identified within the brackets [Document Tag], instead of the complete document title to simplify the text.

- (1) [Dual Mode] VESA DisplayPort Dual-Mode Standard Version 1.1, February 8, 2013
- (2) [HDMI1.4b] High-Definition Multimedia Interface Specification Version 1.4b, October, 2011
- (3) [HDMI2.0] High-Definition Multimedia Interface Specification Version 2.0a, March, 2015
- (4) [I<sup>2</sup>C] The I<sup>2</sup>C-Bus specification version 2.1, January, 2000
- (5) [HDMI1.4b CTS] High-definition Multimedia Interface CTS for Version 1.4b October, 2011
- (6) [HDMI2.0 CTS] High-definition Multimedia Interface CTS for Version 2.0k June, 2015

### 13.3 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

### 13.4 Community Resources

[TI E2E™ support forums](#) are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

Linked content is provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

### 13.5 Trademarks

PowerPAD, E2E are trademarks of Texas Instruments.

Blu-ray is a trademark of Blu-ray Disc Association.

### 13.6 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

### 13.7 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

## 14 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

## PACKAGING INFORMATION

| Orderable part number         | Status<br>(1) | Material type<br>(2) | Package   Pins  | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|-------------------------------|---------------|----------------------|-----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">SN65DP159RGZR</a> | Active        | Production           | VQFN (RGZ)   48 | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-3-260C-168 HR               | -40 to 85    | DP159               |
| SN65DP159RGZR.A               | Active        | Production           | VQFN (RGZ)   48 | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-3-260C-168 HR               | -40 to 85    | DP159               |
| SN65DP159RGZRG4               | Active        | Production           | VQFN (RGZ)   48 | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-3-260C-168 HR               | -40 to 85    | DP159               |
| SN65DP159RGZRG4.A             | Active        | Production           | VQFN (RGZ)   48 | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-3-260C-168 HR               | -40 to 85    | DP159               |
| <a href="#">SN65DP159RGZT</a> | Active        | Production           | VQFN (RGZ)   48 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-3-260C-168 HR               | -40 to 85    | DP159               |
| SN65DP159RGZT.A               | Active        | Production           | VQFN (RGZ)   48 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-3-260C-168 HR               | -40 to 85    | DP159               |
| <a href="#">SN65DP159RSBR</a> | Active        | Production           | WQFN (RSB)   40 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | DP159               |
| SN65DP159RSBR.A               | Active        | Production           | WQFN (RSB)   40 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | DP159               |
| SN65DP159RSBR.B               | Active        | Production           | WQFN (RSB)   40 | 3000   LARGE T&R      | -           | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | DP159               |
| <a href="#">SN65DP159RSBT</a> | Active        | Production           | WQFN (RSB)   40 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | DP159               |
| SN65DP159RSBT.A               | Active        | Production           | WQFN (RSB)   40 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | DP159               |
| SN65DP159RSBT.B               | Active        | Production           | WQFN (RSB)   40 | 250   SMALL T&R       | -           | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | DP159               |
| SN65DP159RSBTG4               | Active        | Production           | WQFN (RSB)   40 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | DP159               |
| SN65DP159RSBTG4.A             | Active        | Production           | WQFN (RSB)   40 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | DP159               |
| <a href="#">SN75DP159RGZR</a> | Active        | Production           | VQFN (RGZ)   48 | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-3-260C-168 HR               | 0 to 85      | 75DP159             |
| SN75DP159RGZR.A               | Active        | Production           | VQFN (RGZ)   48 | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-3-260C-168 HR               | 0 to 85      | 75DP159             |
| <a href="#">SN75DP159RGZT</a> | Active        | Production           | VQFN (RGZ)   48 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-3-260C-168 HR               | 0 to 85      | 75DP159             |
| SN75DP159RGZT.A               | Active        | Production           | VQFN (RGZ)   48 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-3-260C-168 HR               | 0 to 85      | 75DP159             |
| <a href="#">SN75DP159RSBR</a> | Active        | Production           | WQFN (RSB)   40 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 85      | 75DP159             |
| SN75DP159RSBR.A               | Active        | Production           | WQFN (RSB)   40 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 85      | 75DP159             |
| SN75DP159RSBR.B               | Active        | Production           | WQFN (RSB)   40 | 3000   LARGE T&R      | -           | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 85      | 75DP159             |
| <a href="#">SN75DP159RSBT</a> | Active        | Production           | WQFN (RSB)   40 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 85      | 75DP159             |
| SN75DP159RSBT.A               | Active        | Production           | WQFN (RSB)   40 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 85      | 75DP159             |
| SN75DP159RSBTG4               | Active        | Production           | WQFN (RSB)   40 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 85      | 75DP159             |
| SN75DP159RSBTG4.A             | Active        | Production           | WQFN (RSB)   40 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 85      | 75DP159             |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

**(2) Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

**(3) RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

**(4) Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

**(5) MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

**(6) Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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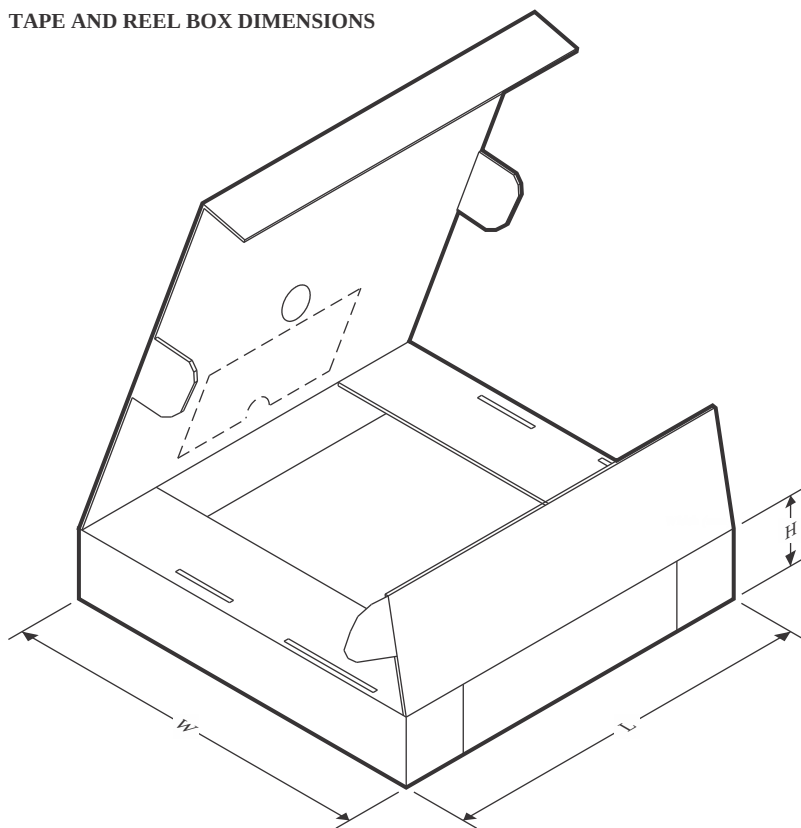
## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device          | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-----------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN65DP159RGZR   | VQFN         | RGZ             | 48   | 2500 | 330.0              | 16.4               | 7.3     | 7.3     | 1.1     | 12.0    | 16.0   | Q2            |
| SN65DP159RGZRG4 | VQFN         | RGZ             | 48   | 2500 | 330.0              | 16.4               | 7.3     | 7.3     | 1.1     | 12.0    | 16.0   | Q2            |
| SN65DP159RGZT   | VQFN         | RGZ             | 48   | 250  | 180.0              | 16.4               | 7.3     | 7.3     | 1.1     | 12.0    | 16.0   | Q2            |
| SN65DP159RSBR   | WQFN         | RSB             | 40   | 3000 | 330.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |
| SN65DP159RSBT   | WQFN         | RSB             | 40   | 250  | 180.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |
| SN65DP159RSBTG4 | WQFN         | RSB             | 40   | 250  | 180.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |
| SN75DP159RGZR   | VQFN         | RGZ             | 48   | 2500 | 330.0              | 16.4               | 7.3     | 7.3     | 1.1     | 12.0    | 16.0   | Q2            |
| SN75DP159RGZT   | VQFN         | RGZ             | 48   | 250  | 180.0              | 16.4               | 7.3     | 7.3     | 1.1     | 12.0    | 16.0   | Q2            |
| SN75DP159RSBR   | WQFN         | RSB             | 40   | 3000 | 330.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |
| SN75DP159RSBT   | WQFN         | RSB             | 40   | 250  | 180.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |
| SN75DP159RSBTG4 | WQFN         | RSB             | 40   | 250  | 180.0              | 12.4               | 5.3     | 5.3     | 1.1     | 8.0     | 12.0   | Q2            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device          | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN65DP159RGZR   | VQFN         | RGZ             | 48   | 2500 | 367.0       | 367.0      | 38.0        |
| SN65DP159RGZRG4 | VQFN         | RGZ             | 48   | 2500 | 367.0       | 367.0      | 38.0        |
| SN65DP159RGZT   | VQFN         | RGZ             | 48   | 250  | 210.0       | 185.0      | 35.0        |
| SN65DP159RSBR   | WQFN         | RSB             | 40   | 3000 | 346.0       | 346.0      | 33.0        |
| SN65DP159RSBT   | WQFN         | RSB             | 40   | 250  | 182.0       | 182.0      | 20.0        |
| SN65DP159RSBTG4 | WQFN         | RSB             | 40   | 250  | 182.0       | 182.0      | 20.0        |
| SN75DP159RGZR   | VQFN         | RGZ             | 48   | 2500 | 367.0       | 367.0      | 38.0        |
| SN75DP159RGZT   | VQFN         | RGZ             | 48   | 250  | 210.0       | 185.0      | 35.0        |
| SN75DP159RSBR   | WQFN         | RSB             | 40   | 3000 | 346.0       | 346.0      | 33.0        |
| SN75DP159RSBT   | WQFN         | RSB             | 40   | 250  | 182.0       | 182.0      | 20.0        |
| SN75DP159RSBTG4 | WQFN         | RSB             | 40   | 250  | 182.0       | 182.0      | 20.0        |

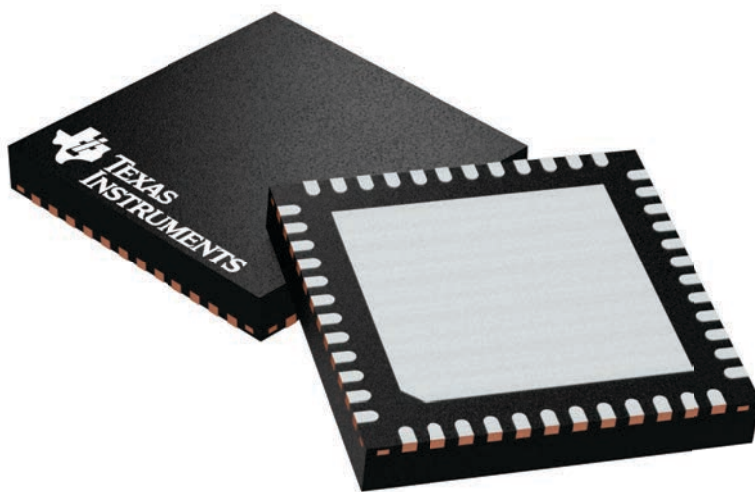
## GENERIC PACKAGE VIEW

**RGZ 48**

**VQFN - 1 mm max height**

7 x 7, 0.5 mm pitch

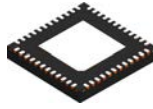
PLASTIC QUADFLAT PACK- NO LEAD



Images above are just a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.

4224671/A

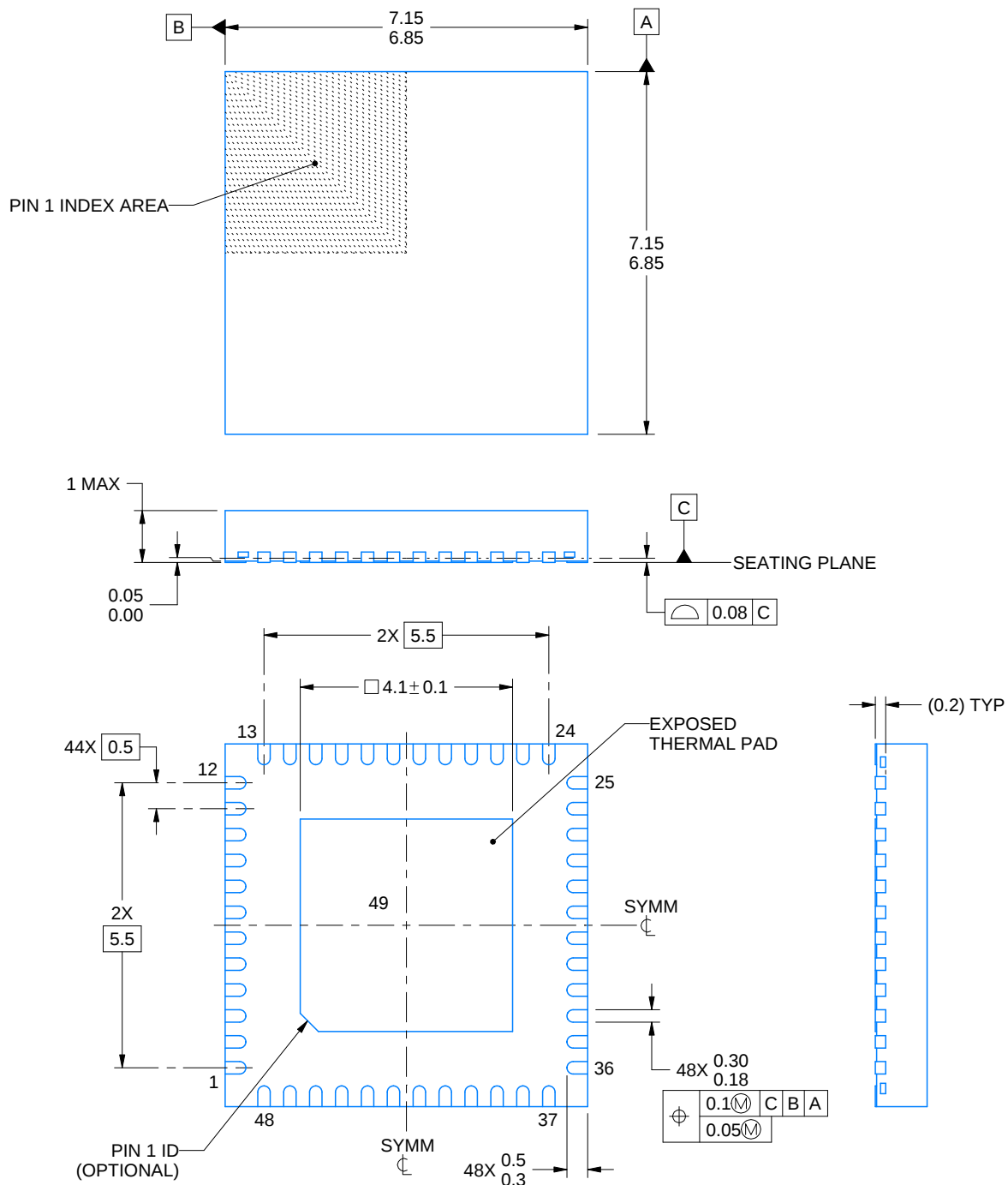
RGZ0048B



## PACKAGE OUTLINE

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



4218795/B 02/2017

### NOTES:

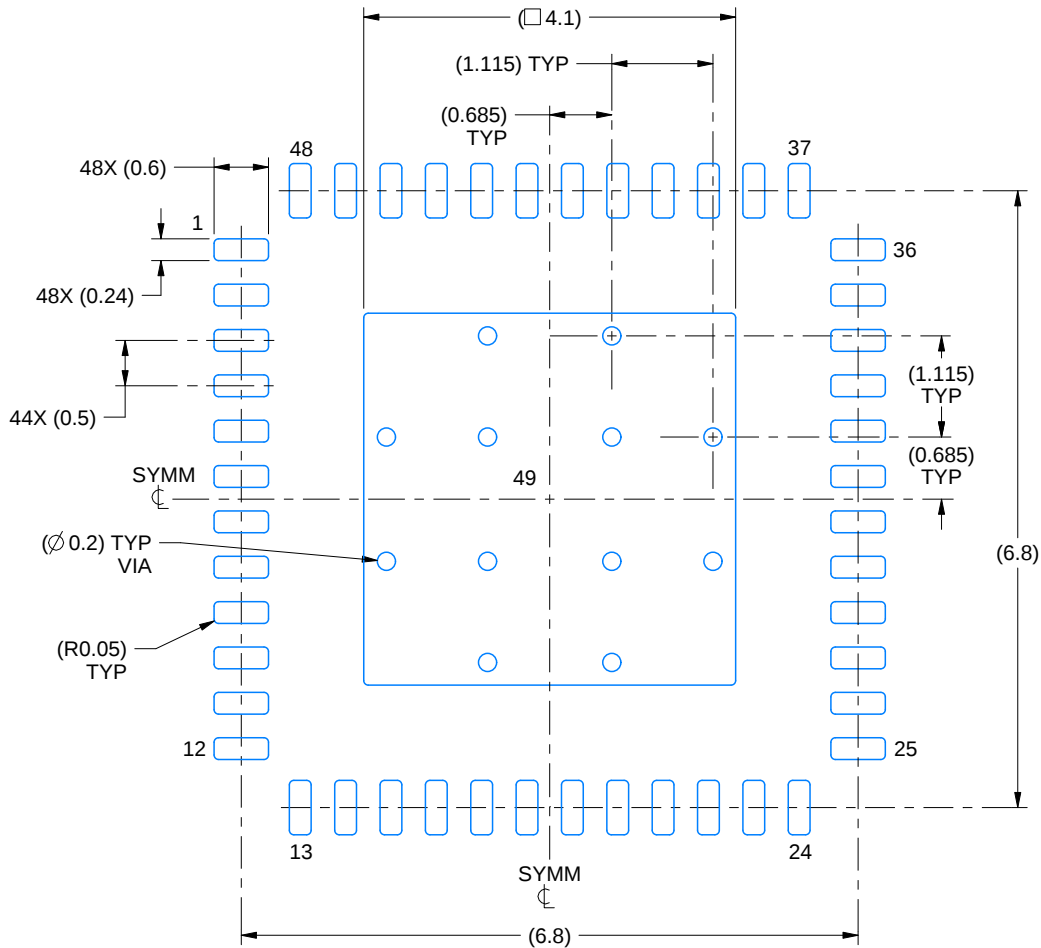
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

# EXAMPLE BOARD LAYOUT

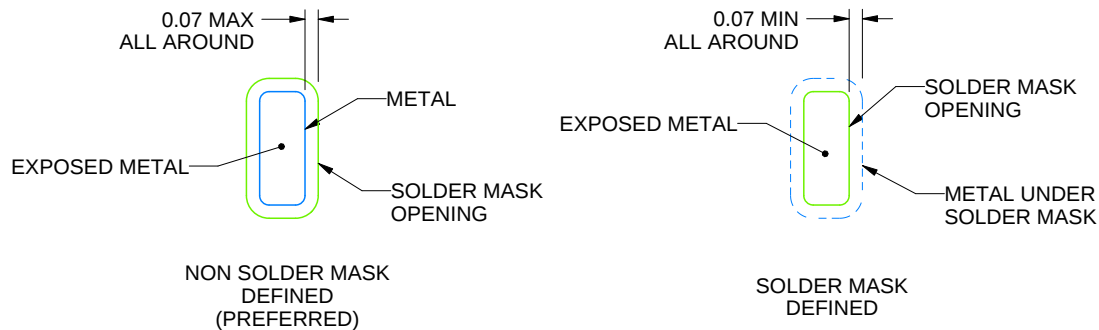
RGZ0048B

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



**LAND PATTERN EXAMPLE**  
EXPOSED METAL SHOWN  
SCALE:12X



**SOLDER MASK DETAILS**

4218795/B 02/2017

NOTES: (continued)

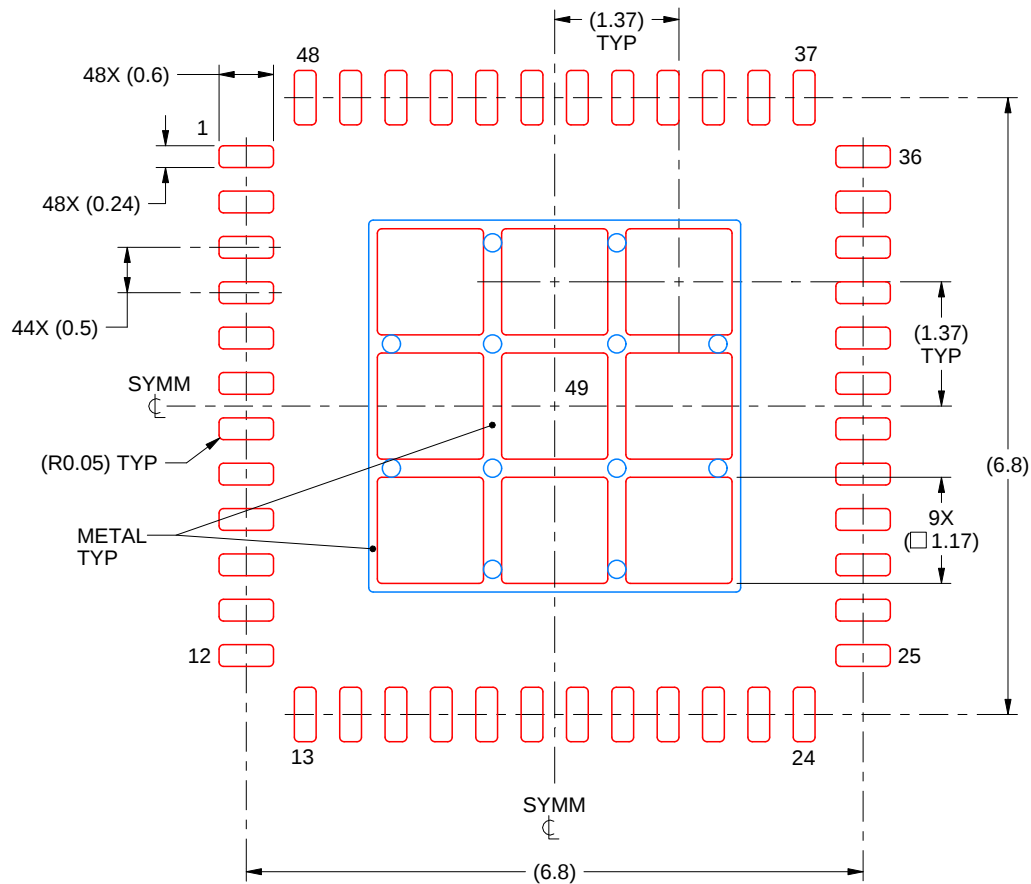
4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 ([www.ti.com/lit/sluea271](http://www.ti.com/lit/sluea271)).
5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

# EXAMPLE STENCIL DESIGN

RGZ0048B

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



## SOLDER PASTE EXAMPLE BASED ON 0.125 mm THICK STENCIL

EXPOSED PAD 49  
73% PRINTED SOLDER COVERAGE BY AREA UNDER PACKAGE  
SCALE:12X

4218795/B 02/2017

NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

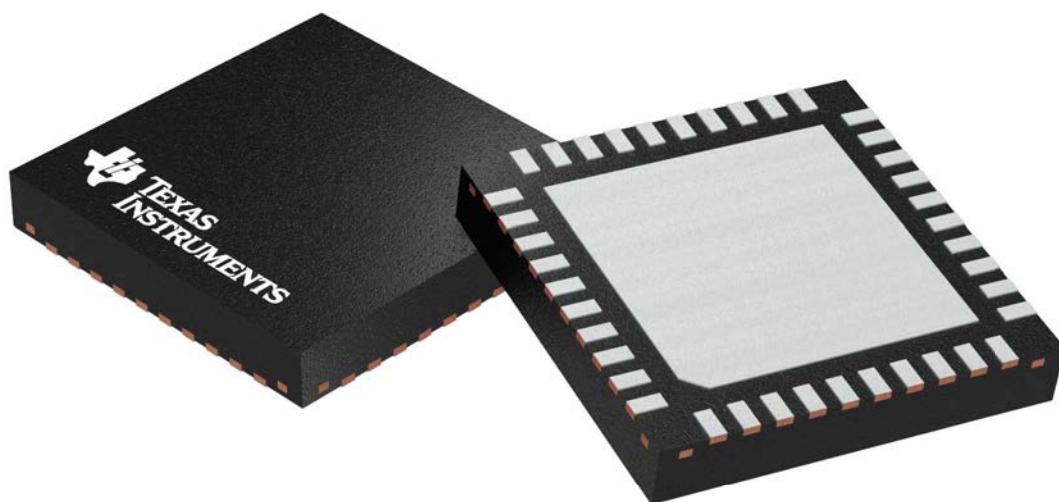
## GENERIC PACKAGE VIEW

**RSB 40**

**WQFN - 0.8 mm max height**

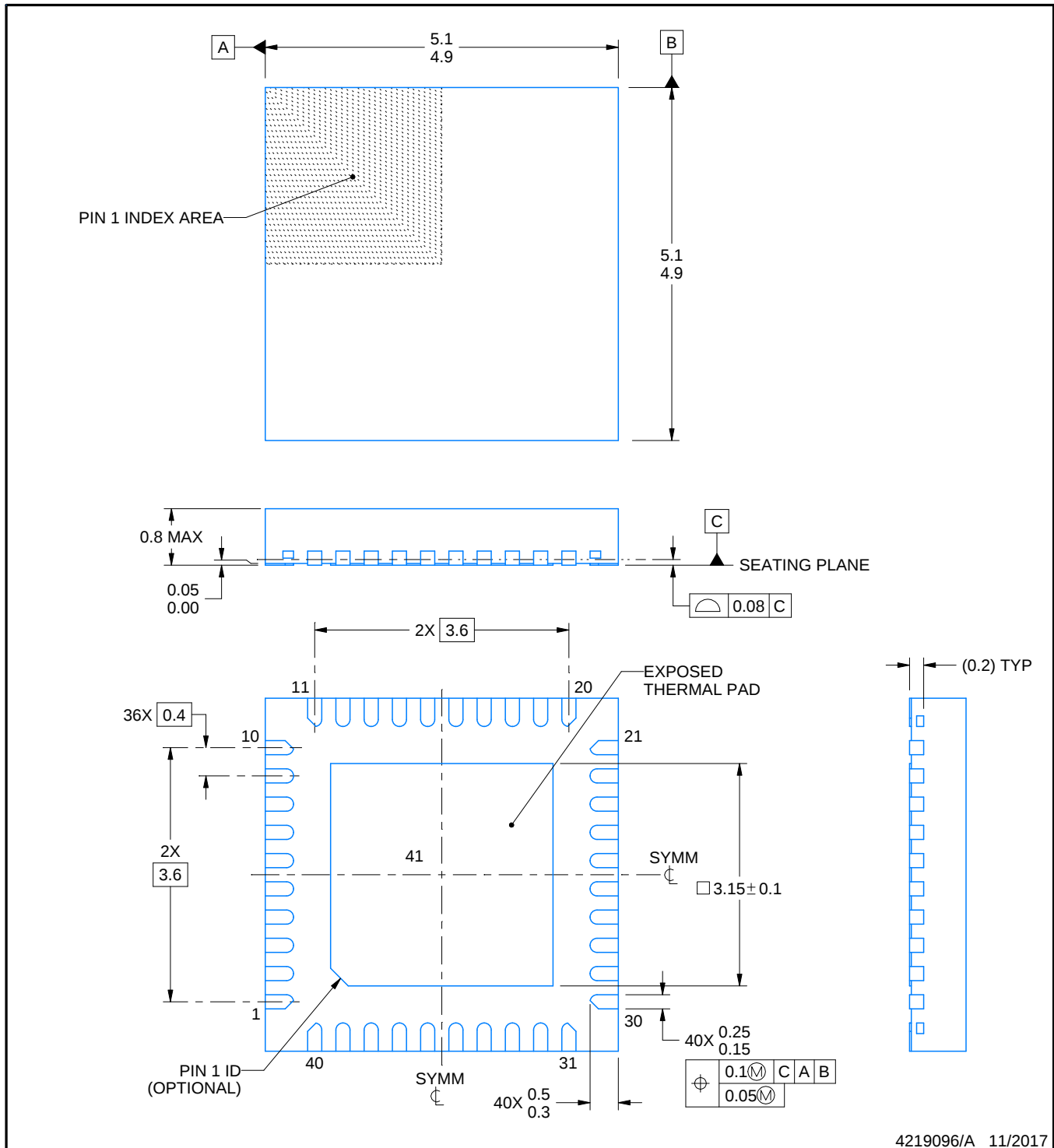
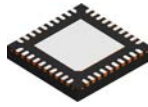
5 x 5 mm, 0.4 mm pitch

PLASTIC QUAD FLATPACK - NO LEAD



Images above are just a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.

4207182/D



## NOTES:

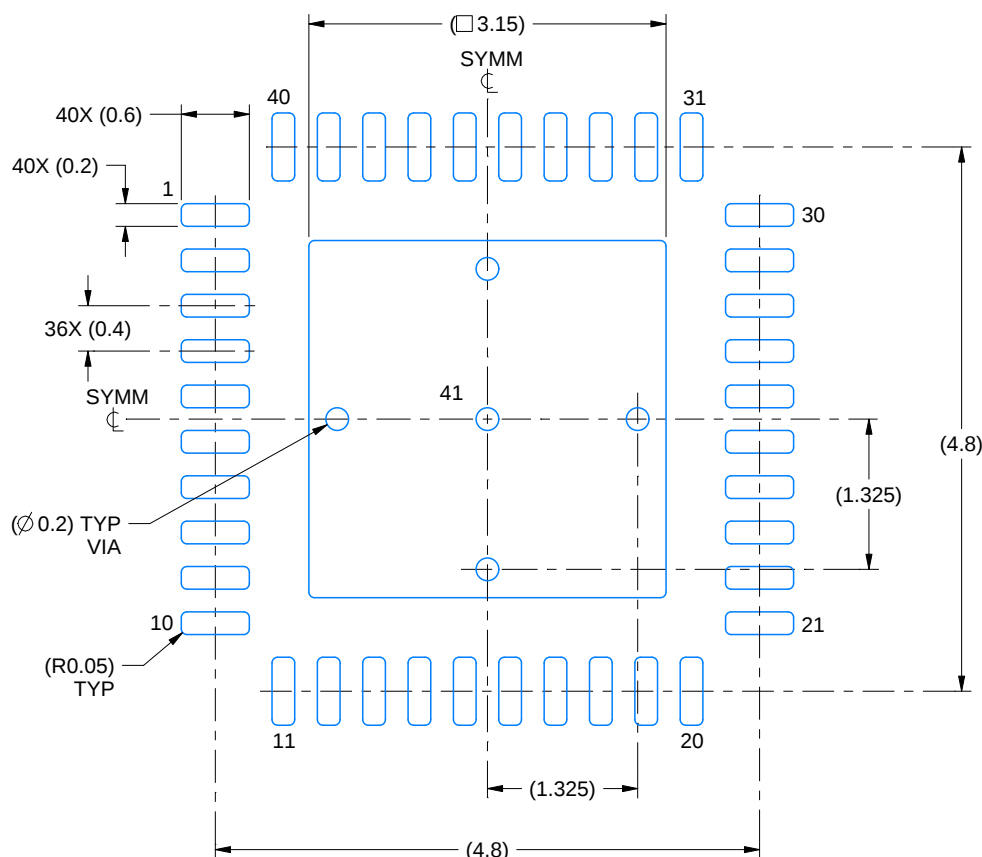
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

# EXAMPLE BOARD LAYOUT

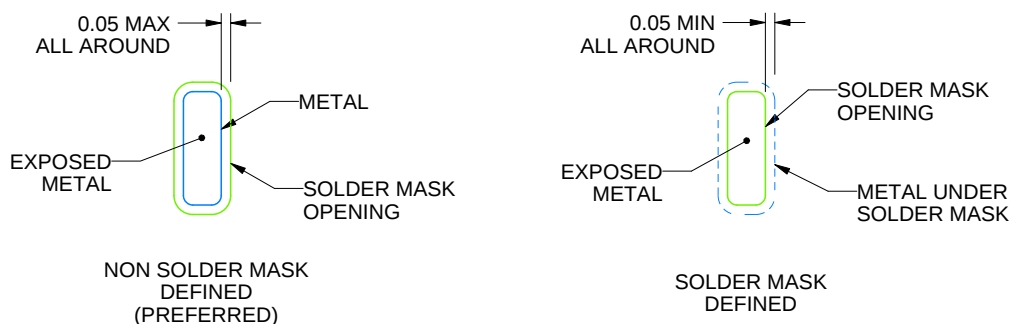
RSB0040E

WQFN - 0.8 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:15X



SOLDER MASK DETAILS

4219096/A 11/2017

NOTES: (continued)

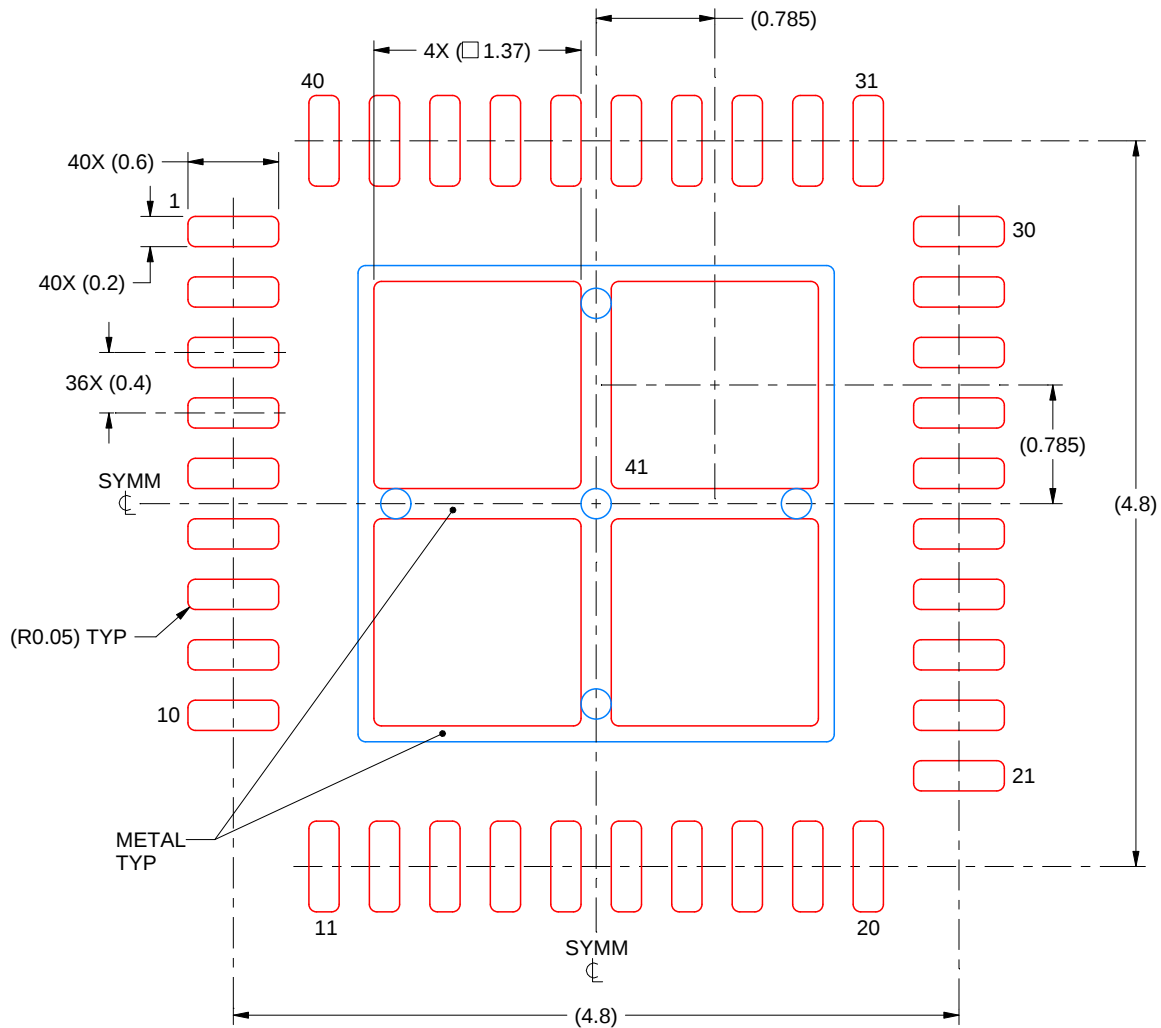
4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 ([www.ti.com/lit/sluea271](http://www.ti.com/lit/sluea271)).
5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

# EXAMPLE STENCIL DESIGN

RSB0040E

WQFN - 0.8 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



**SOLDER PASTE EXAMPLE**  
BASED ON 0.1 mm THICK STENCIL

EXPOSED PAD 41  
75% PRINTED SOLDER COVERAGE BY AREA UNDER PACKAGE  
SCALE:20X

4219096/A 11/2017

NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

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